

16-BIT, 500 MSPS 2x-8x INTERPOLATING DUAL-CHANNEL DIGITAL-TO-ANALOG CONVERTER (DAC)

FEATURES

- 500 MSPS
- Selectable 2x-8x Interpolation
- On-Chip PLL/VCO Clock Multiplier
- Full IQ Compensation Including Offset, Gain, and Phase
- Flexible Input Options:
 - FIFO With Latch on External or Internal Clock
 - Even/Odd Multiplexed Input
 - Single Port Demultiplexed Input
- Complex Mixer With 32-Bit NCO
- Fixed Frequency Mixer With $F_s/4$ and $F_s/2$
- 1.8-V or 3.3-V I/O Voltage
- On-Chip 1.2-V Reference
- Differential Scalable Output: 2 mA to 20 mA
- Pin Compatible to DAC5686
- High Performance
 - 81-dBc ACLR WCDMA TM1 at 30.72 MHz
 - 72-dBc ACLR WCDMA TM1 at 153.6 MHz
- Package: 100-Pin HTQFP

APPLICATIONS

- Cellular Base Transceiver Station Transmit Channel
 - CDMA: W-CDMA, CDMA2000, TD-SCDMA
 - TDMA: GSM, IS-136, EDGE/UWC-136
 - OFDM: 802.16
- Cable Modem Termination System

DESCRIPTION

The DAC5687 is a dual-channel 16-bit high-speed digital-to-analog converter (DAC) with integrated 2x, 4x, and 8x interpolation filters, a complex numerically controlled oscillator (NCO), on-board clock multiplier, IQ compensation and on-chip voltage reference. The DAC5687 is pin compatible to the DAC5686, requiring only changes in register settings for most applications, and offers additional features and superior linearity, noise, crosstalk, and PLL phase noise performance.

The DAC5687 has six signal processing blocks: two interpolate by two digital filters, fine frequency mixer with 32-bit NCO, a quadrature modulation compensation block, another interpolate by two digital filter and a coarse frequency mixer with $F_s/2$ or $F_s/4$. The different modes of operation enable or bypass the signal processing blocks.

The coarse and fine mixers can be combined to span a wider range of frequencies with fine resolution. The DAC5687 allows both complex or real output. Combining the frequency upconversion and complex output produces a Hilbert Transform pair that is output from the two DACs. An external RF quadrature modulator then performs the final single sideband up-conversion.

The IQ compensation feature allows optimization of phase, gain and offset to maximize sideband rejection and minimize LO feedthrough for an analog quadrature modulator.

The DAC5687 includes several input options: single port interleaved data, even and odd multiplexing at half rate, and an input FIFO with either external or internal clock to ease the input timing ambiguity when the DAC5687 is clocked at the DAC output sample rate.

ORDERING INFORMATION

T_A	Package Device
-40°C to 85°C	100 HTQFP ⁽¹⁾ (P&P) PowerPAD™ Plastic Quad FlatPack
	DAC5687IPZP

(1) Thermal Pad Size: 6 mm × 6 mm.

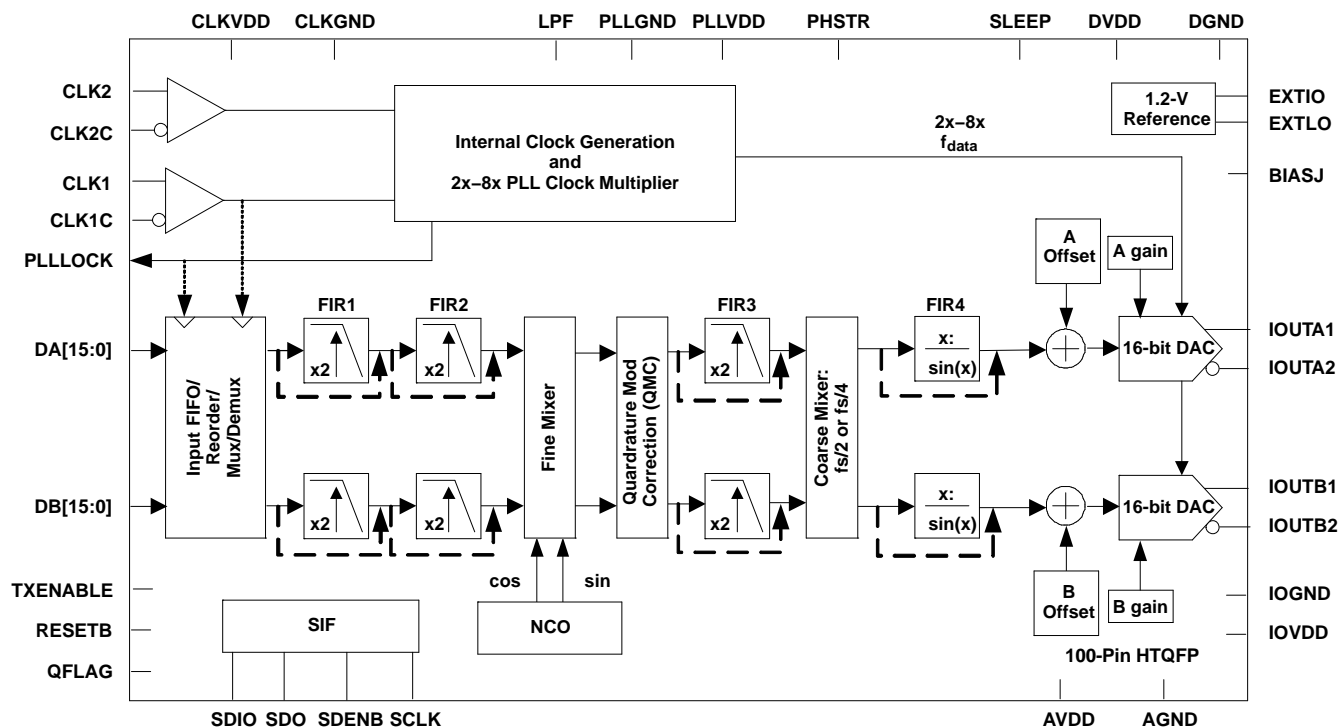


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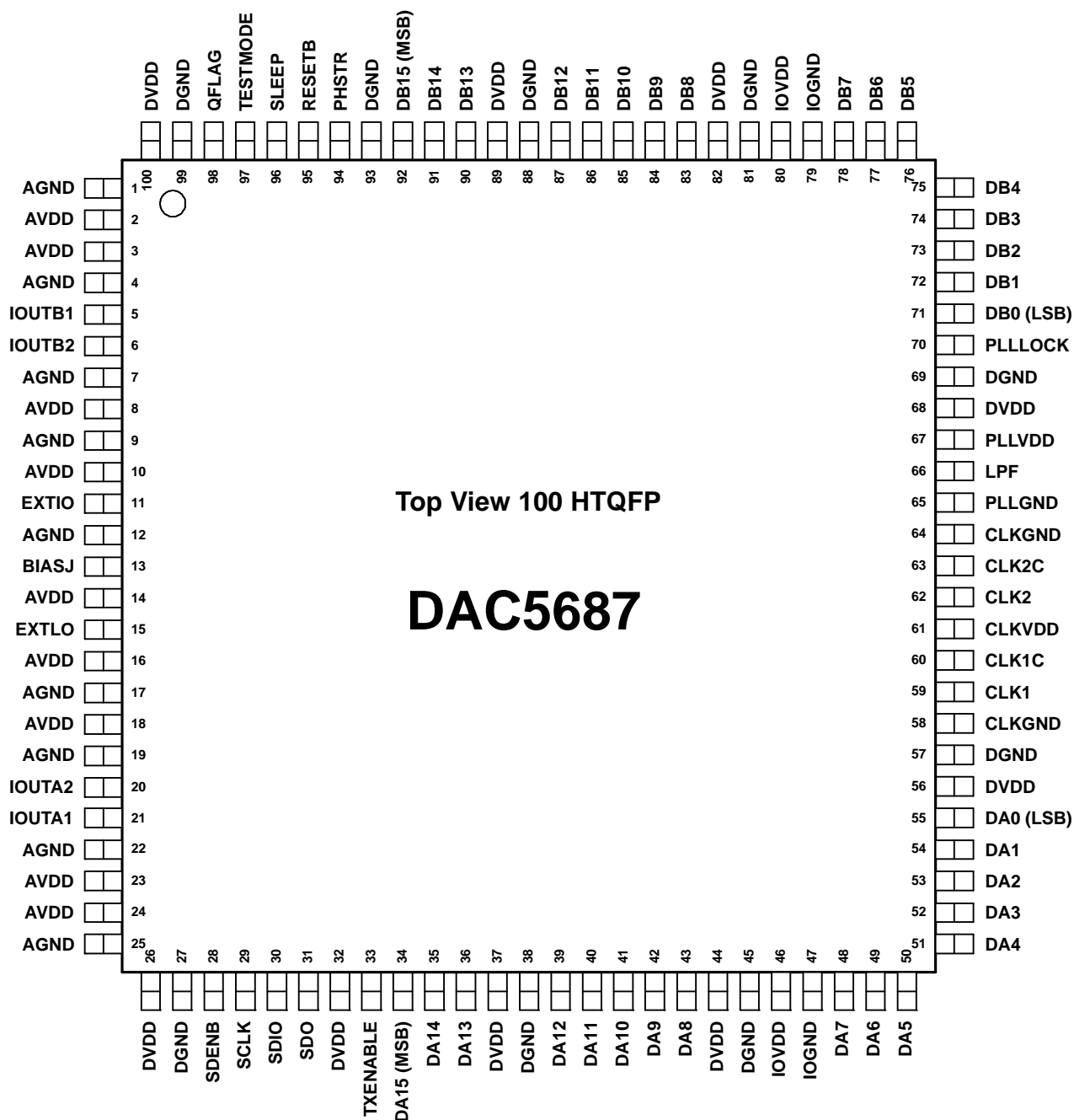


These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

FUNCTIONAL BLOCK DIAGRAM



PINOUT



TERMINAL FUNCTIONS

TERMINAL		I/O	DESCRIPTION
NAME	NO.		
AGND	1, 4, 7, 9, 12, 17, 19, 22, 25	I	Analog ground return
AVDD	2, 3, 8, 10, 14, 16, 18, 23, 24	I	Analog supply voltage
BIASJ	13	O	Full-scale output current bias

TERMINAL FUNCTIONS (continued)

TERMINAL		I/O	DESCRIPTION
NAME	NO.		
CLK1	59	I	In PLL clock mode and dual clock modes, provides data input rate clock. In external clock mode, provides optional input data rate clock to FIFO latch. When the FIFO is disabled, CLK1 is not used and can be left unconnected.
CLK1C	60	I	Complementary input of CLK1.
CLK2	62	I	External and dual clock mode clock input. In PLL mode, CLK2 is unused and can be left unconnected.
CLK2C	63	I	Complementary of CLK2. In PLL mode, CLK2C is unused and can be left unconnected.
CLKGND	58, 64	I	Ground return for internal clock buffer
CLKVDD	61	I	Internal clock buffer supply voltage
DA[15..0]	34-36, 39-43, 48-55	I	A-Channel Data bits 0 through 15. DA15 is most significant data bit (MSB). DA0 is least significant data bit (LSB). Order can be reversed by register change.
DB[0..15]	71-78, 83-87, 90-92	I	B-Channel Data bits 0 through 15. DB15 is most significant data bit (MSB). DB0 is least significant data bit (LSB). Order can be reversed by register change.
DGND	27, 38, 45, 57, 69, 81, 88, 93, 99	I	Digital ground return
DVDD	26, 32, 37, 44, 56, 68, 82, 89, 100	I	Digital supply voltage
EXTIO	11	I/O	Used as external reference input when internal reference is disabled (i.e., EXTLO connected to AVDD). Used as internal reference output when EXTLO = AGND, requires a 0.1- μ F decoupling capacitor to AGND when used as reference output
EXTLO	15	I/O	Internal/external reference select. Internal reference selected when tied to AGND, external reference selected when tied to AVDD. Output only when ATEST is not zero (register 0x1B bits 7 to 3).
IOUTA1	21	O	A-Channel DAC current output. Full scale when all input bits are set 1
IOUTA2	20	O	A-Channel DAC complementary current output. Full scale when all input bits are 0
IOUTB1	5	O	B-Channel DAC current output. Full scale when all input bits are set 1
IOUTB2	6	O	B-Channel DAC complementary current output. Full scale when all input bits are 0
IOGND	47, 79	I	Digital I/O ground return
IOVDD	46, 80	I	Digital I/O supply voltage
LPF	66	I	PLL loop filter connection
PHSTR	94	I	Synchronization input signal that can be used to initialize the NCO, course mixer, internal clock divider, and/or FIFO circuits.
PLLGND	65	I	Ground return for internal PLL
PLLVDD	67	I	PLL supply voltage. When PLLVDD is 0 V, the PLL is disabled.
PLLLOCK	70	O	In PLL mode, provides PLL lock status bit or internal clock signal. PLL is locked to input clock when high. In external clock mode, provides input rate clock.
QFLAG	98	I	When qflag register is 1, the QFLAG pin is used by the user during interleaved data input mode to identify the B sample. High QFLAG indicates B sample. Must be repeated every B sample.
RESETB	95	I	Resets the chip when low. Internal pull-up
SCLK	29	I	Serial interface clock
SDENB	28	I	Active low serial data enable, always an input to the DAC5687
SDIO	30	I/O	Bidirectional serial data in 3-pin interface mode, input only in 4 pin interface mode. Three-pin mode is the default after chip reset.
SDO	31	O	Serial interface data, uni-directional data output, if SDIO is an input. SDO is 3-stated when the 3-pin interface mode is selected (register 0x08 bit 1).
SLEEP	96	I	Asynchronous hardware power down input. Active High. Internal pull down.

TERMINAL FUNCTIONS (continued)

TERMINAL		I/O	DESCRIPTION
NAME	NO.		
TXENABLE	33	I	TXENABLE has two purposes. In all modes, TXENABLE must be high for the DATA to the DAC to be enabled. When TXENABLE is low, the digital logic section is forced to all 0, and any input data presented to DA[15:0] and DB[15:0] is ignored. In interleaved data mode, when the qflag register bit is cleared, TXENABLE is used to synchronizes the data to channels A and B. The first data after the rising edge of TXENABLE is treated as A data, while the next data is treated as B data, and so on.
TESTMODE	97	I	TESTMODE is DGND for the user

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		UNIT
Supply voltage range	AVDD ⁽²⁾	–0.5 V to 4 V
	DVDD ⁽³⁾	–0.5 V to 2.3 V
	CLKVDD ⁽²⁾	–0.5 V to 4 V
	IOVDD ⁽²⁾	–0.5 V to 4 V
	PLLVDD ⁽²⁾	–0.5 V to 4 V
Voltage between AGND, DGND, CLKGND, PLLGND, and IOGND		–0.5 V to 0.5 V
Supply voltage range	AVDD to DVDD	–0.5 V to 2.6 V
	DA[15..0] ⁽⁴⁾	–0.5 V to IOVDD + 0.5 V
	DB[15..0] ⁽⁴⁾	–0.5 V to IOVDD + 0.5 V
	SLEEP ⁽⁴⁾	–0.5 V to IOVDD + 0.5 V
	CLK1/2, CLK1/2C ⁽³⁾	–0.5 V to CLKVDD + 0.5 V
	RESETB ⁽⁴⁾	–0.5 V to IOVDD + 0.5 V
	LPF ⁽⁴⁾	–0.5 V to PLLVDD + 0.5 V
	IOUT1, IOUT2 ⁽²⁾	–1.0 V to AVDD + 0.5 V
	EXTIO, BIASJ ⁽²⁾	–0.5 V to AVDD + 0.5 V
	EXTLO ⁽²⁾	–0.5 V to IAVDD + 0.5 V
Peak input current (any input)		20 mA
Peak total input current (all inputs)		30 mA
T _A	Operating free-air temperature range (DAC5687I)	–40°C to 85°C
T _{stg}	Storage temperature range	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from the case for 10 seconds		260°C

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) Measured with respect to AGND.
(3) Measured with respect to DGND.
(4) Measured with respect to IOGND.

THERMAL CHARACTERISTICS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

Thermal Conductivity		100 HTQFP	UNIT
T _J	Junction temperature ⁽²⁾	105	°C
θ _{JA}	Theta junction-to-ambient (still air)	19.88	°C/W
	Theta junction-to-ambient (150 lfm)	14.37	°C/W
θ _{JC}	Theta junction-to-case	0.12	°C/W

- (1) Air flow or heat sinking reduces θ_{JA} and is highly recommended.
(2) Air flow or heat sinking required for sustained operation at 85°C and maximum operating conditions to maintain junction temperature.

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range, AVDD = 3.3 V, CLKVDD = 3.3 V, PLLVDD = 3.3 V, IOVDD = 3.3 V, DVDD = 1.8 V, IOUT_{FS} = 19.2 mA (unless otherwise noted)

DC SPECIFICATIONS							
PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
RESOLUTION				16			Bits
DC ACCURACY ⁽¹⁾							
INL	Integral nonlinearity	1 LSB = IOUT _{FS} /2 ¹⁶ T _{MIN} to T _{MAX}			±4		LSB
DNL	Differential nonlinearity				±4		LSB
ANALOG OUTPUT							
	Coarse gain linearity	Worst case error from ideal linearity			±0.04		LSB
	Fine gain linearity				±3		LSB
	Offset error	Mid code offset			0.01		%FSR
	Gain error	Without internal reference			1		%FSR
		With internal reference			0.7		%FSR
	Gain mismatch	With internal reference, dual DAC, and SSB mode		-2		2	%FSR
	Minimum full-scale output current ⁽²⁾				2		mA
	Maximum full-scale output current ⁽²⁾				20		mA
	Output compliance range ⁽³⁾	IOUT _{FS} = 20 mA		AVDD –0.5 V		AVDD + 0.5 V	V
	Output resistance				300		kΩ
	Output capacitance				5		pF
REFERENCE OUTPUT							
	Reference voltage			1.14	1.2	1.26	V
	Reference output current ⁽⁴⁾				100		nA
REFERENCE INPUT							
V _{EXTIO}	Input voltage range			0.1		1.25	V
	Input resistance				1		MΩ
	Small signal bandwidth				1.4		MHz
	Input capacitance				100		pF
TEMPERATURE COEFFICIENTS							
	Offset drift				±1		ppm of FSR/°C
	Gain drift	Without internal reference			±15		ppm of FSR/°C
		With internal reference			±30		
	Reference voltage drift				±8		ppm of FSR/°C
POWER SUPPLY							
AVDD	Analog supply voltage			3	3.3	3.6	V
DVDD	Digital supply voltage			1.71	1.8	2.15	V
CLKVDD	Clock supply voltage			3	3.3	3.6	V
IOVDD	I/O supply voltage			1.71		3.6	V
PLLVDD	PLL supply voltage			3	3.3	3.6	V

(1) Measured differential across IOUTA1 and IOUTA2 or IOUTB1 and IOUTB2 with 25 Ω each to AVDD.

(2) Nominal full-scale current, IOUT_{FS}, equals 32X the IBIAS current.

(3) The lower limit of the output compliance is determined by the CMOS process. Exceeding this limit may result in transistor breakdown, resulting in reduced reliability of the DAC5687 device. The upper limit of the output compliance is determined by the load resistors and full-scale output current. Exceeding the upper limit adversely affects distortion performance and integral nonlinearity.

(4) Use an external buffer amplifier with high impedance input to drive any external load.

ELECTRICAL CHARACTERISTICS (continued)

over recommended operating free-air temperature range, AVDD = 3.3 V, CLKVDD = 3.3 V, PLLVDD = 3.3 V, IOVDD = 3.3 V, DVDD = 1.8 V, IOUT_{FS} = 19.2 mA (unless otherwise noted)

DC SPECIFICATIONS						
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I _{AVDD}	Analog supply current	Mode 5 ⁽⁵⁾		41		mA
		Mode 6 ⁽⁵⁾		80		mA
I _{DVDD}	Digital supply current ⁽⁵⁾	Mode 6 ⁽⁵⁾		587		mA
I _{CLKVDD}	Clock supply current ⁽⁵⁾	Mode 6 ⁽⁵⁾		5		mA
I _{PLLVDD}	PLL supply current ⁽⁵⁾	Mode 6 ⁽⁵⁾		20		mA
I _{IOVDD}	IO supply current ⁽⁵⁾	Mode 6 ⁽⁵⁾		2		mA
I _{AVDD}	Sleep mode AVDD supply current	Sleep mode (Sleep pin high) CLK2 = 500 MHz		1		mA
I _{DVDD}	Sleep mode DVDD supply current	Sleep mode (Sleep pin high) CLK2 = 500 MHz		2		mA
I _{CLKVDD}	Sleep mode CLKVDD supply current	Sleep mode (Sleep pin high) CLK2 = 500 MHz		0.25		mA
I _{PLLVDD}	Sleep mode PLLVDD supply current	Sleep mode (Sleep pin high) CLK2 = 500 MHz		0.6		mA
I _{IOVDD}	Sleep mode IOVDD supply current	Sleep mode (Sleep pin high) CLK2 = 500 MHz		0.6		mA
P _D	Power dissipation	Mode 1 ⁽⁵⁾ AVDD = 3.3 V, DVDD = 1.8 V		750		mW
		Mode 2 ⁽⁵⁾ AVDD = 3.3 V, DVDD = 1.8 V		910		
		Mode 3 ⁽⁵⁾ AVDD = 3.3 V, DVDD = 1.8 V		760		
		Mode 4 ⁽⁵⁾ AVDD = 3.3 V, DVDD = 1.8 V		1250		
		Mode 5 ⁽⁵⁾ AVDD = 3.3 V, DVDD = 1.8 V		1250		
		Mode 6 ⁽⁵⁾ AVDD = 3.3 V, DVDD = 1.8 V		1410		
		Mode 7 ⁽⁵⁾ AVDD = 3.3 V, DVDD = 1.8 V		1400	1750	
		Sleep mode (Sleep pin high) CLK2 = 500 MHz		11	20	
APSRR	Power supply rejection ratio		-0.2		0.2	%FSR/V
DPSRR			-0.2		0.2	%FSR/V

(5) MODE 1 – MODE 7:

- Mode 1: X2, PLL off, CLK2 = 320 MHz, DACA and DACB on, IF = 5 MHz
- Mode 2: X4 QMC, PLL on, CLK1 = 125 MHz, DACA and DACB on, IF = 5 MHz
- Mode 3: X4 CMIX, PLL off, CLK2 = 500 MHz, DACA off and DACB on, IF = 150 MHz
- Mode 4: X4L FMIX CMIX, PLL off, CLK2 = 500 MHz, DACA off and DACB on, IF = 150 MHz
- Mode 5: X4L FMIX CMIX, PLL on, CLK1 = 125 MHz, DACA off and DACB on, IF = 150 MHz
- Mode 6: X4L FMIX CMIX, PLL on, CLK1 = 125 MHz, DACA on and DACB on, IF = 150 MHz
- Mode 7: X8 FMIX CMIX, PLL on, CLK1 = 62.5 MHz, DACA and DACB on, IF = 150 MHz

ELECTRICAL CHARACTERISTICS⁽¹⁾

over recommended operating free-air temperature range, AVDD = 3.3 V, CLKVDD = 3.3 V, PLLVDD = 0 V (= 3.3 V for PLL Clock Mode), IOVDD = 3.3 V, DVDD = 1.8 V, IOUT_{FS} = 19.2 mA, External Clock Mode, 4:1 transformer output termination, 50-Ω doubly terminated load (unless otherwise noted)

AC SPECIFICATIONS				
PARAMETER		TEST CONDITIONS	MIN TYP MAX	UNIT
ANALOG OUTPUT				
f _{CLK}	Maximum output update rate		500	MSPS
t _{s(DAC)}	Output settling time to 0.1%	Transition: Code 0x0000 to 0xFFFF	10.4	ns
t _{pd}	Output propagation delay		3	ns
t _{r(IOUT)}	Output rise time 10% to 90%		2	ns
t _{f(IOUT)}	Output fall time 90% to 10%		2	ns
AC PERFORMANCE				
SFDR	Spurious free dynamic range ⁽²⁾	X2, PLL off, CLK2 = 250 MHz, DAC A and DAC B on, IF = 5.1 MHz, First Nyquist Zone < f _{DATA} /2	78	dBc
		X4, PLL off, CLK2 = 500 MHz, DAC A and DAC B on, IF = 5.1 MHz, First Nyquist Zone < f _{DATA} /2	77	
		X4, CLK2 = 500 MHz, DAC A and DAC B on, IF = 20.1 MHz, PLL on for Min, PLL off for TYP, First Nyquist Zone < f _{DATA} /2	68 ⁽³⁾ 76	
SNR	Signal-to-noise ratio	X4, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, Single tone, 0 dBFS, IF = 20.1 MHz	73	dBc
		X4 CMIX, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, IF = 70.1 MHz	65	
		X4 CMIX, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, Single tone, 0 dBFS, IF = 150.1 MHz	57	
		X4 FMIX CMIX, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, Single tone, 0 dBFS, IF = 180.1 MHz	54	
		X4, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, Four tone, each -12 dBFS, IF = 24.7, 24.9, 25.1, 25.3 MHz	73	
IMD3	Third-order two-tone intermodulation (each tone at -6 dBFS)	X4, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, IF = 20.1 and 21.1 MHz	79	dBc
		X4 CMIX, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, IF = 70.1 and 71.1 MHz	73	
		X4 CMIX, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, IF = 150.1 and 151.1 MHz	68	
		X4 FMIX CMIX, PLL off, CLK2 = 500 MSPS, DAC A and DAC B on, IF = 180.1 and 181.1 MHz	67	
IMD	Four-tone Intermodulation to Nyquist (each tone at -12 dBFS)	X4 CMIX, CLK2 = 500 MHz f _{OUT} = 149.2, 149.6, 150.4, and 150.8 MHz	66	dBc

(1) Measured single ended into 50-Ω load.

(2) See the Non-Harmonic Clock Related Spurious Signals section for information on spurious products out of band (< f_{DATA}/2).

(3) 1:1 transformer output termination.

ELECTRICAL CHARACTERISTICS (continued)

over recommended operating free-air temperature range, AVDD = 3.3 V, CLKVDD = 3.3 V, PLLVDD = 0 V (= 3.3 V for PLL Clock Mode), IOVDD = 3.3 V, DVDD = 1.8 V, IOUT_{FS} = 19.2 mA, External Clock Mode, 4:1 transformer output termination, 50-Ω doubly terminated load (unless otherwise noted)

AC SPECIFICATIONS						
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ACLR ⁽⁴⁾	Adjacent channel leakage ratio	Single carrier, baseband, X4, PLL Clock Mode, CLK1 = 122.88 MHz		78.4		dBc
		Single carrier, baseband, X4, PLL Clock Mode, CLK2 = 491.52 MHz		78.5		
		Single carrier, IF = 153.6 MHz, X4 CMIX, External Clock Mode, CLK2 = 491.52 MHz		70.9		
		Two carrier, IF = 153.6 MHz, X4 CMIX, External Clock Mode, CLK2 = 491.52 MHz		67.8		
		Four carrier, baseband, X4, External Clock Mode, CLK2 = 491.52 MHz		76.1		
		Four carrier, IF = 92.16 MHz, X4L, External Clock Mode, CLK2 = 491.52 MHz		66.8		
		Single carrier, IF = 153.6 MHz, X4 CMIX, External Clock Mode, CLK2 = 491.52 MHz, DVDD = 2.1 V		72.2		
		Two carrier, IF = 153.6 MHz, X4 CMIX, External Clock Mode, CLK2 = 491.52 MHz, DVDD = 2.1 V		69.3		
		Four carrier, baseband, X4, External Clock Mode, CLK2 = 491.52 MHz, DVDD = 2.1 V		68.5		
		Four carrier, IF = 92.16 MHz, X4L, External Clock Mode, CLK2 = 491.52 MHz, DVDD = 2.1 V		66.3		
	Noise Floor	50-MHz offset, 1-MHz BW, Single carrier, baseband, X4, External Clock Mode, CLK1 = 122.88 MHz		92		dBc
		50-MHz offset, 1-MHz BW, Four carrier, baseband, X4, External Clock Mode, CLK1 = 122.88 MHz		81		
		50-MHz offset, 1-MHz BW, Single carrier, baseband, X4, PLL Clock Mode, CLK2 = 491.52 MHz		88		
		50-MHz offset, 1-MHz BW, Four carrier, baseband, X4, PLL Clock Mode, CLK2 = 491.52 MHz		81		

(4) W-CDMA with 3.84 MHz BW, 5-MHz spacing, centered at IF. TESTMODEL 1, 10 ms

ELECTRICAL CHARACTERISTICS (DIGITAL SPECIFICATIONS)

over recommended operating free-air temperature range, AVDD = 3.3 V, CLKVDD = 3.3 V, PLLVDD = 3.3 V, IOVDD = 3.3 V, DVDD = 1.8 V, IOUT_{FS} = 19.2 mA (unless otherwise noted)

DIGITAL SPECIFICATIONS							
PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
CMOS INTERFACE							
V _{IH}	High-level input voltage			2	3		V
V _{IL}	Low-level input voltage			0	0	0.8	V
I _{IH}	High-level input current			−40		40	μA
I _{IL}	Low-level input current			−40		40	μA
	Input capacitance			5			pF
V _{OH}	PLLLOCK, SDO, SDIO	I _{load} = −100 μA		IOVDD − 0.2			V
		I _{load} = −8 mA		0.8 x IOVDD			V
V _{OL}	PLLLOCK, SDO, SDIO	I _{load} = 100 μA		0.2			V
		I _{load} = 8 mA		0.22 x IOVDD			V
	Input data rate	External or dual-clock modes		16		250	MSPS
		PLL clock mode		16		160	

ELECTRICAL CHARACTERISTICS (DIGITAL SPECIFICATIONS) (continued)

over recommended operating free-air temperature range, AVDD = 3.3 V, CLKVDD = 3.3 V, PLLVDD = 3.3 V, IOVDD = 3.3 V, DVDD = 1.8 V, IOUT_{FS} = 19.2 mA (unless otherwise noted)

DIGITAL SPECIFICATIONS						
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
PLL						
Phase noise		At 600-kHz offset, measured at DAC output, 25 MHz 0-dBFS tone, F _{DATA} = 125 MSPS, 4x interpolation, pll_freq = 1, pll_kv = 0	133			dBc/Hz
		At 6-MHz offset, measured at DAC output, 25 MHz 0-dBFS tone, 125 MSPS, 4x interpolation, pll_freq = 1, pll_kv = 0	148.5			dBc/Hz
VCO maximum frequency		pll_freq = 0, pll_kv = 0	370			MHz
		pll_freq = 0, pll_kv = 1	480			
		pll_freq = 1, pll_kv = 0	495			
		pll_freq = 1, pll_kv = 1	520			
VCO minimum frequency		pll_freq = 0, pll_kv = 0			225	MHz
		pll_freq = 0, pll_kv = 1			200	
		pll_freq = 1, pll_kv = 0			480	
		pll_freq = 1, pll_kv = 1			480	
NCO and QMC BLOCKS						
QMC clock rate					320	MHz
NCO clock rate					320	MHz
SERIAL PORT TIMING						
t _s (SDENB)	Setup time, SDENB to rising edge of SCLK		20			ns
t _s (SDIO)	Setup time, SDIO valid to rising edge of SCLK		10			ns
t _h (SDIO)	Hold time, SDIO valid to rising edge of SCLK		5			ns
t _{SCLK}	Period of SCLK		100			ns
t _{SCLKH}	High time of SCLK		40			ns
t _{SCLK}	Low time of SCLK		40			ns
t _d (Data)	Data output delay after falling edge of SCLK		10			ns
CLOCK INPUT (CLK1/CLK1C, CLK2/CLK2C)						
Duty cycle			40%		60%	
Differential voltage			0.4		1	V
TIMING PARALLEL DATA INPUT: CLK1 LATCHING MODES (PLL Mode –Figure 45, Dual Clock Mode FIFO Disabled – See Figure 47, Dual Clock Mode With FIFO Enabled – See Figure 48)						
t _s (DATA)	Setup time, DATA valid to rising edge of CLK1		0.5			ns
t _h (DATA)	Hold time, DATA valid after rising edge of CLK1		1.5			ns
t _{align}	Maximum offset between CLK1 and CLK2 rising edges – Dual Clock Mode with FIFO disabled		$\frac{1}{2F_{CLK2}} - 0.5 \text{ ns}$			ns
Timing Parallel Data Input (External Clock Mode, Latch on PLLLock Rising Edge, CLK2 Clock Input, See Figure 43)						
t _s (DATA)	Setup time, DATA valid to rising edge of PLLLOCK	72-Ω load on PLLLOCK	0.5			ns
t _h (DATA)	Hold time, DATA valid after rising edge of PLLLOCK	72-Ω load on PLLLOCK	1.5			ns
t _{delay} (PLLlock)	Delay from CLK2 rising edge to PLLLOCK rising edge	72-Ω load on PLLLOCK. Note that PLLLOCK delay increases with a lower impedance load.	4.5			ns
Timing Parallel Data Input (External Clock Mode, Latch on PLLLock Falling Edge, CLK2 Clock Input, See Figure 44)						
t _s (DATA)	Setup time, DATA valid to falling edge of PLLLOCK	High impedance load on PLLLOCK	0.5			ns
t _h (DATA)	Hold time, DATA valid after falling edge of PLLLOCK	High impedance load on PLLLOCK	1.5			ns

ELECTRICAL CHARACTERISTICS (DIGITAL SPECIFICATIONS) (continued)

over recommended operating free-air temperature range, AVDD = 3.3 V, CLKVDD = 3.3 V, PLLVDD = 3.3 V, IOVDD = 3.3 V, DVDD = 1.8 V, IOUT_{FS} = 19.2 mA (unless otherwise noted)

DIGITAL SPECIFICATIONS					
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{delay(PLLlock)} Delay from CLK2 rising edge to PLLLOCK rising edge	High impedance load on PLLLOCK. Note that PLLLOCK delay increases with a lower impedance load.		4.5		ns

Typical Characteristics

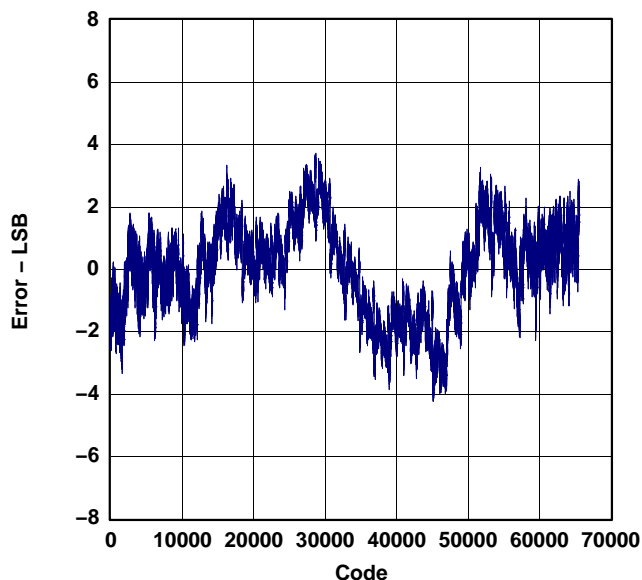


Figure 1. Integral Nonlinearity

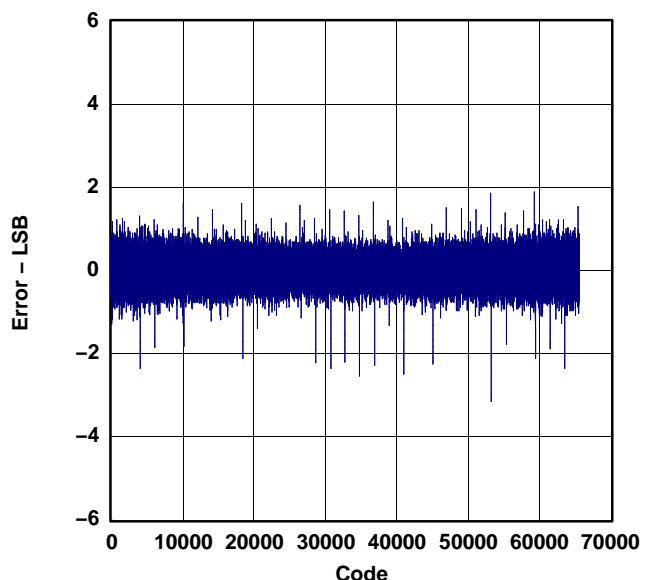


Figure 2. Differential Nonlinearity

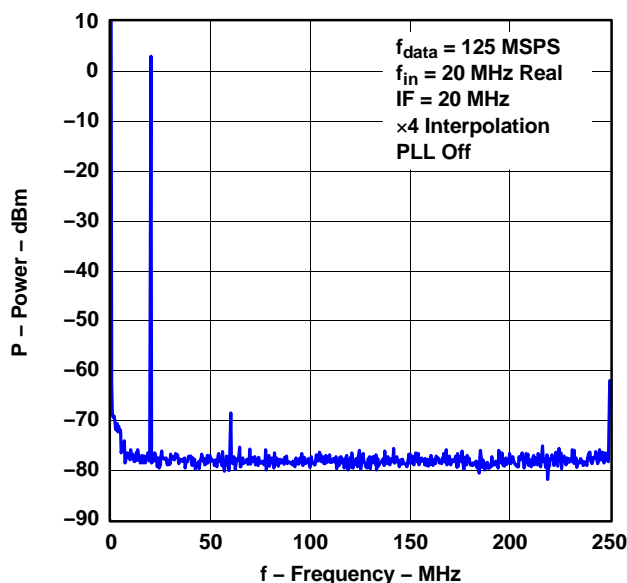


Figure 3. Single Tone Spectral Plot

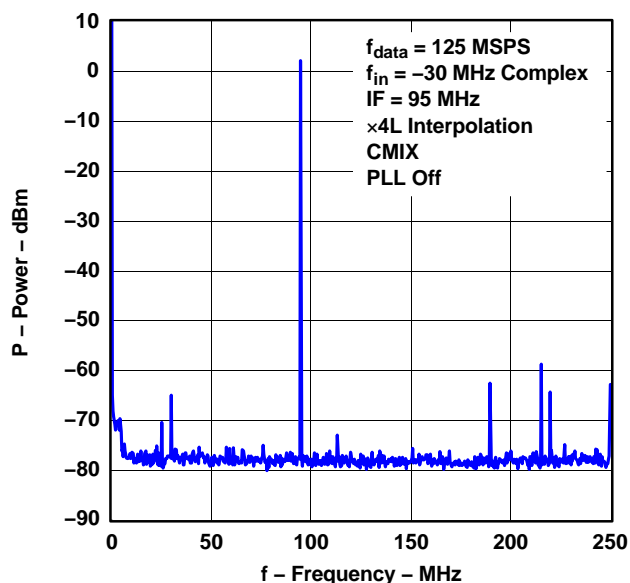


Figure 4. Single Tone Spectral Plot

Typical Characteristics (continued)

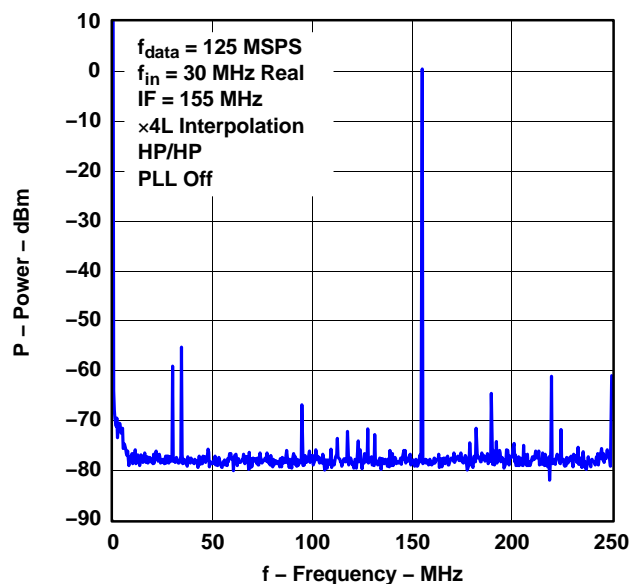


Figure 5. Single Tone Spectral Plot

G005

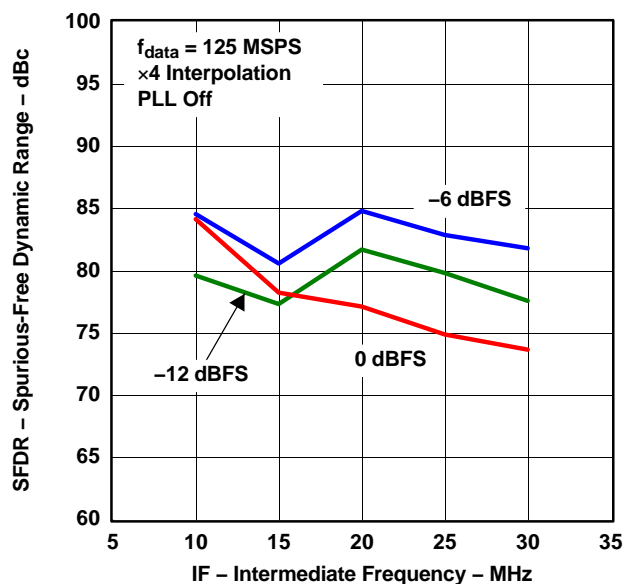


Figure 6. In-Band SFDR vs Intermediate Frequency

G006

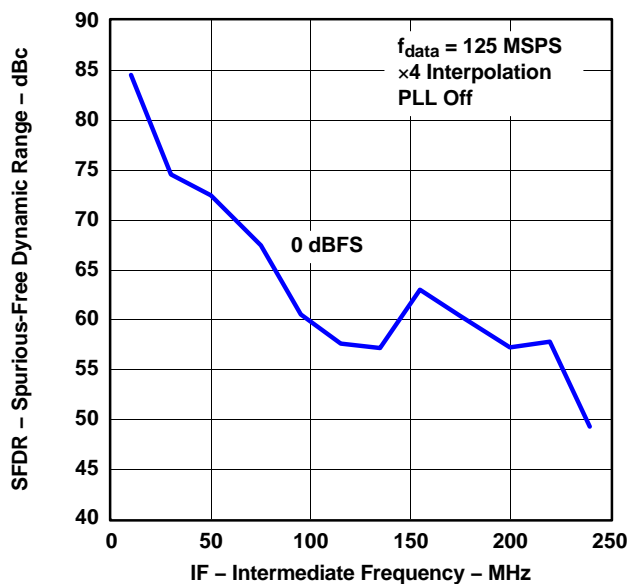


Figure 7. Out-of-Band SFDR vs Intermediate Frequency

G007

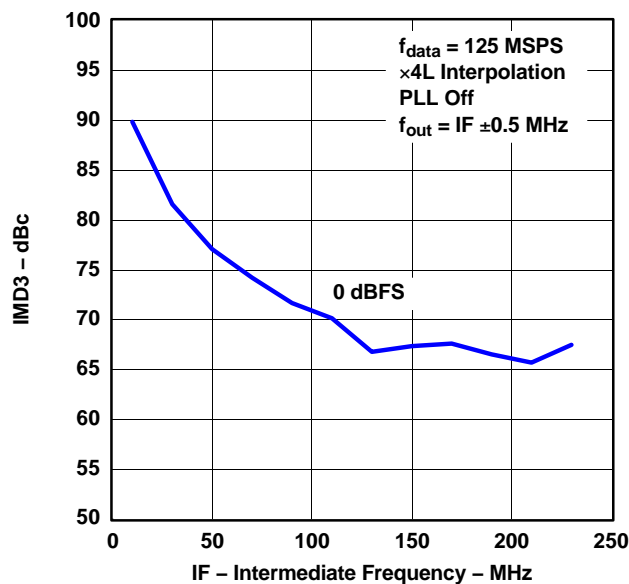


Figure 8. Two Tone IMD vs Intermediate Frequency

G008

Typical Characteristics (continued)

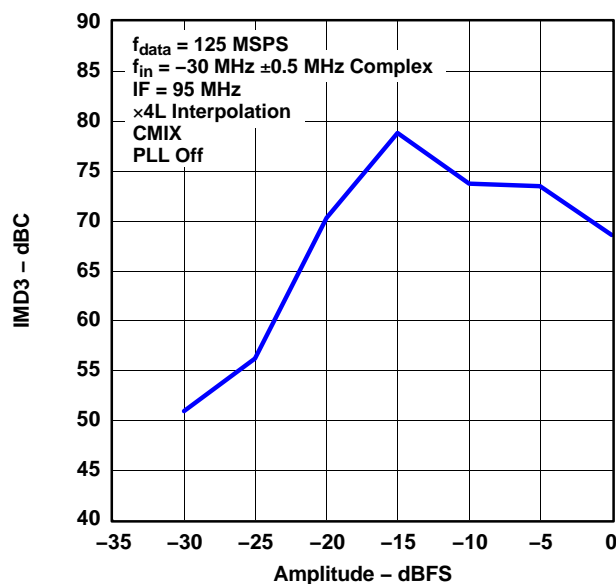


Figure 9. Two Tone IMD vs Amplitude

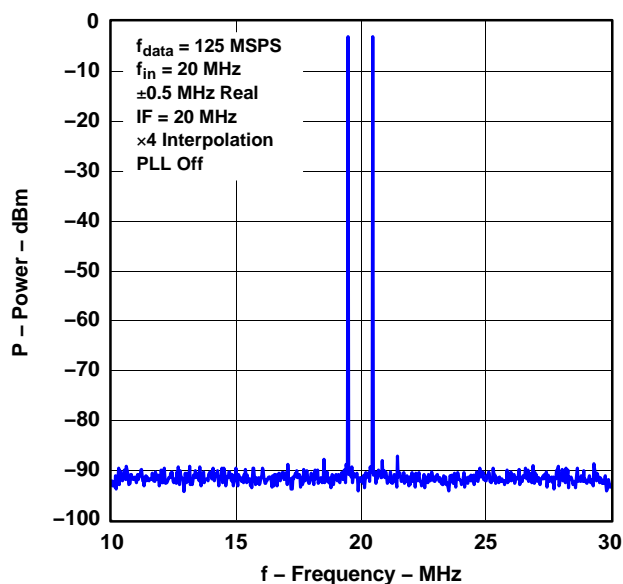


Figure 10. Two Tone IMD Spectral Plot

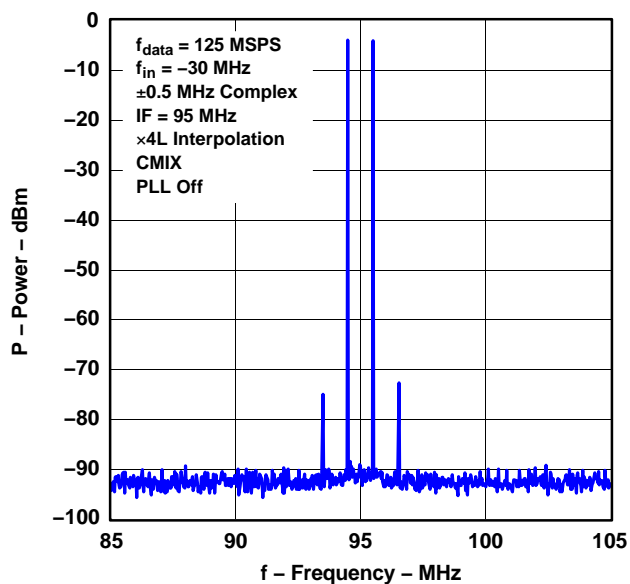


Figure 11. Two Tone IMD Spectral Plot

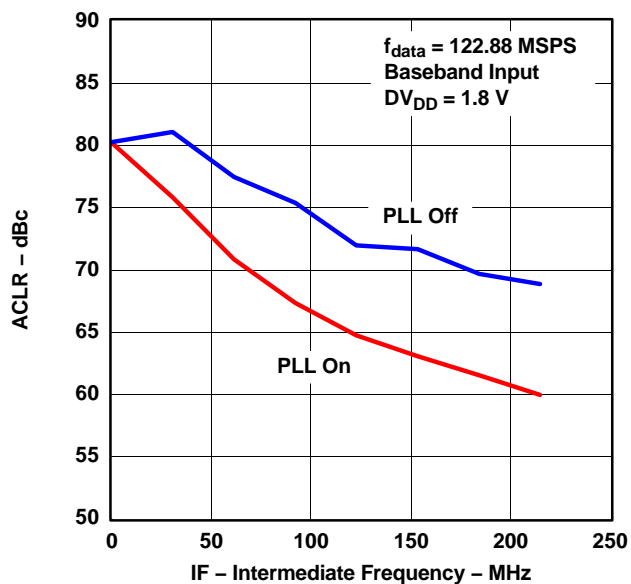
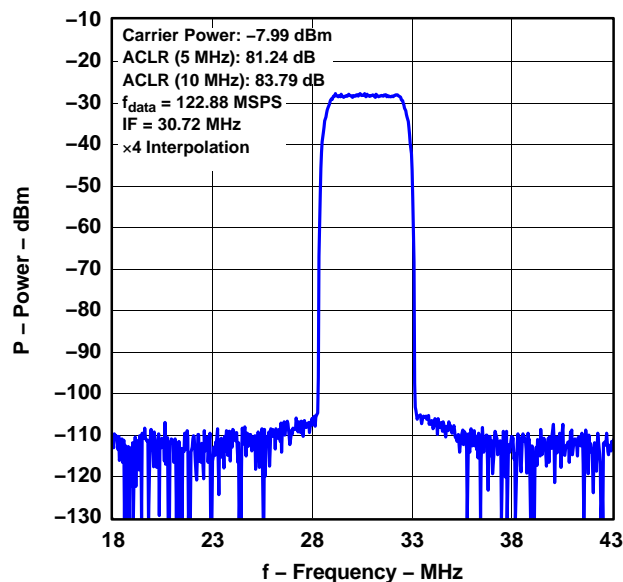


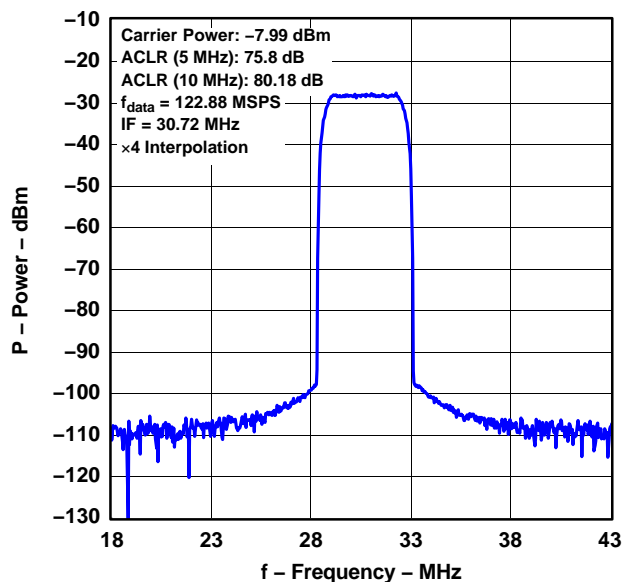
Figure 12. WCDMA ACLR vs Intermediate Frequency

Typical Characteristics (continued)



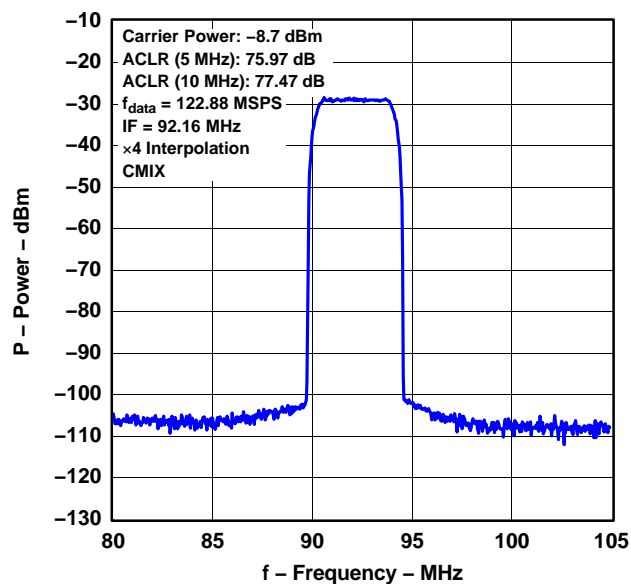
G013

Figure 13. WCDMA TM1 : Single Carrier, PLL Off, DVDD = 1.8 V



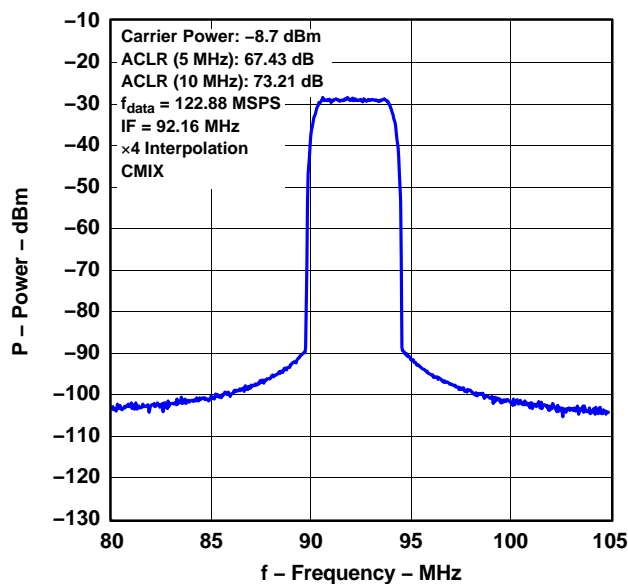
G014

Figure 14. WCDMA TM1 : Single Carrier, PLL On, DVDD = 1.8 V



G015

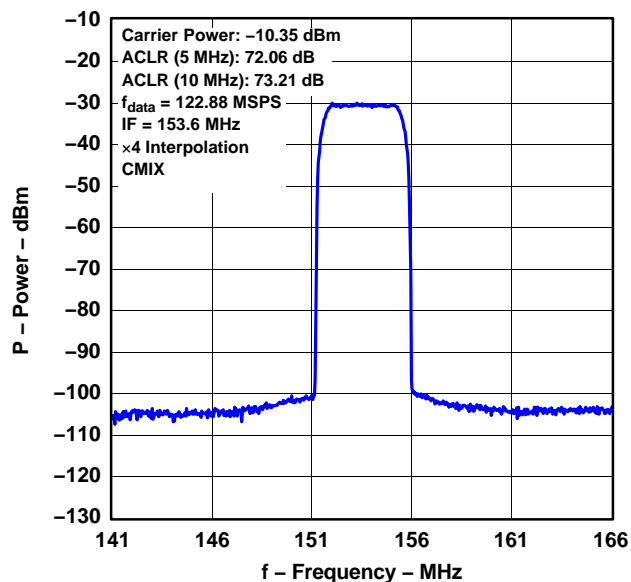
Figure 15. WCDMA TM1 : Single Carrier, PLL Off, DVDD = 1.8 V



G016

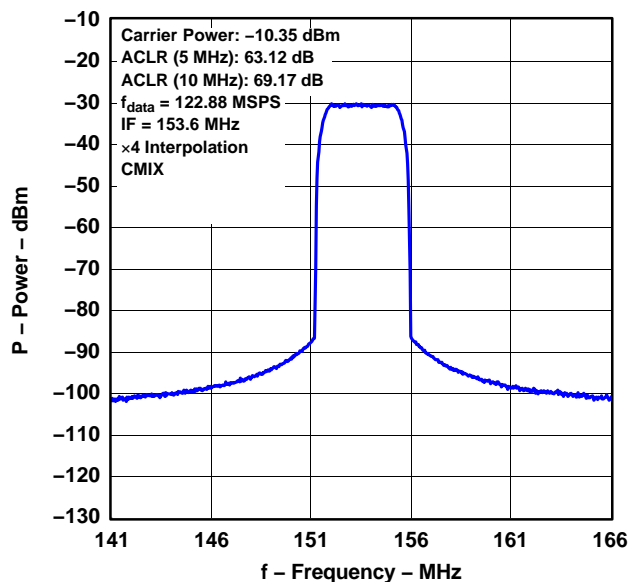
Figure 16. WCDMA TM1 : Single Carrier, PLL On, DVDD = 1.8 V

Typical Characteristics (continued)



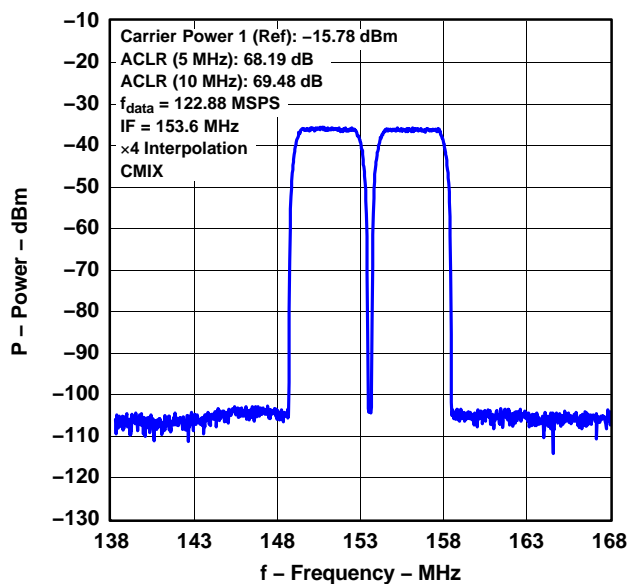
G017

Figure 17. WCDMA TM1 : Single Carrier, PLL Off, DVDD = 1.8 V



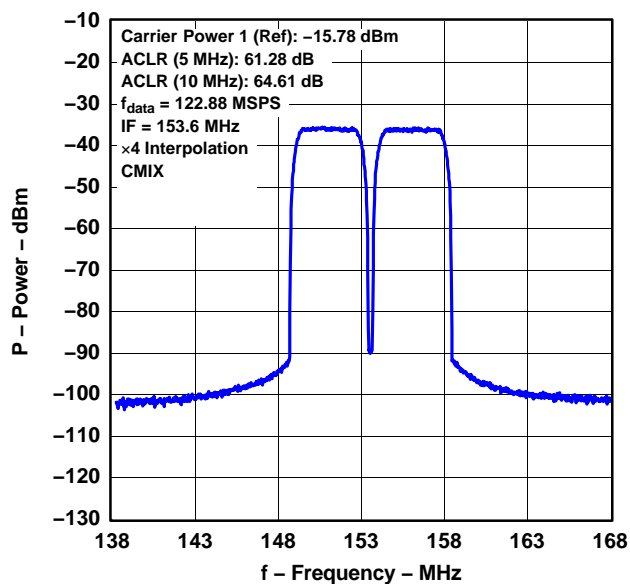
G018

Figure 18. WCDMA TM1 : Single Carrier, PLL On, DVDD = 1.8 V



G019

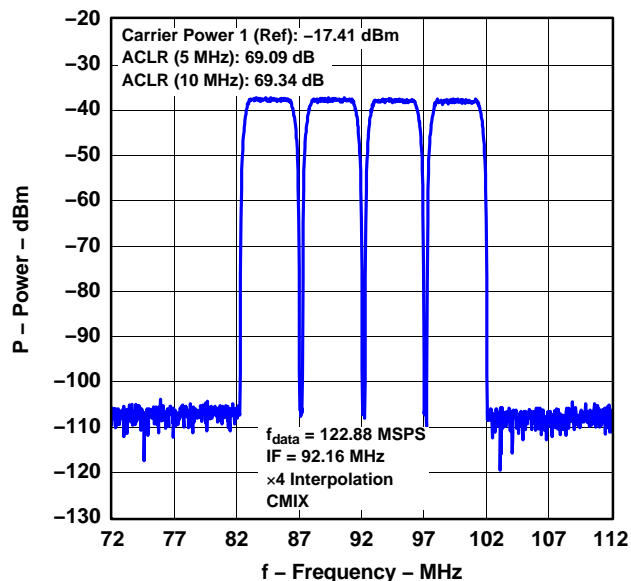
Figure 19. WCDMA TM1 : Two Carrier, PLL Off, DVDD = 1.8 V



G020

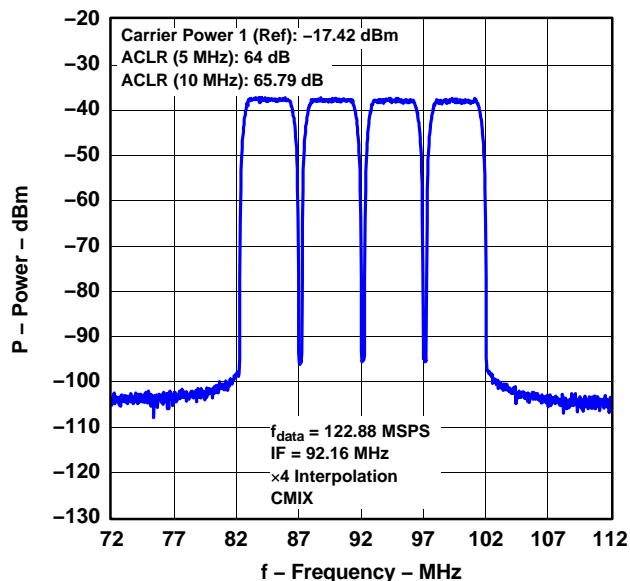
Figure 20. WCDMA TM1 : Two Carrier, PLL On, DVDD = 1.8 V

Typical Characteristics (continued)



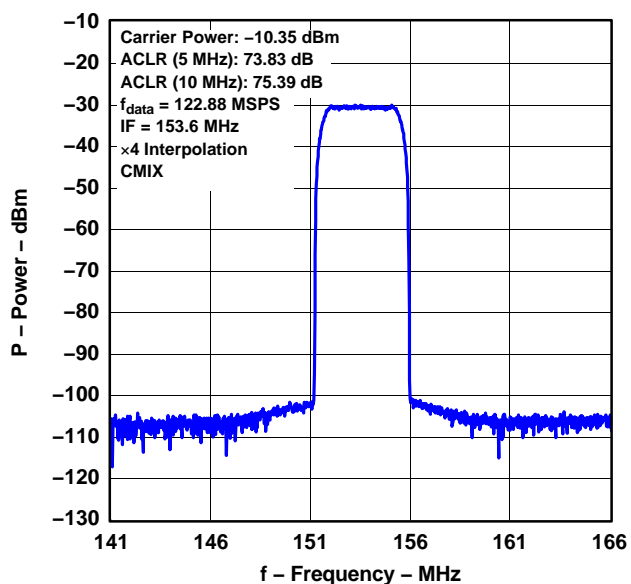
G021

Figure 21. WCDMA TM1 : Four Carrier, PLL Off, DVDD = 1.8 V



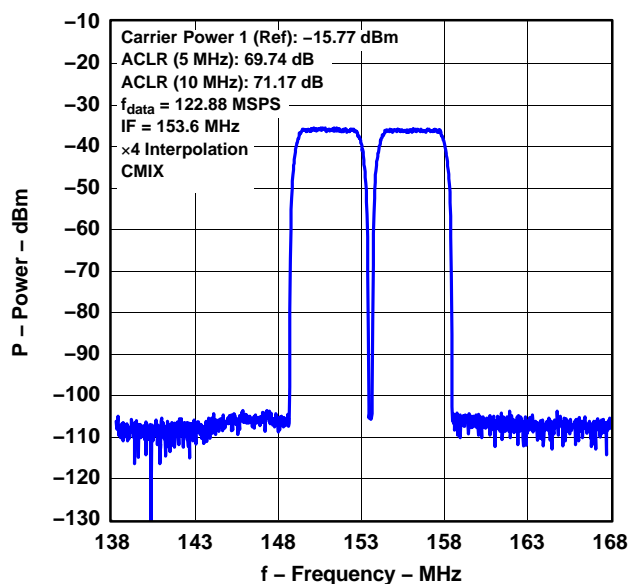
G022

Figure 22. WCDMA TM1 : Four Carrier, PLL On, DVDD = 1.8 V



G023

Figure 23. WCDMA TM1 : Single Carrier, PLL Off, DVDD = 2.1 V



G024

Figure 24. WCDMA TM1 : Two Carrier, PLL Off, DVDD = 2.1 V

Typical Characteristics (continued)

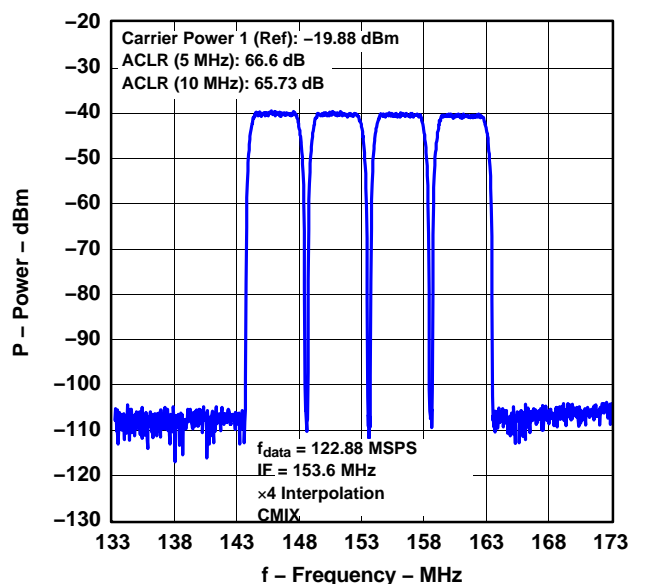


Figure 25. WCDMA TM1 : Four Carrier, PLL Off,
DVDD = 2.1 V

Test Methodology

Typical ac specifications in external clock mode were characterized with the DAC5687EVM using the test configuration shown in Figure 26. The DAC sample rate clock f_{DAC} is generated by a HP8665B signal generator. An Agilent 8133A pulse generator is used to divide f_{DAC} for the data rate clock f_{DATA} for the Agilent 16702A pattern generator clock and provide adjustable skew to the DAC input clock. The 8133A f_{DAC} output is set to 1 V_{PP}, equivalent to 2-V_{PP} differential at CLK2/CLK2C pins. Alternatively, the DAC5687 PLLLOCK output can be used for the pattern generator clock.

The DAC5687 output is characterized with a Rohde & Schwarz FSQ8 spectrum analyzer. For WCDMA signal characterization, it is important to use a spectrum analyzer with high IP3 and noise subtraction capability so that the spectrum analyzer does not limit the ACPR measurement. For all specifications, both DACA and DACB are measured and the lowest value used as the specification.

Test Methodology (continued)

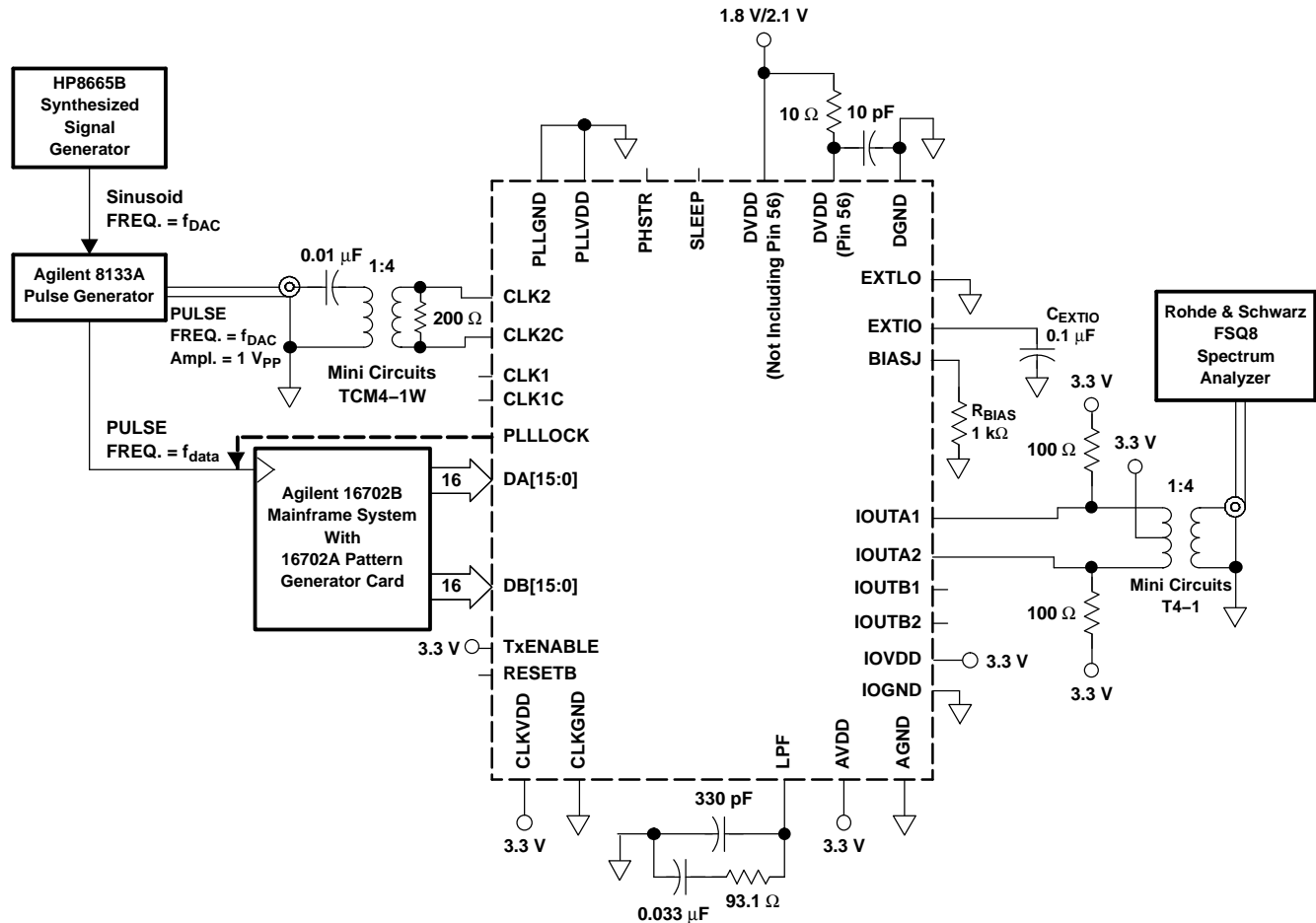
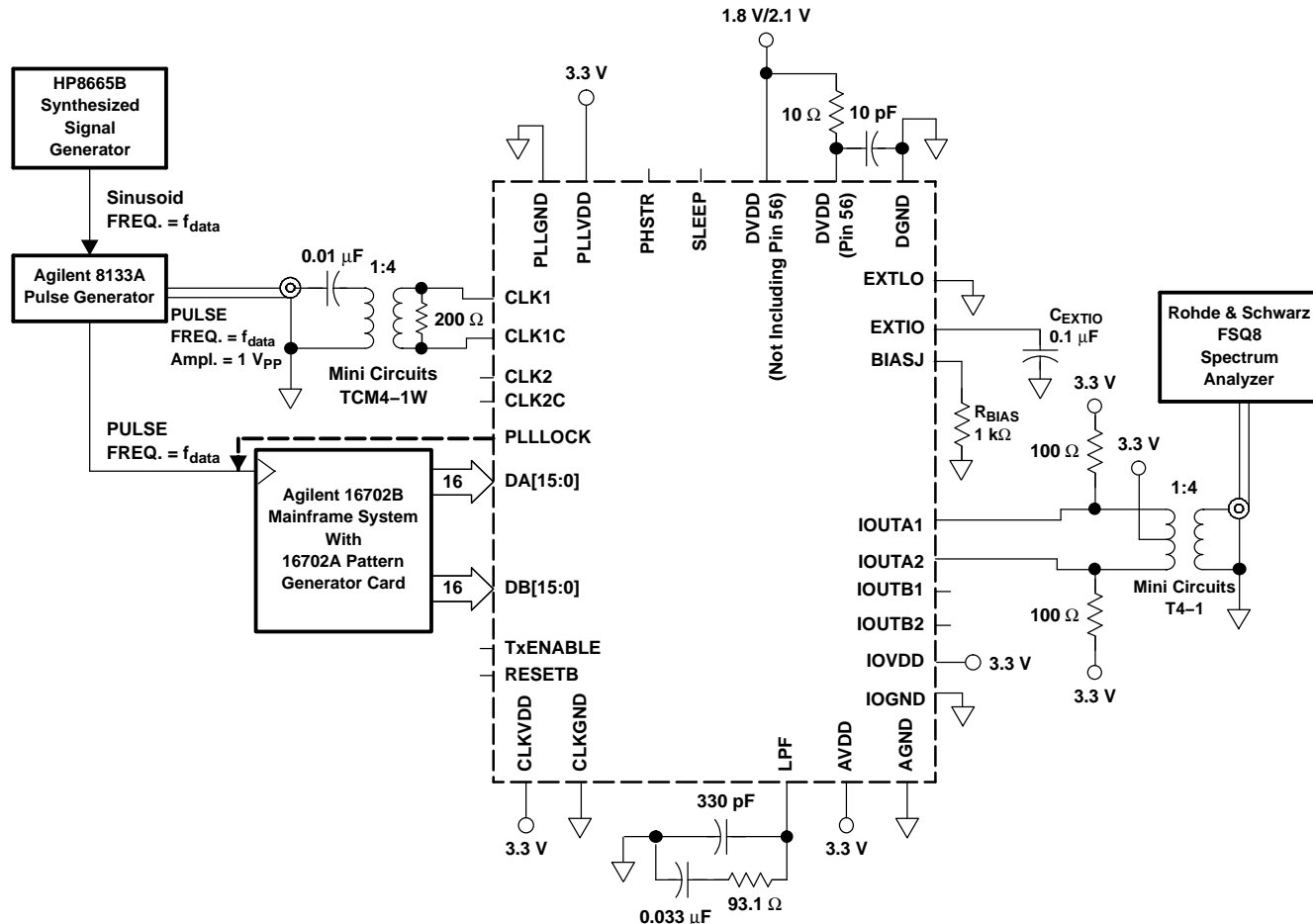


Figure 26. DAC5687 Test Configuration for External Clock Mode

PLL clock mode was characterized using the test configuration shown in [Figure 27](#). The DAC data rate clock f_{DATA} is generated by a HP8665B signal generator. An Agilent 8133A pulse generator is used to generate a clock f_{DATA} for the Agilent 16702A pattern generator clock and provide adjustable skew to the DAC input clock. The 8133A f_{DAC} output is set to 1 V_{PP}, equivalent to 2-V_{PP} differential at CLK1/CLK1C pins. Alternatively, the DAC5687 PLLLOCK output can be used for the pattern generator clock.

Test Methodology (continued)



B0039-02

Figure 27. DAC5687 Test Configuration for PLL Clock Mode

WCDMA Test Model 1 test vectors for the DAC5687 characterization were generated in accordance with the 3GPP Technical Specification. Chip rate data was generated using the Test Model 1 block in Agilent ADS. For multicarrier signals, different random seeds and PN offsets were used for each carrier. A Matlab script performed pulse shaping, interpolation to the DAC input data rate, frequency offsets, rounding and scaling. Each test vector is 10 ms long, representing one frame. Special care is taken to assure that the end of file wraps smoothly to the beginning of the file.

The cumulative complementary distribution function (CCDF) for the 1, 2, and 4 carrier test vectors is shown in [Figure 28](#). The test vectors are scaled such that the absolute maximum data point is 0.95 (-0.45 dB) of full scale. No peak reduction is used.

Test Methodology (continued)

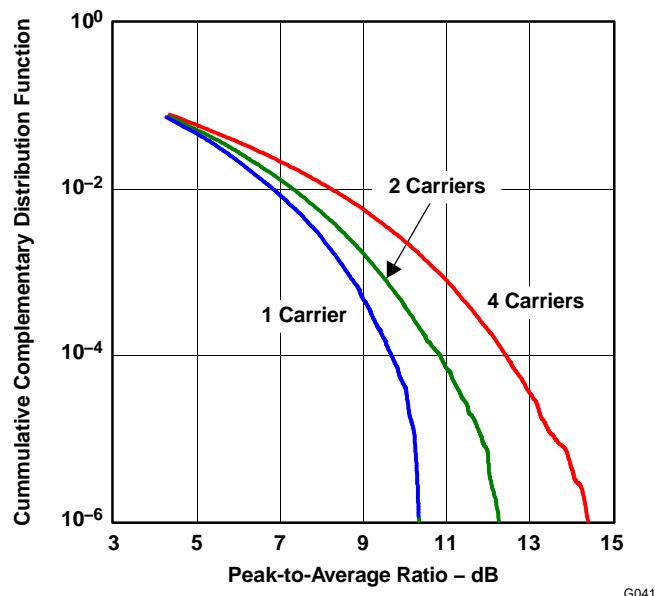


Figure 28. WCDMA TM1 Cumulative Complementary Distribution Function for 1, 2, and 4 carriers

DETAILED DESCRIPTION

Modes of Operation

The DAC5687 has six digital signal processing blocks: FIR1 and FIR2 (interpolate by two digital filters), FMIX (fine frequency mixer), QMC (quadrature modulation phase correction), FIR3 (interpolate by two digital filter) and CMIX (coarse frequency mixer). The modes of operation, listed in [Table 1](#), enable or bypass the blocks to produce different results. The modes are selected by registers CONFIG1, CONFIG2, and CONFIG3 (0x02, 0x03, and 0x04). Block diagrams for each mode (x2, x4, x4L, and x8) are shown in [Figure 29](#) through [Figure 32](#).

Table 1. DAC5687 Modes of Operation

MODE	FIR1	FIR2	FMIX	QMC	FIR3	CMIX
FULL BYPASS	–	–	–	–	–	–
X2	–	–	–	–	ON	–
X2 FMIX	–	–	ON	–	ON	–
X2 QMC	–	–	–	ON	ON	–
X2 FMIX QMC	–	–	ON	ON	ON	–
X2 CMIX	–	–	–	–	ON	ON
X2 FMIX CMIX	–	–	ON	–	ON	ON
X2 QMC CMIX	–	–	–	ON ⁽¹⁾	ON	ON
X2 FMIX QMC CMIX	–	–	ON	ON ⁽¹⁾	ON	ON
X4	ON	ON	–	–	–	–
X4 FMIX ⁽²⁾	ON	ON	ON	–	–	–
X4 QMC ⁽²⁾	ON	ON	–	ON	–	–
X4 FMIX QMC	ON	ON	ON	ON	–	–
X4 CMIX	ON	ON	–	–	–	ON

(1) The QMC phase correction will be eliminated by the CMIX, so the QMC phase should be set to zero. The QMC gain settings can still be used to adjust the signal path gain as needed.

(2) f_{DAC} limited to maximum clock rate for the NCO and QMC, (See the AC specs).

Table 1. DAC5687 Modes of Operation (continued)

MODE	FIR1	FIR2	FMIX	QMC	FIR3	CMIX
X4L	ON	–	–	–	ON	–
X4L FMIX	ON	–	ON	–	ON	–
X4L QMC	ON	–	–	ON	ON	–
X4L FMIX QMC	ON	–	ON	ON	ON	–
X4L CMIX	ON	–	–	–	ON	ON
X4L FMIX CMIX	ON	–	ON	–	ON	ON
X4L QMC CMIX	ON	–	–	ON ⁽²⁾	ON	ON
X4L FMIX QMC CMIX	ON	–	ON	ON ⁽²⁾	ON	ON
X8	ON	ON	–	–	ON	–
X8 FMIX	ON	ON	ON	–	ON	–
X8 QMC	ON	ON	–	ON	ON	–
X8 FMIX QMC	ON	ON	ON	ON	ON	–
X8 CMIX	ON	ON	–	–	ON	ON
X8 FMIX CMIX	ON	ON	ON	–	ON	ON
X8 QMC CMIX	ON	ON	–	ON ⁽³⁾	ON	ON
X8 FMIX QMC CMIX	ON	ON	ON	ON ⁽³⁾	ON	ON

(3) The QMC phase correction will be eliminated by the CMIX, so the QMC phase should be set to zero. The QMC gain settings can still be used to adjust the signal path gain as needed.

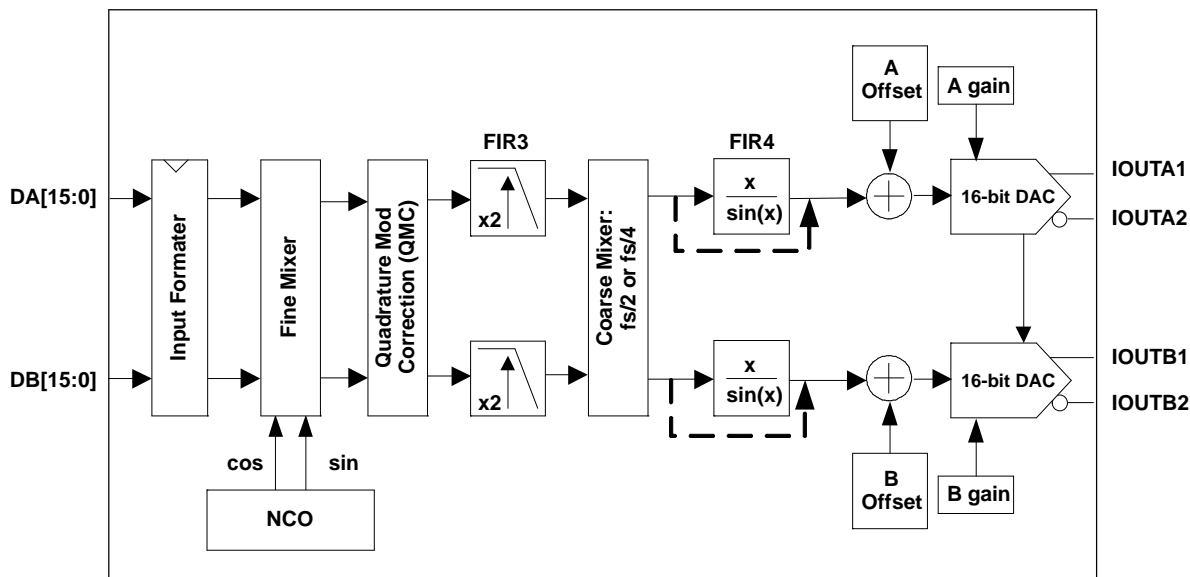
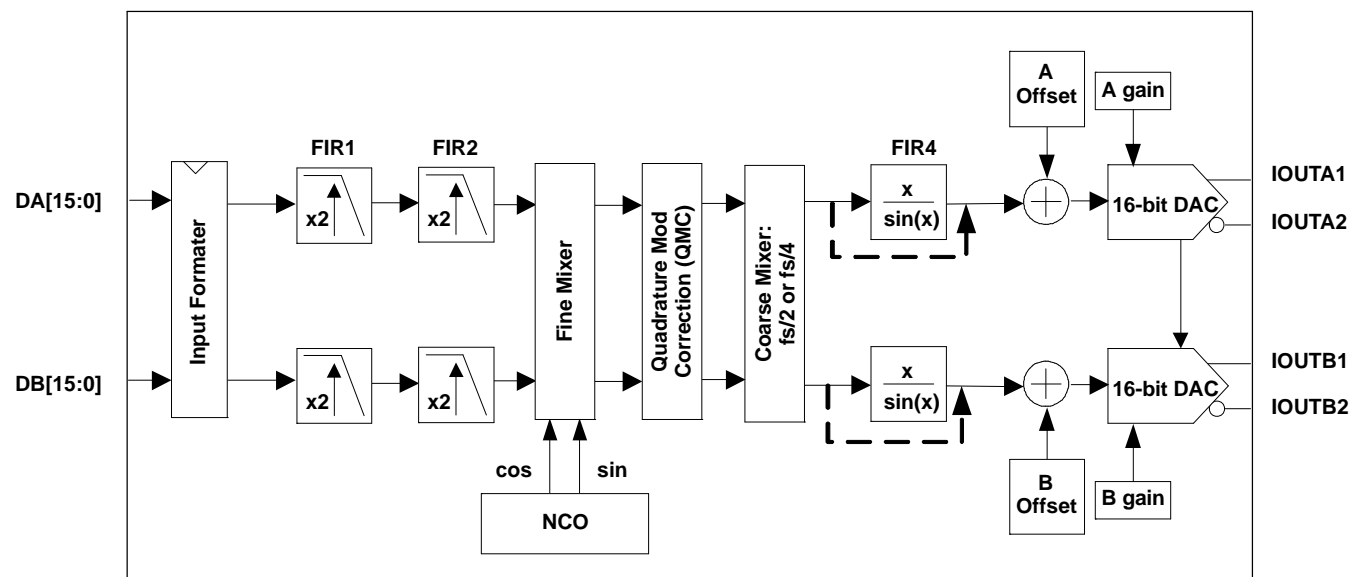


Figure 29. Block Diagram for X2 Mode



A. FMIX or QMC block cannot be enabled with CMIX block.

Figure 30. Block Diagram for X4 Mode (A)

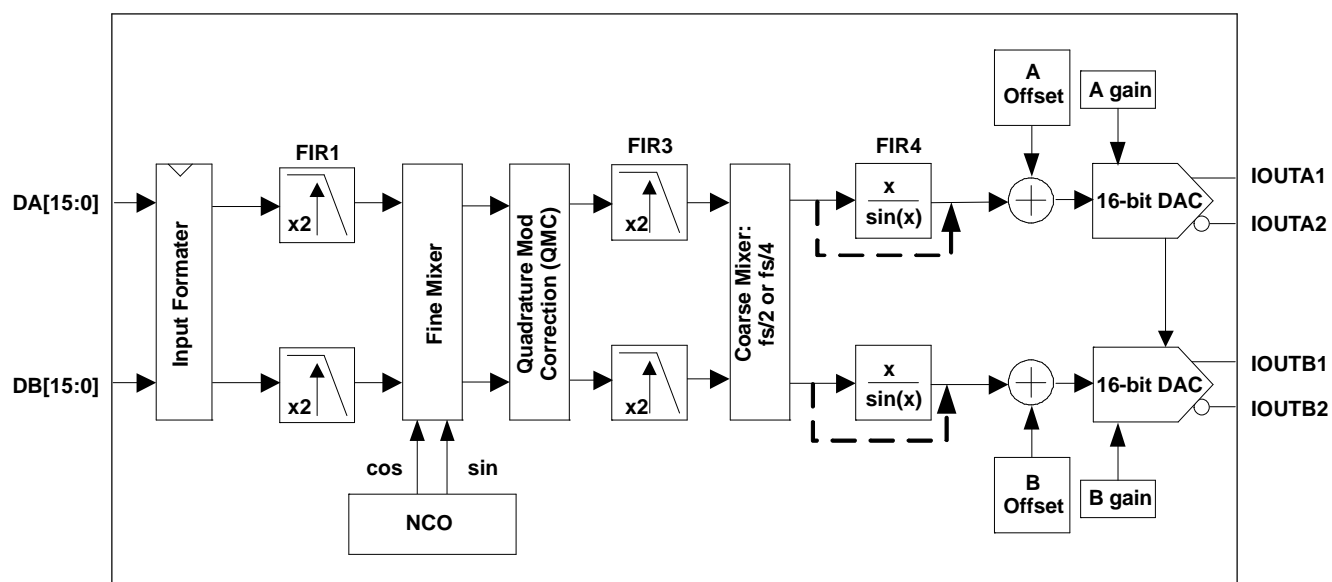


Figure 31. Block Diagram for X4L Mode

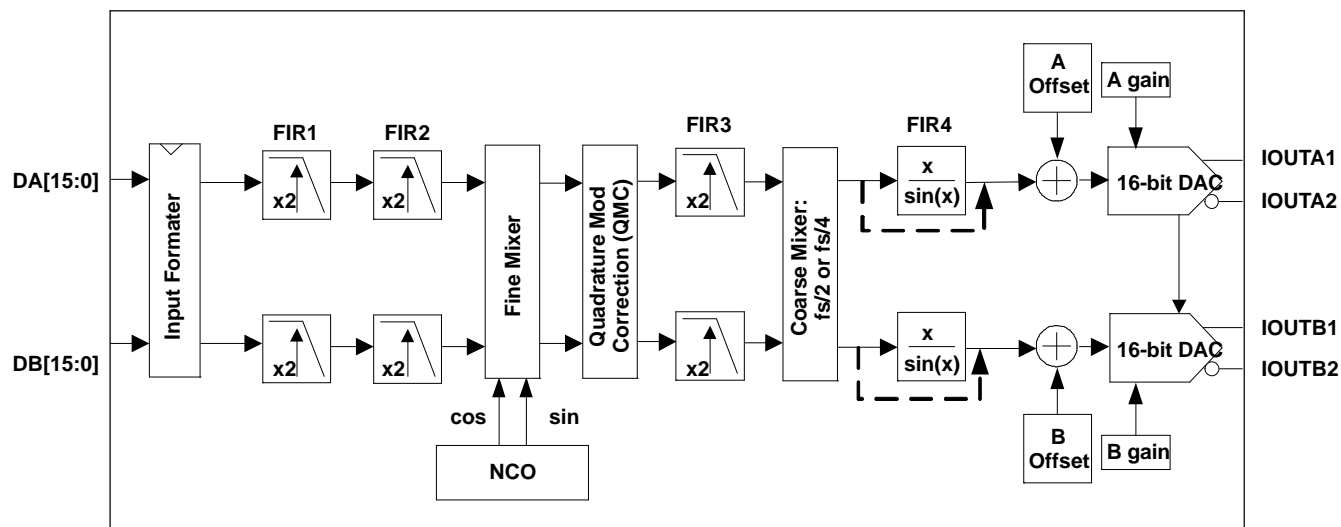


Figure 32. Block Diagram for X8 Mode

Programming Registers

REGISTER MAP

Name	Address	Default	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	(LSB) Bit 0
VERSION	0x00	0x01	sleep_daca	sleep_dacb	hpla	hplb	unused	version(2:0)		
CONFIG0	0x01	0x00	pll_div(1:0)		pll_freq	pll_kv	interp(1:0)		inv_plllock	fifo_bypass
CONFIG1	0x02	0x00	qflag	interl	dual_clk	twos	rev_abus	rev_bbus	fir_bypass	full_bypass
CONFIG2	0x03	0x80	nco	nco_gain	qmc	cm_mode(3:0)				invsinc
CONFIG3	0x04	0x00	sif_4pin	dac_ser_data	half_rate	unused	usb	counter_mode(2:0)		
SYNC_CNTL	0x05	0x00	sync_phstr	sync_nco	sync_cm	sync_fifo(2:0)			unused	unused
SER_DATA_0	0x06	0x00	dac_data(7:0)							
SER_DATA_1	0x07	0x00	dac_data(15:8)							
factory use only	0x08	0x00								
NCO_FREQ_0	0x09	0x00	freq(7:0)							
NCO_FREQ_1	0x0A	0x00	freq(15:8)							
NCO_FREQ_2	0x0B	0x00	freq(23:16)							
NCO_FREQ_3	0x0C	0x0C	freq(31:24)							
NCO_PHASE_0	0x0D	0x00	phase(7:0)							
NCO_PHASE_1	0x0E	0x00	phase(15:8)							
DACA_OFFSET_0	0x0F	0x00	daca_offset(7:0)							
DACB_OFFSET_0	0x10	0x00	dacb_offset(7:0)							
DACA_OFFSET_1	0x11	0x00	daca_offset(12:8)					unused	unused	unused
DACB_OFFSET_1	0x12	0x00	dacb_offset(12:8)					unused	unused	unused
QMCA_GAIN_0	0x13	0x00	qmc_gain_a(7:0)							
QMCB_GAIN_0	0x14	0x00	qmc_gain_b(7:0)							
QMC_PHASE_0	0x15	0x00	qmc_phase(7:0)							
QMC_PHASE_GAIN_1	0x16	0x00	qmc_phase(9:8)		qmc_gain_a(10:8)			qmc_gain_b(10:8)		
DACA_GAIN_0	0x17	0x00	daca_gain(7:0)							
DACB_GAIN_0	0x18	0x00	dacb_gain(7:0)							
DACA_DACB_GAIN_1	0x19	0xFF	daca_gain(11:8)				dacb_gain(11:8)			
factory use only	0x1A	0x00								
atest	0x1B	0x00	atest					phstr_del(1:0)		unused

REGISTER MAP (continued)

Name	Address	Default	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	(LSB) Bit 0
DAC_TEST	0x1C	0x00	factory use only							phstr_clkdiv_sel
factory use only	0x1D	0x00								
factory use only	0x1E	0x00								
factory use only	0x1F	0x00								

Register Name: VERSION — Address: 0x00, Default = 0x01

BIT 7

BIT 0

sleep_daca	sleep_dacb	hpla	hplb	unused	version(2:0)	
0	0	0	0	0	0	1

sleep_daca: DAC A sleeps when set, operational when cleared.**sleep_dacb:** DAC B sleeps when set, operational when cleared.**hpla:** A side first FIR filter in high-pass mode when set, low-pass mode when cleared.**hplb:** B side first FIR filter in high-pass mode when set, low-pass mode when cleared.**version(2:0):** A hardwired register that contains the version of the chip. Read Only.**Register Name: CONFIG0 — Address: 0x01, Default = 0x00**

BIT 7

BIT 0

pll_div(1:0)		pll_freq	pll_kv	interp(1:0)		inv_plllock	fifo_bypass
0	0	0	0	0	0	0	0

pll_div(1:0): PLL VCO divider; {00 = 1, 01 = 2, 10 = 4, 11 = 8}.**pll_freq:** PLL VCO center frequency; {0 = low center frequency, 1 = high center frequency}.**pll_kv:** PLL VCO gain; {0 = high gain, 1 = low gain}.**interp(1:0):** FIR Interpolation; {00 = X2, 01 = X4, 10 = X4L, 11 = X8}. X4 uses lower power than x4L, but f_{DAC} = 320 MHz max when NCO or QMC are used.**inv_plllock:** Multi-function bit depending on clock mode.**fifo_bypass:** When set, the internal 4-sample FIFO is disabled. When cleared, the FIFO is enabled.**Table 2. inv_plllock Bit Modes**

PLLVD	dual_clk	inv_plllock	fifo_bypass	DESCRIPTION
0 V	0	0	1	Input data latched on PLLLOCK pin rising edges, FIFO disabled.
0 V	0	1	1	Input data latched on PLLLOCK pin falling edges, FIFO disabled.
0 V	0	0	0	Input data latched on PLLLOCK pin rising edges, FIFO enabled and must be sync'd.
0 V	0	1	0	Input data latched on PLLLOCK pin falling edges, FIFO enabled and must be sync'd.
0 V	1	0	1	Input data latched on CLK1/CLK1C differential input. Timing between CLK1 and CLK2 rising edges must be tightly controlled (500 ps max at 500-MHz CLK2). PLLLOCK output signal is always low. The FIFO is always disabled in this mode.
0 V	1	1	0	Input data latched on CLK1/CLK1C differential input. No phase relationship required between CLK1 and CLK2. The FIFO is employed to manage the internal handoff between the CLK1 input clock and the CLK2 derived output clock; the FIFO must be sync'd. The PLLLOCK output signal reflects the internally generated FIFO output clock.
0 V	1	0	0	Not a valid setting. Do not use.

Table 2. inv_plllock Bit Modes (continued)

PLLVD	dual_clk	inv_plllock	fifo_bypass	DESCRIPTION
0 V	1	1	1	Not a valid setting. Do not use.
3.3 V	X	X	1	Internal PLL enabled, CLK1/CLK1C input differential clock is used to latch the input data. The FIFO is always disabled in this mode.
3.3 V	X	X	0	Not a valid setting. Do not use.

Register Name: CONFIG1 — Address: 0x02, Default = 0x00

BIT 7

BIT 0

qflag	interl	dual_clk	twos	rev_abus	rev_bbus	fir_bypass	full_bypass
0	0	0	0	0	0	0	0

qflag: When set, the QFLAG input pin operates as a B sample indicator when interleaved data is enabled. When cleared, the TXENABLE rising determines the A/B timing relationship.

interl: When set, interleaved input data mode is enabled; both A and B data streams are input at the DA(15:0) input pins.

dual_clk: Only used when the PLL is disabled. When set, two differential clocks are used to input the data to the chip; CLK1/CLK1C is used to latch the input data into the chip and CLK2/CLK2C is used as the DAC sample clock.

twos: When set, input data is interpreted as 2's complement. When cleared, input data is interpreted as offset binary.

rev_abus: When cleared, DA input data MSB to LSB order is DA(15) = MSB and DA(0) = LSB. When set, DA input data MSB to LSB order is reversed, DA(15) = LSB and DA(0) = MSB.

rev_bbus: When cleared, DB input data MSB to LSB order is DB(15) = MSB and DB(0) = LSB. When set, DB input data MSB to LSB order is reversed, DB(15) = LSB and DB(0) = MSB.

fir_bypass: When set, all interpolation filters are bypassed (interp(1:0) setting has no effect). QMC and NCO blocks are functional in this mode up to $f_{dac} = 250$ MHz, limited by the input datarate.

full_bypass: When set, all filtering, QMC and NCO functions are bypassed.

Register Name: CONFIG2 — Address: 0x03, Default = 0x80

BIT 7

BIT 0

nco	nco_gain	qmc	cm_mode(3:0)				invsinc
1	0	0	0	0	0	0	0

nco: When set, the NCO is enabled.

nco_gain: When set, the data output of the NCO is increased by 2x.

qmc: Quadrature modulator gain and phase correction is enabled when set.

cm_mode(3:0): Controls $f_{DAC}/2$ or $f_{DAC}/4$ mixer modes for the coarse mixer block.

Table 3. Coarse Mixer Sequences

cm_mode(3:0)	Mixing Mode	Sequence
00XX	No mixing	
0100	$f_{DAC}/2$	DAC A = {-A +A -A +A ...} DAC B = {-B +B -B +B ...}
0101	$f_{DAC}/2$	DAC A = {-A +A -A +A ...} DAC B = {+B -B +B -B ...}
0110	$f_{DAC}/2$	DAC A = {+A -A +A -A ...} DAC B = {-B +B -B +B ...}

Table 3. Coarse Mixer Sequences (continued)

cm_mode(3:0)	Mixing Mode	Sequence
0111	f_{DAC}^2	DAC A = {+A -A +A -A ...} DAC B = {+B -B +B -B ...}
1000	$f_{DAC}/4$	DAC A = {+A -B -A +B ...} DAC B = {+B +A -B -A ...}
1001	$f_{DAC}/4$	DAC A = {+A -B -A +B ...} DAC B = {-B -A +B +A ...}
1010	$f_{DAC}/4$	DAC A = {-A +B +A -B ...} DAC B = {+B +A -B -A ...}
1011	$f_{DAC}/4$	DAC A = {-A +B +A -B ...} DAC B = {-B -A +B +A ...}
1100	$-f_{DAC}/4$	DAC A = {+A +B -A -B ...} DAC B = {+B -A -B +A ...}
1101	$-f_{DAC}/4$	DAC A = {+A +B -A -B ...} DAC B = {-B +A +B -A ...}
1110	$-f_{DAC}/4$	DAC A = {-A -B +A +B ...} DAC B = {+B -A -B +A ...}
1111	$-f_{DAC}/4$	DAC A = {-A -B +A +B ...} DAC B = {-B +A +B -A ...}

invsinc: Enables the invsinc compensation filter when set.

Register Name: CONFIG3 — Address: 0x04, Default = 0x00

BIT 7

BIT 0

sif_4pin	dac_ser_data	half_rate	Unused	usb	counter_mode(2:0)		
0	0	0	0	0	0	0	0

sif_4pin: Four-pin serial interface mode is enabled when set, 3-pin mode when cleared.

dac_ser_data: When set, both DAC A and DAC B input data is replaced with fixed data loaded into the 16 bit serial interface ser_data register.

half_rate: Enables half-rate input mode. Input data for the DAC A data path is input to the chip at half speed using both the DA(15:0) and DB(15:0) input pins.

usb: When set, the data to DACB is inverted to generate upper side band output.

counter_mode(2:0): Controls the internal counter that can be used as the DAC data source.
{0XX = off; 100 = all 16b; 101 = 7b LSBs; 110 = 5b MIDs; 111 = 5b MSBs}

Register Name: SYNC_CNTL — Address: 0x05, Default = 0x00

BIT 7

BIT 0

sync_phstr	sync_nco	sync_cm	sync_fifo(2:0)			unused	unused
0	0	0	0	0	0	0	0

sync_phstr: When set, the internal clock divider logic is initialized with a PHSTR pin low-to-high transition.

sync_nco: When set, the NCO phase accumulator is cleared with a PHSTR low-to-high transition.

sync_cm: When set, the coarse mixer is initialized with a PHSTR low-to-high transition.

sync_fifo(2:0): Sync source selection mode for the FIFO. When a low-to-high transition is detected on the selected sync source, the FIFO input and output pointers are initialized.

Table 4. Synchronization Source

sync_fifo (2:0)	Synchronization Source
000	txenable pin
001	phstr pin
010	qflag pin
011	db(15)
100	da(15) first transition (one shot)
101	Software sync using SIF write
110	Sync source disabled (always off)
111	Always on

Register Name: SER_DATA_0— Address: 0x06, Default = 0x00

BIT 7

BIT 0

dac_data(7:0)							
0	0	0	0	0	0	0	0

dac_data(7:0): Lower 8 bits of DAC data input to the DACs when dac_ser_data is set.

Register Name: SER_DATA_1— Address: 0x07, Default = 0x00

BIT 7

BIT 0

dac_data(15:8)							
0	0	0	0	0	0	0	0

dac_data(15:8): Upper 8 bits of DAC data input to the DACs when dac_ser_data is set.

Register Name: BYPASS_MASK_CNTL— Address: 0x08, Default = 0x00

BIT 7

BIT 0

fast_latch	bp_invsinc	bp_fir3	bp_qmc	bp_fmixon	bp_fir2	bp_fir1	nco_only
0	0	0	0	0	0	0	0

These modes are for factory use only – leave as default.

Register Name: NCO_FREQ_0— Address: 0x09, Default = 0x00

BIT 7

BIT 0

freq(7:0)							
0	0	0	0	0	0	0	0

freq(7:0): Bits 7:0 of the NCO frequency word.

Register Name: NCO_FREQ_1— Address: 0x0A, Default = 0x00

BIT 7

BIT 0

freq(15:8)							
0	0	0	0	0	0	0	0

freq(15:8): Bits 15:8 of the NCO frequency word.

Register Name: NCO_FREQ_2— Address: 0x0C, Default = 0x40

BIT 7

BIT 0

freq(23:16)							
0	0	0	0	0	0	0	0

freq(23:16): Bits 23:16 of the NCO frequency word.

Register Name: NCO_FREQ_3— Address: 0x0B, Default = 0x00

BIT 7

BIT 0

freq(31:24)							
0	1	0	0	0	0	0	0

freq(31:24): Bits 31:24 of the NCO frequency word.

Register Name: NCO_PHASE_0— Address: 0x0D, Default = 0x00

BIT 7

BIT 0

Phase(7:0)							
0	0	0	0	0	0	0	0

phase(7:0): Bits 7:0 of the NCO phase offset word.

Register Name: NCO_PHASE_1— Address: 0x0E, Default = 0x00

BIT 7

BIT 0

Phase(15:8)							
0	0	0	0	0	0	0	0

phase(15:8): Bits 15:8 of the NCO phase offset word.

Register Name: DACA_OFFSET_0— Address: 0x0F, Default = 0x00

BIT 7

BIT 0

daca_offset(7:0)							
0	0	0	0	0	0	0	0

daca_offset(7:0): Bits 7:0 of the DAC A offset word.

Register Name: DACB_OFFSET_0— Address: 0x10, Default = 0x00

BIT 7

BIT 0

dacb_offset(7:0)							
0	0	0	0	0	0	0	0

dacb_offset(7:0): Bits 7:0 of the DAC B offset word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

Register Name: DACA_OFFSET_1— Address: 0x11, Default = 0x00

BIT 7

BIT 0

daca_offset(12:8)					unused	unused	unused
0	0	0	0	0	0	0	0

daca_offset(12:8): Bits 12:8 of the DAC A offset word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

Register Name: DACB_OFFSET_1— Address: 0x12, Default = 0x00

BIT 7

BIT 0

dacb_offset(12:8)					unused	unused	unused
0	0	0	0	0	0	0	0

dacb_offset(12:8): Bits 12:8 of the DAC B offset word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

Register Name: QMCA_GAIN_0— Address: 0x13, Default = 0x00

BIT 7

BIT 0

qmc_gain_a(7:0)							
0	0	0	0	0	0	0	0

qmc_gain_a(7:0): Bits 7:0 of the QMC A path gain word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

Register Name: QMCB_GAIN_0— Address: 0x14, Default = 0x00

BIT 7

BIT 0

qmc_gain_b(7:0)							
0	0	0	0	0	0	0	0

qmc_gain_b(7:0): Bits 7:0 of the QMC B path gain word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

Register Name: QMC_PHASE_0— Address: 0x15, Default = 0x00

BIT 7

BIT 0

qmc_phase(7:0)							
0	0	0	0	0	0	0	0

qmc_phase(7:0): Bits 7:0 of the QMC phase word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

Register Name: QMC_PHASE_GAIN_1— Address: 0x16, Default = 0x00

BIT 7

BIT 0

qmc_phase(9:8)		qmc_gain_a(10:8)			qmc_gain_b(10:8)		
0	0	0	0	0	0	0	0

qmc_phase(9:8): Bits 9:8 of the QMC phase word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

qmc_gain_a(10:8): Bits 10:8 of the QMC A path gain word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

qmc_gain_b(10:8): Bits 10:8 of the QMC B path gain word. Updates to this register do not take effect until DACA_OFFSET_0 has been written.

Register Name: DACA_GAIN_0— Address: 0x17, Default = 0x00

BIT 7

BIT 0

daca_gain(7:0)							
0	0	0	0	0	0	0	0

daca_gain(7:0): Bits 7:0 of the DAC A gain adjustment word.

Register Name: DACB_GAIN_0— Address: 0x18, Default = 0x00

BIT 7

BIT 0

dacb_gain(7:0)							
0	0	0	0	0	0	0	0

dacb_gain(7:0): Bits 7:0 of the DAC B gain adjustment word.

Register Name: DACA_DACB_GAIN_1— Address: 0x19, Default = 0xFF

BIT 7

BIT 0

daca_gain(11:8)				dacb_gain(11:8)			
1	1	1	1	1	1	1	1

daca_gain(11:8): Four MSBs of gain control for DACA.

dacb_gain(11:8): Bits 11:8 of the DAC B gain word. Four MSBs of gain control for DACB.

Register Name: DAC_CLK_CNTL— Address: 0x1A, Default = 0x00

BIT 7

BIT 0

factory use only							
0	0	0	0	0	0	0	0

Reserved for factory use only.

Register Name: ATEST— Address: 0x1B, Default = 0x00

BIT 7

BIT 0

atest(4:0)					phstr_del(1:0)		unused
0	0	0	0	0	0	0	0

atest: Can be used to enable clock output at the PLLLOCK pin according to [Table 5](#). Pin EXTLO must be open when atest (4:0) is not equal to 00000.

Table 5.

atest(4:0)	PLLLOCK Output Signal	
	PLL Enabled (PLLVD = 3.3 V)	PLL Disabled (PLLVD = 0 V)
11101	f_{DAC}	Normal operation
11110	f_{DAC} divided by 2	Normal operation
11111	f_{DAC} divided by 4	Normal operation
All others	Normal operation	

phstr_del: Adjusts the initial phase of the fs/2 and fs/4 blocks cmix block after PHSTR.

Register Name: DAC_TEST— Address: 0x1C, Default = 0x00

BIT 7

BIT 0

Factory Use Only							phstr_clkdiv_sel
0	0	0	0	0	0	0	0

phstr_clkdiv_sel: Selects the clock used to latch the PHSTR input when restarting the internal dividers. When set, the full DAC sample rate CLK2 signal latches PHSTR and when cleared, the divided down input clock signal latches PHSTR.

Address: 0x1D, 0x1E, and 0x1F – Reserved

Writes have no effect and reads will be 0x00.

Serial Interface

The serial port of the DAC5687 is a flexible serial interface which communicates with industry standard microprocessors and microcontrollers. The interface provides read/write access to all registers used to define the operating modes of the DAC5687. It is compatible with most synchronous transfer formats and can be configured as a 3- or 4-pin interface by **sif4** in register **config_msb**. In both configurations, **SCLK** is the serial interface input clock and **SDENB** is serial interface enable. For 3-pin configuration, **SDIO** is a bidirectional pin for both data in and data out. For 4-pin configuration, **SDIO** is data in only and **SDO** is data out only.

Each read/write operation is framed by signal **SDENB** (serial data enable bar) asserted low for 2 to 5 bytes, depending on the data length to be transferred (1 – 4 bytes). The first frame byte is the instruction cycle which identifies the following data transfer cycle as read or write, how many bytes to transfer, and what address to transfer the data. Table 6 indicates the function of each bit in the instruction cycle and is followed by a detailed description of each bit. Frame bytes 2 to 5 comprise the data transfer cycle.

Table 6. Instruction Byte of the Serial Interface

MSB				LSB				
Bit	7	6	5	4	3	2	1	0
Description	R/W	N1	N0	A4	A3	A2	A1	A0

R/W Identifies the following data transfer cycle as a read or write operation. A high indicates a read operation from the DAC5687 and a low indicates a write operation to the DAC5687.

[N1 : N0] Identifies the number of data bytes to be transferred per Table 7. Data is transferred MSB first.

Table 7. Number of Transferred Bytes Within One Communication Frame

N1	N0	Description
0	0	Transfer 1 Byte
0	1	Transfer 2 Bytes
1	0	Transfer 3 Bytes
1	1	Transfer 4 Bytes

[A4 : A3 : A2 : A1 : A0] Identifies the address of the register to be accessed during the read or write operation. For multi-byte transfers, this address is the starting address. Note that the address is written to the DAC5687 MSB first.

Figure 33 shows the serial interface timing diagram for a DAC5687 write operation. **SCLK** is the serial interface clock input to the DAC5687. Serial data enable **SDENB** is an active low input to the DAC5687. **SDIO** is serial data in. Input data to the DAC5687 is clocked on the rising edges of **SCLK**.

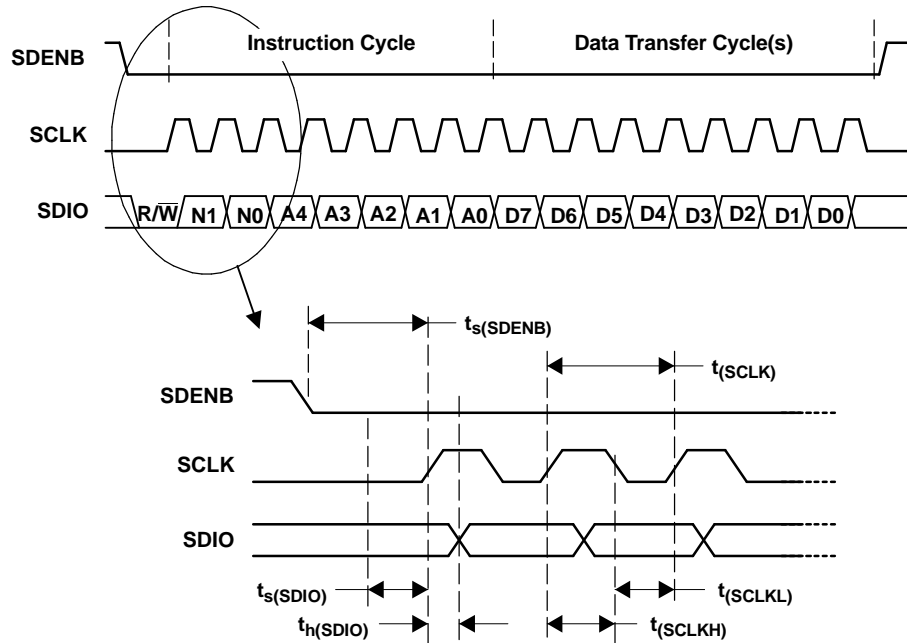


Figure 33. Serial Interface Write Timing Diagram

Figure 34 shows the serial interface timing diagram for a DAC5687 read operation. **SCLK** is the serial interface clock input to the DAC5687. Serial data enable **SDENB** is an active low input to the DAC5687. **SDIO** is serial data in during the instruction cycle. In 3-pin configuration, **SDIO** is data out from the DAC5687 during the data transfer cycle(s), while **SDO** is in a high-impedance state. In 4-pin configuration, **SDO** is data out from the DAC5687 during the data transfer cycle(s). At the end of the data transfer, **SDO** outputs low on the final falling edge of SCLK until the rising edge of SDENB when it will 3-state.

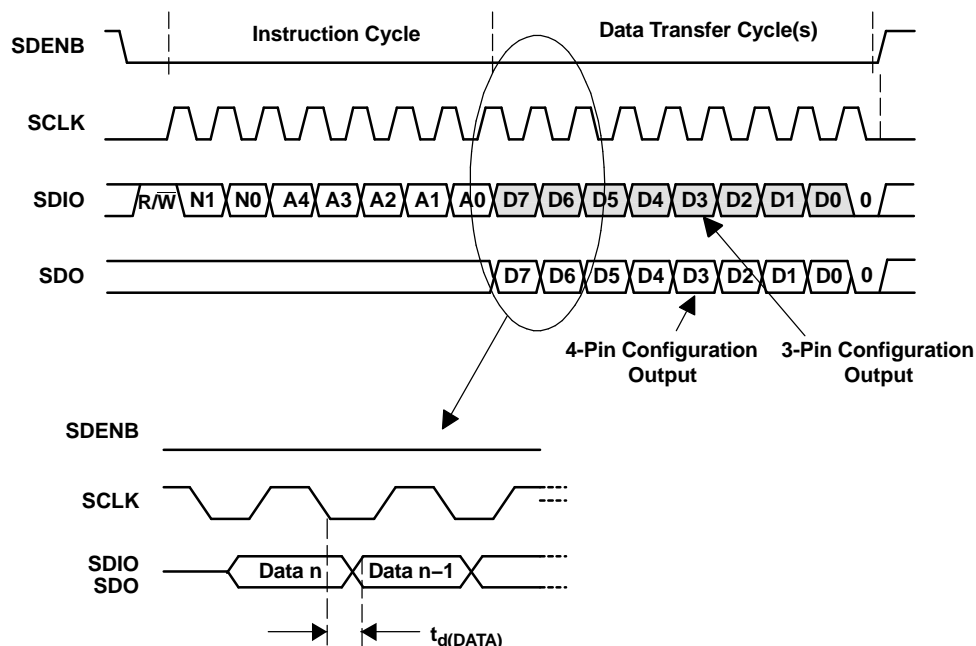


Figure 34. Serial Interface Read Timing Diagram

FIR Filters

Figure 35 shows the magnitude spectrum response for the identical 51-tap FIR1 and FIR3 filters. The transition band is from 0.4 to $0.6 \times F_{IN}$ (the input data rate for the FIR filter) with < 0.002 -dB pass-band ripple and > 80 -dB stop-band attenuation. Figure 36 shows the region from 0.35 to $0.45 \times F_{IN}$. Up to $0.44 \times F_{IN}$ there is less than 0.5 -dB attenuation.

Figure 37 shows the magnitude spectrum response for the 19-tap FIR2 filter. The transition band is from 0.25 to $0.75 \times F_{IN}$ (the input data rate for the FIR filter) with < 0.002 -dB pass-band ripple and > 80 -dB stop-band attenuation.

The DAC5687 also has an inverse Sinc filter (FIR4) that runs at the DAC update rate (f_{DAC}) that can be used to flatten the frequency response of the sample and hold output. The DAC sample and hold output set the output current and holds it constant for one DAC clock cycle until the next sample, resulting in the well known $\text{Sin}(x)/x$ or $\text{Sinc}(x)$ frequency response shown in Figure 38 (black solid line). The inverse sinc filter response (Figure 38, blue dotted line) has the opposite frequency response between 0 to $0.4 \times f_{DAC}$, resulting in the combined response (Figure 38, red dashed line). Between 0 to $0.4 \times f_{DAC}$, the inverse sin filter compensates the sample and hold rolloff with less than < 0.03 -dB error.

The inverse sine filter has a gain > 1 at all frequencies. Therefore, the signal input to FIR4 must be reduced from full scale to prevent saturation in the filter. The amount of backoff required depends on the signal frequency, and is set such that at the signal frequencies the combination of the input signal and filter response is less than 1 (0 dB). For example, if the signal input to FIR4 is at $0.25 \times f_{DAC}$, the response of FIR4 is 0.9 dB, and the signal will need to be backed off from full scale by 0.9 dB. The gain function in the QMC block can be used to set reduce amplitude of the input signal. The advantage of FIR4 having a positive gain at all frequencies is that the user is then able to optimized backoff of the signal based on the signal frequency.

The filter taps for all digital filters are listed in Table 8.

Note that the loss of signal amplitude may result in lower SNR due to decrease in signal amplitude.

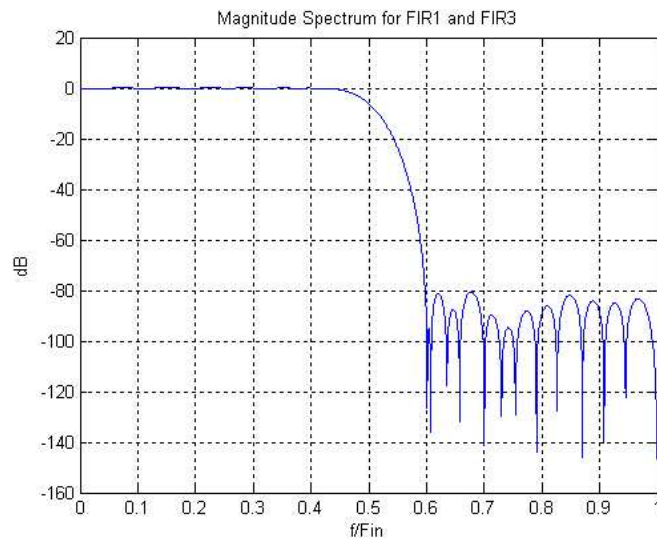


Figure 35. Magnitude Spectrum for FIR1 and FIR3

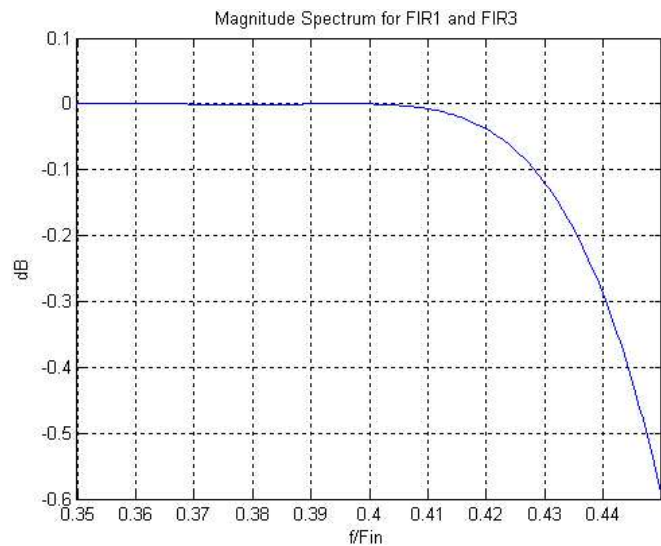


Figure 36. FIR1 and FIR3 Transition Band

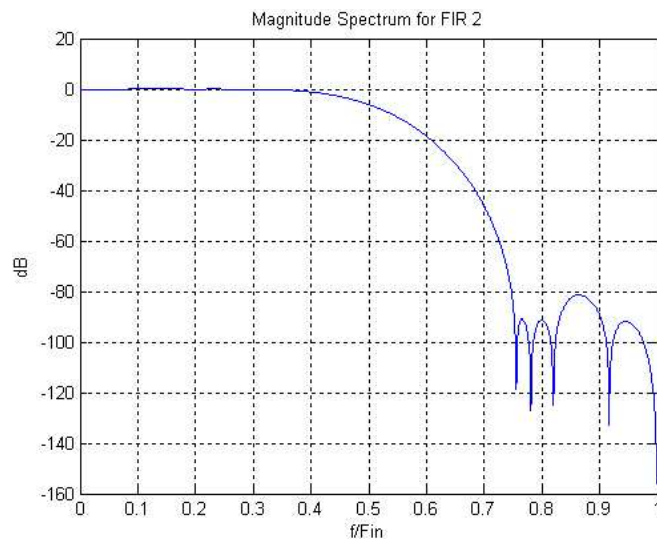


Figure 37. Magnitude Spectrum for FIR2

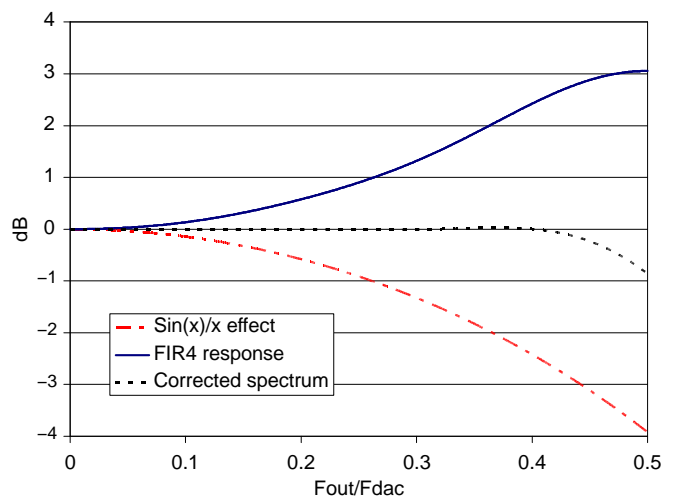


Figure 38. Magnitude Spectrum for Inverse Sinc Filter FIR4 (Versions 1 and 2)

Table 8. Digital Filter Taps

FIR1 and FIR3		FIR2		FIR4 (Invsinc)	
Tap	Coeff	Tap	Coeff	Tap	Coeff
1, 51	8	1, 19	9	1, 9	1
2, 50	0	2, 18	0	2, 8	-4
3, 49	-24	3, 17	-58	3, 7	13
4, 48	0	4, 16	0	4, 6	-50
5, 47	58	5, 15	214	5	592
6, 46	0	6, 14	0		
7, 45	-120	7, 13	-638		
8, 44	0	8, 12	0		
9, 43	221	9, 11	2521		
10, 42	0	10	4096		
11, 41	-380				

Table 8. Digital Filter Taps (continued)

FIR1 and FIR3		FIR2		FIR4 (Invsinc)	
Tap	Coeff	Tap	Coeff	Tap	Coeff
12, 40	0				
13, 39	619				
14, 38	0				
15, 37	–971				
16, 36	0				
17, 35	1490				
18, 34	0				
19, 33	–2288				
20, 32	0				
21, 31	3649				
22, 30	0				
23, 29	–6628				
24, 28	0				
25, 27	20750				
26	32768				

Dual Channel Real Upconversion

The DAC5687 can be used in a dual channel mode with real upconversion by mixing with a 1, -1, ... sequence in the signal chain to invert the spectrum. This mixing mode maintains isolation of the A and B channels. There are two points of mixing: in X4L mode, the FIR1 output is inverted (high-pass mode) by setting registers **hpla** and **hplb** to 1 and the FIR3 output is inverted by setting CMIX to $f_{DAC}/2$. In X8 mode, the output of FIR1 is inverted by setting **hpla** and **hplb** to 1 and the FIR3 output is inverted by setting CMIX to $f_{DAC}/2$. In X2 and X4 modes, the output of FIR3 is inverted by setting CMIX to $f_{DAC}/2$.

The wide bandwidth of FIR3 (40% passband) in X4L mode provides options for setting four different frequency ranges, listed in Table 9. For example, with $f_{DATA} = 125$ MSPS ($f_{DAC} = 500$ MSPS), setting FIR1/FIR3 to High Pass/High Pass respectively will upconvert a signal between 25 and 50 MHz to 150 to 175 MHz. With the High Pass/Low Pass and Low Pass/High Pass setting the upconverted signal will be spectrally inverted.

Table 9. X4L Mode High-Pass/Low-Pass Options

FIR1	FIR3	Input Frequency	Output Frequency	Bandwidth	Inverted?
Low Pass	Low Pass	$0 - 0.4 \times f_{DATA}$	$0 - 0.4 \times f_{DATA}$	$0.4 \times f_{DATA}$	No
High Pass	Low Pass	$0.2 \text{ to } 0.4 \times f_{DATA}$	$0.6 - 0.8 \times f_{DATA}$	$0.2 \times f_{DATA}$	Yes
High Pass	High Pass	$0.2 \text{ to } 0.4 \times f_{DATA}$	$1.2 - 1.4 \times f_{DATA}$	$0.2 \times f_{DATA}$	No
Low Pass	High Pass	$0 - 0.4 \times f_{DATA}$	$1.6 - 2 \times f_{DATA}$	$0.4 \times f_{DATA}$	Yes

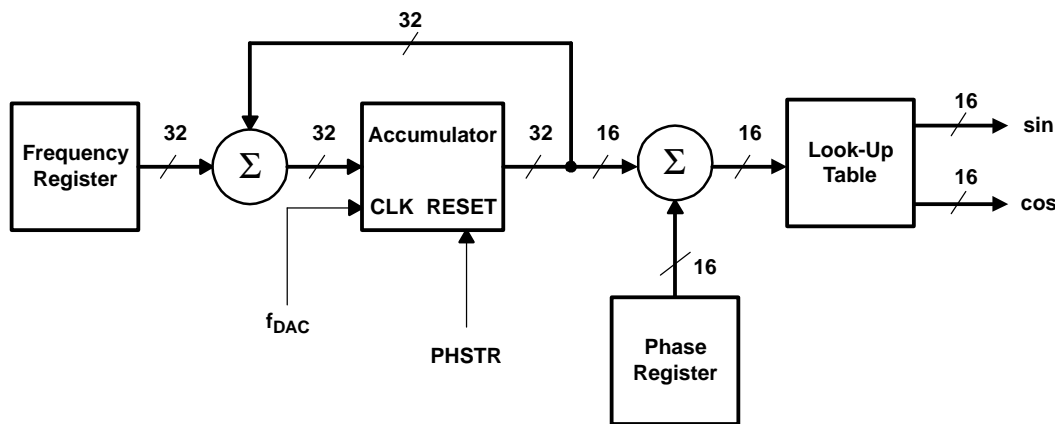
Limitations on Signal BW and Final Output Frequency in X4L and X8 Modes

For very wide bandwidth signals, the FIR3 pass-band ($0 - 0.4 \times F_{DAC}/2$) can limit the range of the final output frequency. For example in X4L FMIX CMIX mode (4x interpolation with FMIX after FIR1), at the maximum input data rate $F_{IN} = 125$ MSPS the input signal can be ± 50 MHz before running into the transition band of FIR1. After 2x interpolation, FIR3 limits the signal to ± 100 MHz (0.4×250 MHz). Therefore, at the maximum signal bandwidth, FMIX can mix up to 50 MHz and still fall within the passband of FIR3. This results in gaps in the final output frequency between FMIX alone (0 MHz to 50 MHz) and FMIX + CMIX with $f_{DAC}/4$ (75 MHz to 175 MHz) and FMIX + $f_{DAC}/2$ (200 MHz to 250 MHz).

In practice, it may be possible to extend the signal into the FIR3 transition band. Referring to [Figure 36](#) in the Digital Filter section above, if 0.5 dB of attenuation at the edge of the signal can be tolerated, then the signal can be extended up to $0.44 \times F_{IN}$. This would extend the range of FMIX in the example to 60 MHz.

Fine Mixer (FMIX)

The fine mixer block FMIX uses a numerically controlled oscillator (NCO) with a 32-bit frequency register **freq(31:0)** and a 16-bit phase register **phase(15:0)** to provide sin and cos for mixing. The NCO tuning frequency is programmed in registers 0x09 through 0x0C. Phase offset is programmed in registers 0xD and 0xE. A block-diagram of the NCO is shown in [Figure 39](#).



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Figure 39. Block-Diagram of the NCO

Synchronization of the NCO occurs by resetting the NCO accumulator to zero with assertion of **PHSTR**. See the Fine Mixer Synchronization section below. Frequency word **freq** in the frequency register is added to the accumulator every clock cycle. The output frequency of the NCO is

$$f_{NCO} = \frac{\text{freq} \times f_{NCO_CLK}}{2^{32}} \text{ for } \text{freq} \leq 2^{31} \quad / \quad f_{NCO} = \frac{(\text{freq} - 2^{32}) \times f_{NCO_CLK}}{2^{32}} \text{ for } \text{freq} > 2^{31}$$

where f_{NCO_CLK} is the clock frequency of the NCO circuit. In X4 mode, the NCO clock frequency is the same as the DAC sample rate f_{DAC} . The maximum clock frequency the NCO can operate at is 320 MHz – in X4 FMIX mode, where FMIX operates at the DAC update rate, the DAC update rate will be limited to 320 MSPS. In X2, X4L and X8 modes, the NCO circuit is followed by a further 2x interpolation and so $f_{NCO_CLK} = f_{DAC}/2$ and operates at $f_{DAC} = 500$ MHz.

Treating channels A and B as a complex vector $I + I \times Q$ where $I(t) = A(t)$ and $Q(t) = B(t)$, the output of FMIX $I_{OUT}(t)$ and $Q_{OUT}(t)$ is

$$\begin{aligned} I_{OUT}(t) &= (I_{IN}(t)\cos(2\pi f_{NCO}t + \delta) - Q_{IN}(t)\sin(2\pi f_{NCO}t + \delta)) \times 2^{(NCO_GAIN - 1)} \\ Q_{OUT}(t) &= (I_{IN}(t)\sin(2\pi f_{NCO}t + \delta) + Q_{IN}(t)\cos(2\pi f_{NCO}t + \delta)) \times 2^{(NCO_GAIN - 1)} \end{aligned}$$

Where t is the time since the last resetting of the NCO accumulator, δ is the initial accumulator value and NCO_GAIN , bit 6 in register CONFIG2, is either 0 or 1. δ is given by

$$\delta = 2\pi \times \text{phase}/2^{16}.$$

The maximum output amplitude of FMIX occurs if $I_{IN}(t)$ and $Q_{IN}(t)$ are simultaneously full scale amplitude and the sine and cosine arguments $2\pi f_{NCO}t + \delta = (2N-1) \times \pi/4$ ($N = 1, 2, \dots$). With $NCO_GAIN = 0$, the gain through FMIX is $\sqrt{2}/2$ or – 3 dB. This loss in signal power is in most cases undesirable, and it is recommended that the gain function of the QMC block be used to increase the signal by 3 dB to 0 dBFS by setting $qmca_gain$ and qmc_gain each to 1446 (decimal).

With $NCO_GAIN = 1$, the gain through FMIX is $\sqrt{2}$ or + 3 dB, which can cause clipping of the signal if $I_{IN}(t)$ and $Q_{IN}(t)$ are simultaneously near full scale amplitude and should therefore be used with caution.

Coarse Mixer (CMIX)

The coarse mixer block provides mixing capability at the DAC output rate with fixed frequencies of $F_S/2$ or $F_S/4$. The coarse mixer output phase sequence is selected by the `cm_mode(3:0)` bits in register CONFIG2 and is shown in [Table 10](#).

Table 10. Coarse Mixer Sequences

cm_mode(3:0)	Mixing Mode	Sequence
00XX	No mixing	
0100	$f_{DAC}/2$	DAC A = {-A +A -A +A ...} DAC B = {-B +B -B +B ...}
0101	$f_{DAC}/2$	DAC A = {-A +A -A +A ...} DAC B = {+B -B +B -B ...}
0110	$f_{DAC}/2$	DAC A = {+A -A +A -A ...} DAC B = {-B +B -B +B ...}
0111	$f_{DAC}/2$	DAC A = {+A -A +A -A ...} DAC B = {+B -B +B -B ...}
1000	$f_{DAC}/4$	DAC A = {+A -B -A +B ...} DAC B = {+B +A -B -A ...}
1001	$f_{DAC}/4$	DAC A = {+A -B -A +B ...} DAC B = {-B -A +B +A ...}
1010	$f_{DAC}/4$	DAC A = {-A +B +A -B ...} DAC B = {+B +A -B -A ...}
1011	$f_{DAC}/4$	DAC A = {-A +B +A -B ...} DAC B = {-B -A +B +A ...}
1100	$-f_{DAC}/4$	DAC A = {+A +B -A -B ...} DAC B = {+B -A -B +A ...}
1101	$-f_{DAC}/4$	DAC A = {+A +B -A -B ...} DAC B = {-B +A +B -A ...}
1110	$-f_{DAC}/4$	DAC A = {-A -B +A +B ...} DAC B = {+B -A -B +A ...}
1111	$-f_{DAC}/4$	DAC A = {-A -B +A +B ...} DAC B = {-B +A +B -A ...}

The output of CMIX is complex. For a real output, either DACA or DACB can be used and the other DAC slept, the difference being the phase sequence.

Quadrature Modulator Correction (QMC)

The quadrature modulator correction (QMC) block provides a means for changing the phase balance of the complex signal to compensate for I and Q imbalance present in an analog quadrature modulator. The QMC block is limited in operation to a clock rate of 320 MSPS.

The block diagram for the QMC block is shown in [Figure 40](#). The QMC block contains three programmable parameters. Registers **qma_gain** and **qmb_gain** control the I and Q path gains and are 11 bit values with a range of 0 to approximately 2. Note that the I and Q gain can also be controlled by setting the DAC full-scale output current (see below). Register **qm_phase** controls the phase imbalance between I and Q and is a 10-bit value with a range of $-1/2$ to approximately $1/2$.

LO feedthrough can be minimized by adjusting the DAC offset feature described below.

An example of sideband optimization using the QMC block and gain adjustment is shown in [Figure 41](#). The QMC phase adjustment in combination with the DAC gain adjustment can reduce the unwanted sideband signal from ~ 40 dBc to > 65 dBc.

Note that mixing in the CMIX block after the QMC correction will destroy the I and Q phase compensation information from the QMC block.

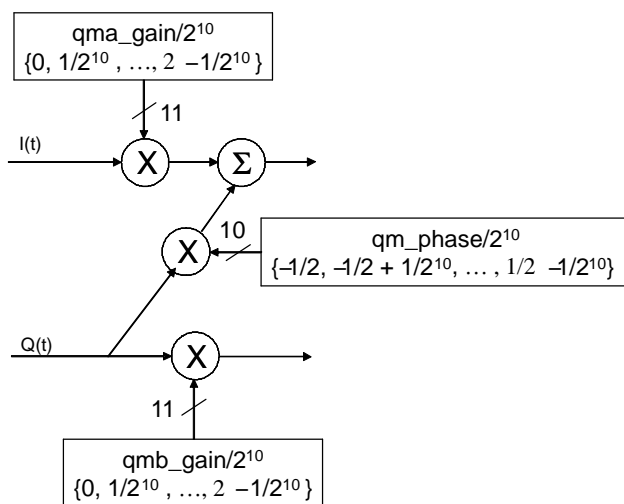
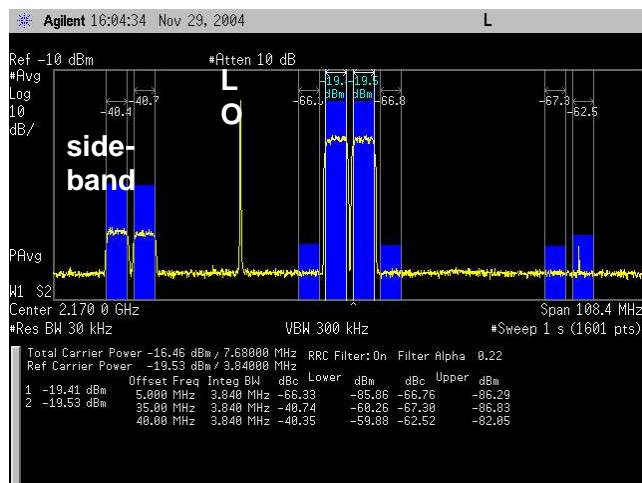
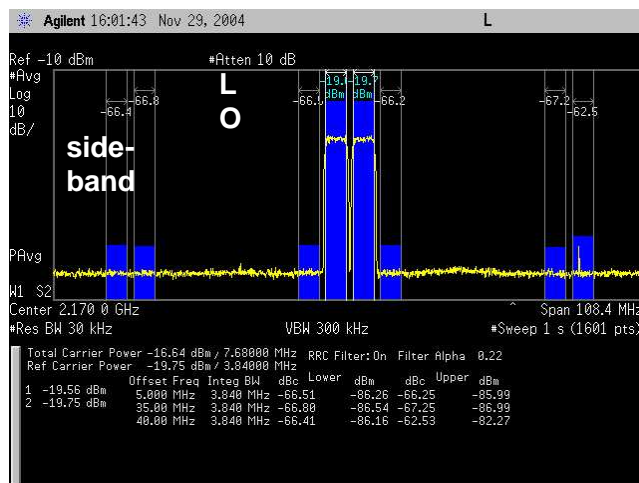


Figure 40. QMC Block Diagram



Uncorrected



Corrected

Figure 41. Example of Sideband Optimization Using QMC Phase and Gain Adjustments

DAC Offset Control

Registers **qma_offset** and **qmb_offset** control the I and Q path offsets and are 13-bit values with a range of -4096 to 4095. The DAC offset value adds a digital offset to the digital data before digital-to-analog conversion. The **qma_gain** and **qmb_gain** registers can be used to backoff the signal before the offset to prevent saturation when the offset value is added to the digital signal.

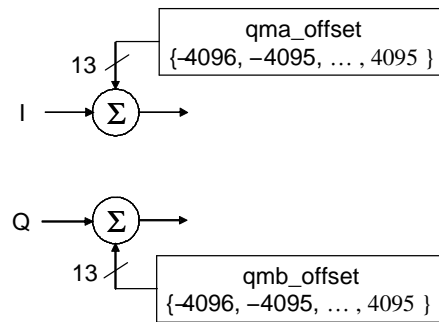


Figure 42. DAC Offset Block

Analog DAC Gain

The full-scale DAC output current can be set by programming the **daca_gain** and **dacb_gain** registers. The DAC gain value controls the full-scale output current.

$$I_{\text{fullscale}} = \left[\frac{16(V_{\text{extio}})}{R_{\text{biasj}}} \times \frac{(\text{GAINCODE} + 1)}{16} \div \left(1 - \frac{\text{FINEGAIN}}{3072} \right) \right]$$

where GAINCODE = daca_gain[11:8] or dacb_gain[11:8] is the coarse gain setting (0 to 15) and FINEGAIN = daca_gain[7:0] or dacb_gain[7:0] (-128 to 127) is the fine gain setting.

Clock Modes

In the DAC5687, the internal clocks (1x, 2x, 4x, and 8x as needed) for the logic, FIR interpolation filters, and DAC are derived from a clock at either the input data rate using an internal PLL (PLL clock mode) or DAC output sample rate (external clock mode). Power for the internal PLL blocks (PLLVDV and PLLGND) are separate from the other clock generation blocks power (CLKVDD and CLKGND), thus minimizing phase noise within the PLL.

The DAC5687 has three clock modes for generating the internal clocks (1x, 2x, 4x, and 8x as needed) for the logic, FIR interpolation filters, and DACs. The clock mode is set using the PLLVDD pin and **dual_clk** in register **CONFIG1**.

1. PLLVDD = 0 V and **dual_clk** = 0: EXTERNAL CLOCK MODE

In EXTERNAL CLOCK MODE, the user provides a clock signal at the DAC output sample rate through CLK2/CLK2C. CLK1/CLK1C and the internal PLL are not used. LPF and CLK1/CLK1C pins can be left unconnected. The input data rate clock and interpolation rate are selected by the bits **interp(1:0)** in register **CONFIG0** and is output through the PLLLOCK pin. The PLLLOCK clock can be used to drive the input data source (such as digital upconverter) that sends the data to the DAC. Note that the PLLLOCK delay relative to the input CLK2 rising edge ($t_{d(\text{PLLLOCK})}$) in Figure 43 and Figure 44) increases with increasing loads. The input data is latched on either the rising (**inv_plllock** = 0) or falling edge (**inv_plllock** = 1) of PLLLOCK, which is sensed internally at the output pin.

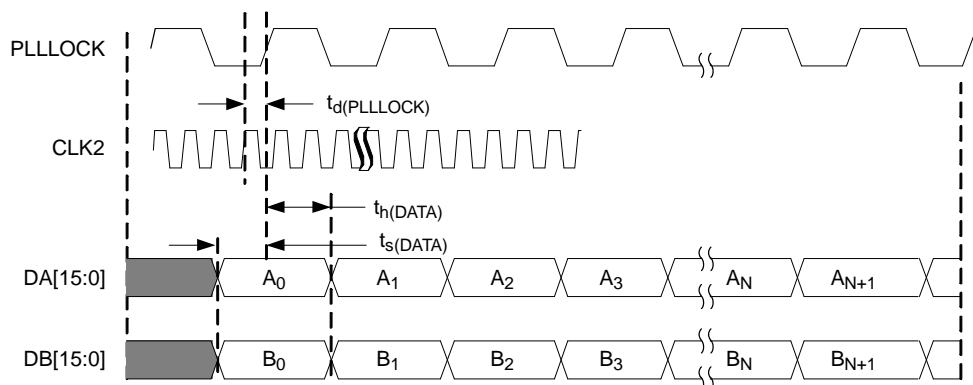


Figure 43. Dual Bus Mode Timing Diagram for External Clock Mode (PLLLOCK Rising Edge)

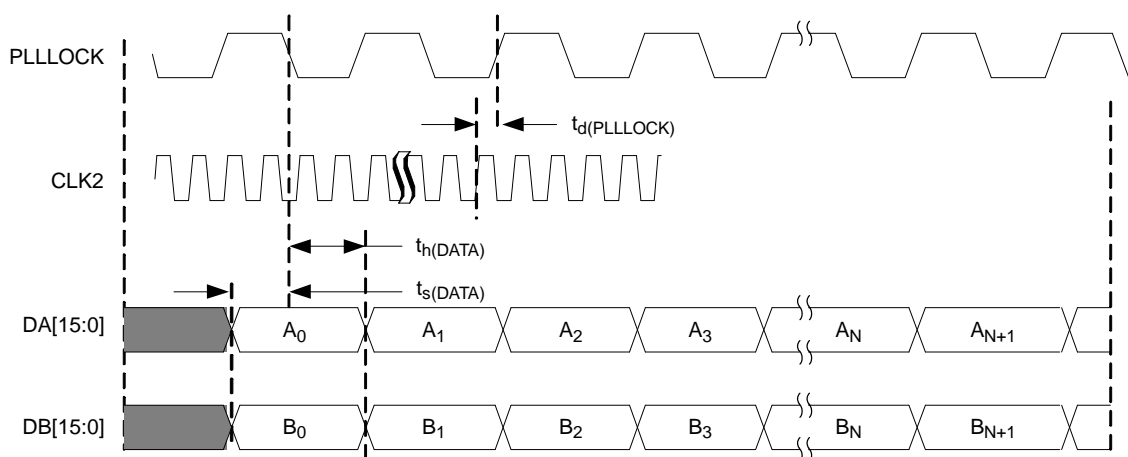


Figure 44. Dual Bus Mode Timing Diagram for External Clock Mode (PLLLOCK Falling Edge)

2. PLLVDD = 3.3 V (**dual_clk** can be 0 or 1 and is ignored): PLL CLOCK MODE

In PLL CLOCK MODE, you drive the DAC at the input sample rate (unless the data is mux'd) through CLK1/CLK1C. CLK2/CLK2C is not used. In this case, there is no phase ambiguity on the clock. The DAC generates the higher speed DAC sample rate clock using an internal PLL/VCO. In PLL clock mode, the user provides a differential external reference clock on CLK1/CLK1C.

A type four phase-frequency detector (PFD) in the internal PLL compares this reference clock to a feedback clock and drives the PLL to maintain synchronization between the two clocks. The feedback clock is generated by dividing the VCO output by 1x, 2x, 4x, or 8x as selected by the prescaler (**div[1:0]**). The output of the prescaler is the DAC sample rate clock and is divided down to generate clocks at ÷ 2, ÷ 4, and ÷ 8. The feedback clock is selected by the registers **sel[1:0]**, which is fed back to the PFD for synchronization to the input clock. The feedback clock is also used for the data input rate, so the ratio of DAC output clock to feedback clock sets the interpolation rate of the DAC5687. The PLLLOCK pin is an output indicating when the PLL has achieved lock. An external RC low-pass PLL filter is provided by the user at pin LPF. See the Low-Pass Filter section for filter setting calculations. This is the only mode where the LPF filter applies.

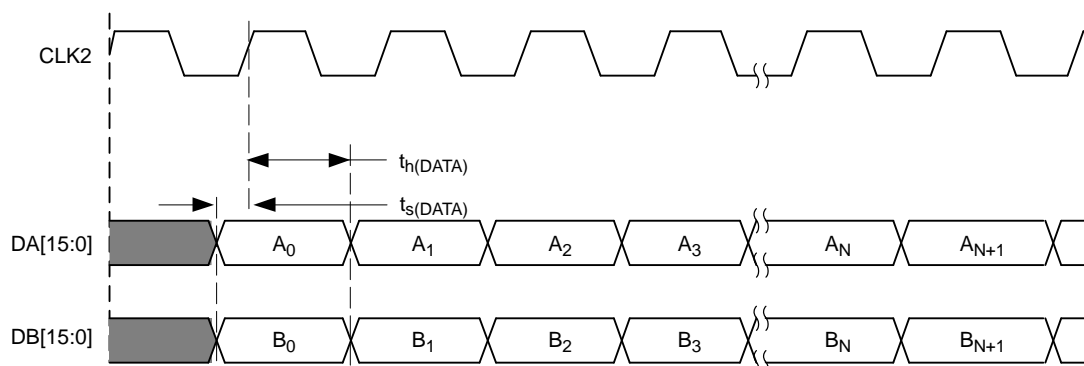
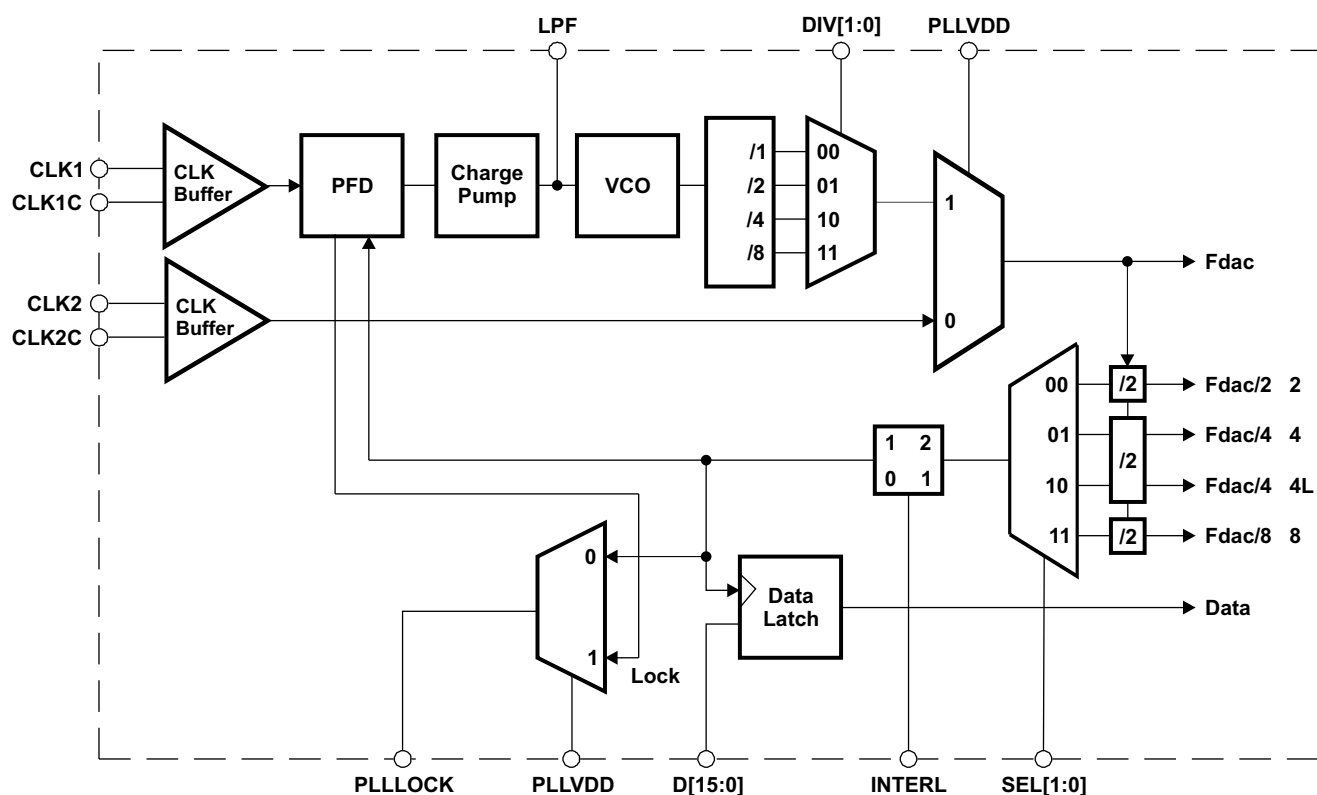


Figure 45. Dual Bus Mode Timing Diagram (PLL Mode)



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Figure 46. Clock Generation Architecture in PLL Mode

Power for the internal PLL blocks (PLLVD and PLLGND) are separate from the other clock generation blocks power (CLKVDD and CLKGND), thus minimizing PLL phase noise.

3) PLLVDD = 0 V and **dual clk** = 1: DUAL CLOCK MODE

In DUAL CLOCK MODE, the DAC is driven at the DAC sample rate through CLK2/CLK2C and the input data rate through CLK1/CLK1C. There are two options in dual clock mode: with FIFO (**inv_pillock** set) and without FIFO (**inv_pillock** clear). If the FIFO is not used, the CLK1/CLK1C input is used to set the phase of the internal clock divider. In this case, the edges of CLK1 and CLK2 must be aligned to within $\pm t_{align}$ (Figure 47), defined as

$$f_{\text{align}} = \frac{1}{2F_{\text{CLK2}}} - 0.5 \text{ ns}$$

where f_{CLK2} is the clock frequency at CLK2. For example, $t_{\text{align}} = 0.5 \text{ ns}$ at $f_{\text{CLK2}} = 500 \text{ MHz}$ and 1.5 ns at $f_{\text{CLK2}} = 250 \text{ MHz}$.

If the FIFO is enabled (**inv_plllock** set) in dual clock mode, then CLK1 is only used as an input latch (Figure 48) and is independent from the internal divided clock generated from CLK2/CLK2C and there is no alignment specification. However, the FIFO needs to be synchronized by one of the methods listed in **SYNC_CNTL** register and the latency of the DAC can be up to one clock cycle different depending on the phase relationship between CLK1 and the internally divided clock.

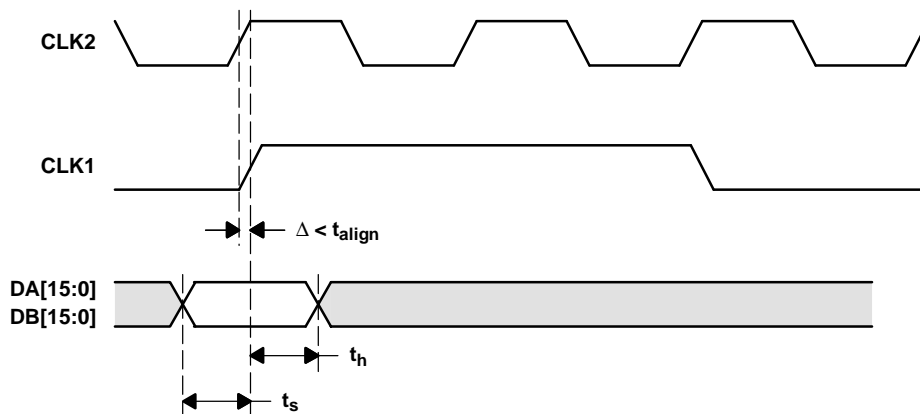


Figure 47. Dual Clock Mode Without FIFO

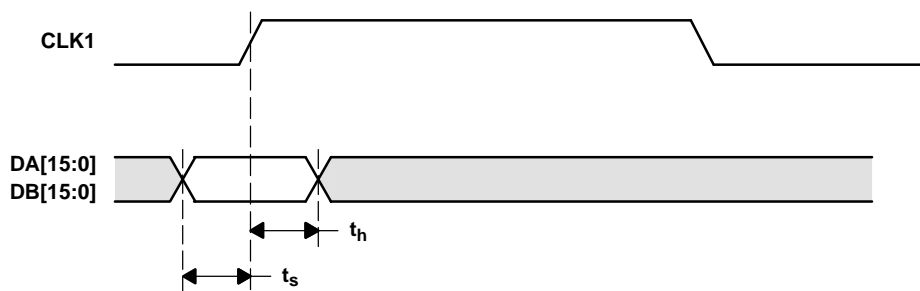


Figure 48. Dual Clock Mode With FIFO

The CDC7005 from Texas Instruments is recommended for providing phase aligned clocks at different frequencies for this application.

Input FIFO

In DAC clock mode, where the DAC5687 is clocked at the DAC update rate, the DAC5687 has an optional input FIFO that allows latching of DA[15:0], DB[15:0] and PHSTR based on a user provided CLK1/CLK1C input or the input data rate clock provided to the PLLLOCK pin. The FIFO can be bypassed by setting register **fifo_bypass** in **CONFIG0** to 1.

The input interface FIFO incorporates a four sample register file, an input pointer, and an output pointer. Initialization of the FIFO pointers can be programmed to one of seven different sources.

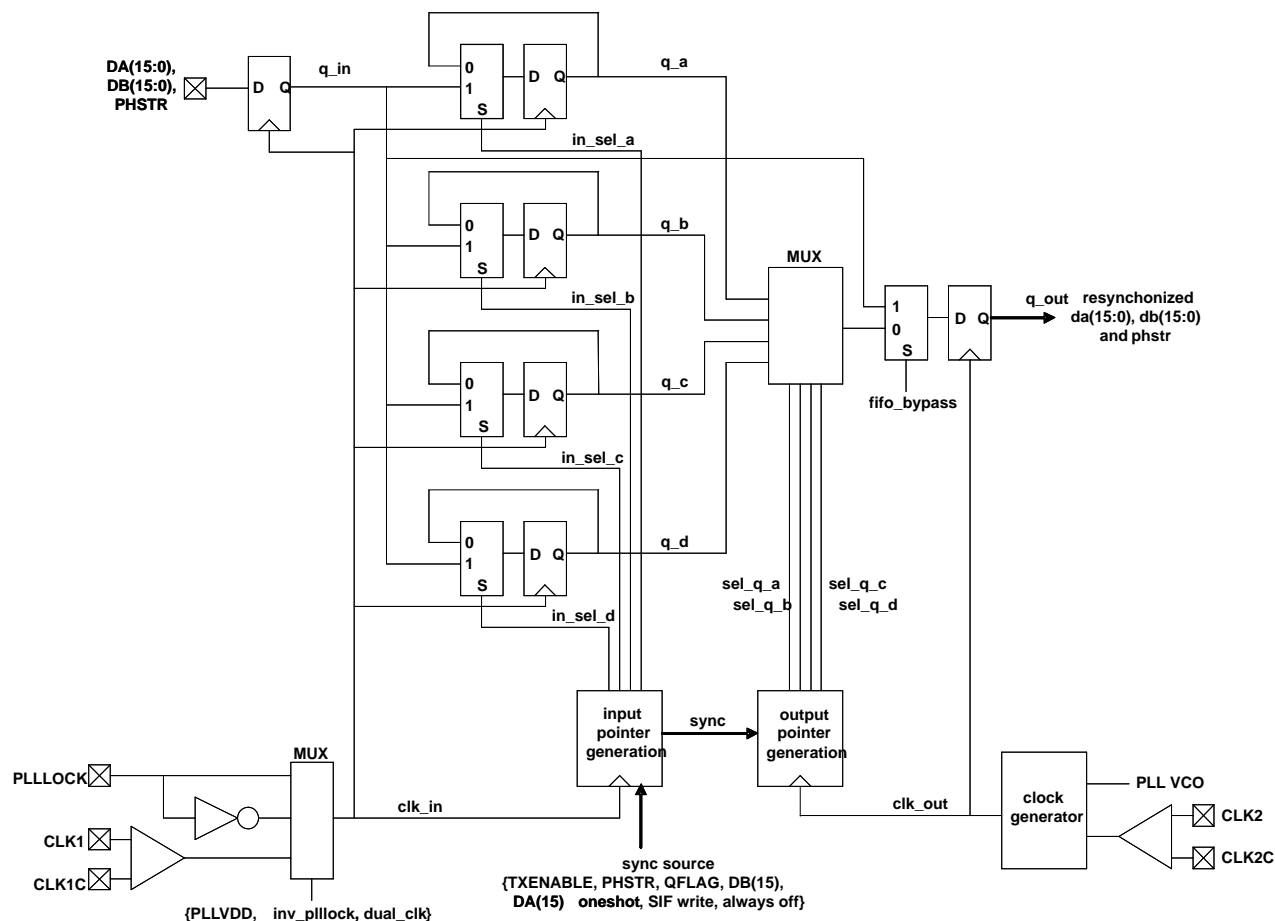


Figure 49. DAC5687 Input FIFO Logic

Initialization of the FIFO block involves selecting and asserting a synchronization source. Initialization causes the input and output pointers to be forced to an offset of 2; the input pointer will be forced to the in_sel_a state while the output pointer will be forced to the sel_q_c state. This initialization of the input and output pointers can cause discontinuities in a data stream and should therefore be handled at startup.

Table 11. Synchronization Source Selection

sync_fifo (2:0)	Synchronization Source
000	txenable pin
001	phstr pin
010	qflag pin
011	db(15)
100	da(15) first transition (one shot)
101	sync now with SIF write (always on)
110	sync source disabled (always off)
111	sync now with SIF write (always on)

All possible sync sources are registered with `clk_in` and then passed through a synchronous rising edge detector.

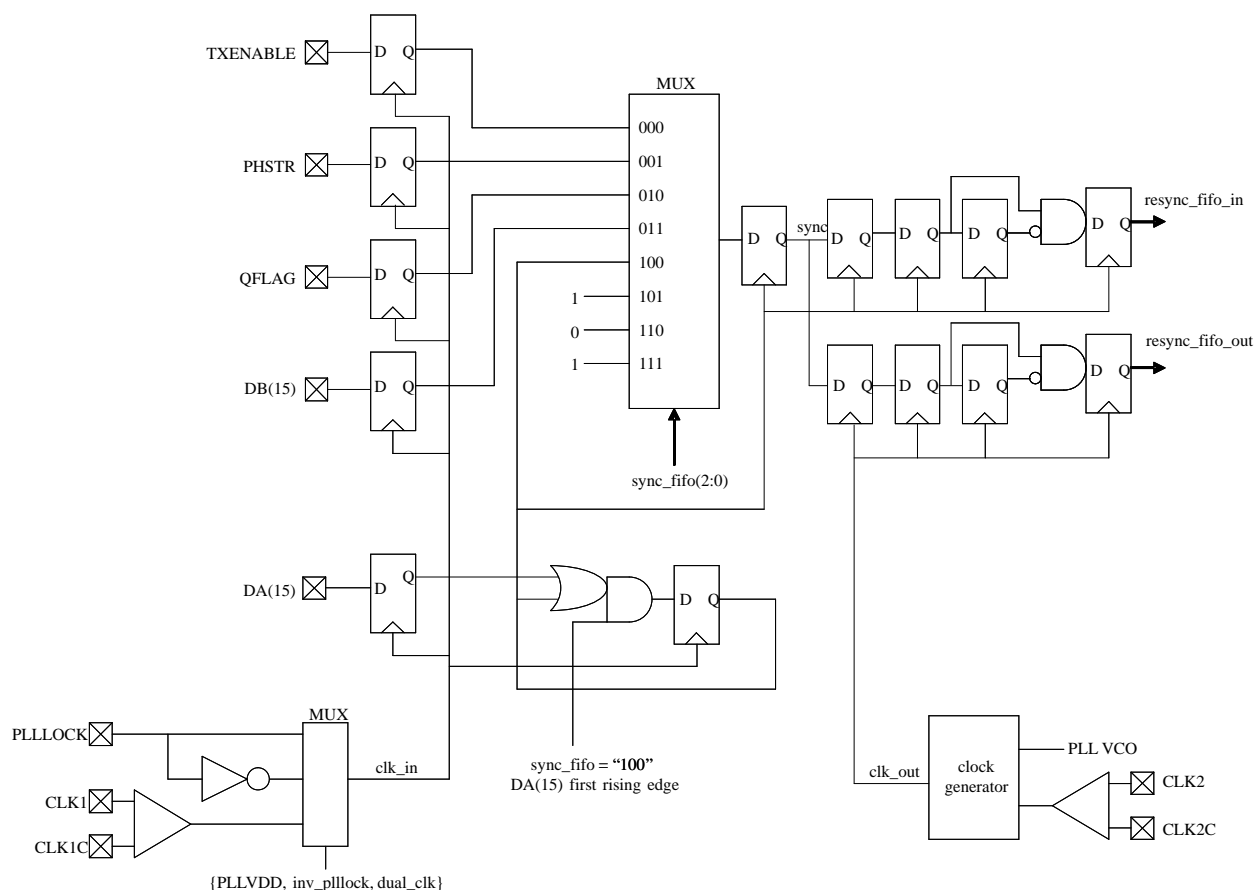


Figure 50. DAC5687 FIFO Synchronization Source Logic

For example, if TXENABLE is selected as the sync source, a low-to-high transition on the TXENABLE pin causes the pointers to be initialized.

Once initialized, the FIFO input pointer advances using `clk_in` and the output pointer advances using `clk_out`, providing an *elastic* buffering effect. The phase relationship between `clk_in` and `clk_out` can wander or drift until the output pointer overruns the input pointer or vice versa.

Even/Odd Input Mode

The DAC5687 has a double data rate input mode that allows both input ports to be used to multiplex data onto one DAC channel (A). In the Even/Odd mode, the FIR3 filter can be used to interpolate the data by 2x. The even/odd input mode is enabled by setting **half_rate** in **CONFIG3**. The maximum input rate for each port is 250 MSPS, for a combined rate of 500 MSPS.

Synchronization

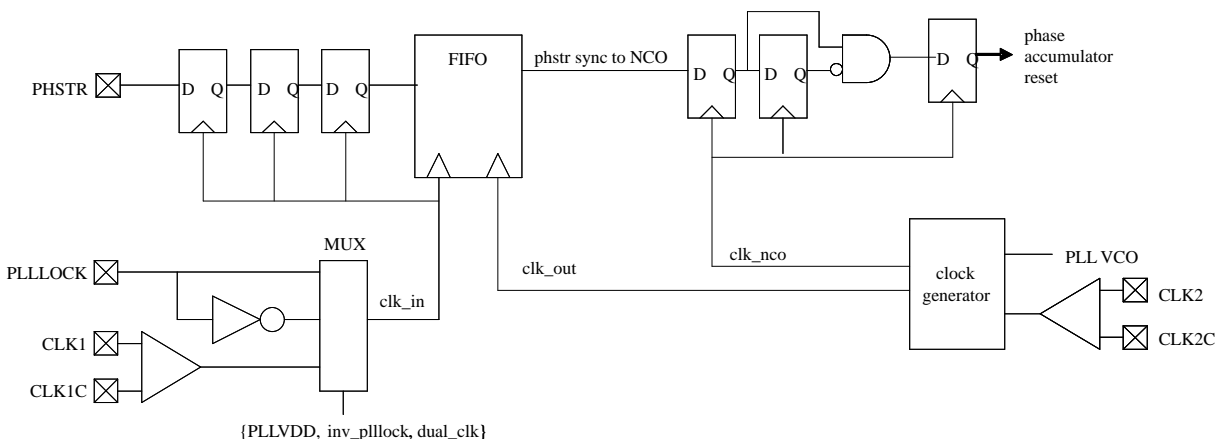
The DAC5687 has several digital circuits that can be synchronized to a known state. The circuits that can be synchronized are the fine mixer (NCO), coarse mixer (fixed $fs/2$ or $fs/4$ mixer), the FIFO input and output pointers, and the internal clock divider.

Table 12. Synchronization in Different Clock Modes

Clock Mode	PLLVD Pin	Serial Interface Register Bits			DA, DB, PHSTR, and TXENABLE Latch	Description
		fifo_bypass	dual_clk	inv_plllock		
Single External Clock without FIFO	0 V	1	0	0	PLLLOCK rising edge	Signal at the PLLLOCK output pin is used to clock the PHSTR signal into the chip. The PLLLOCK output clock is generated by dividing the CLK2/CLK2C input signal by the programmed interpolation and interface settings.
				1	PLLLOCK falling edge	
Single External Clock with FIFO	0 V	0	0	0	PLLLOCK rising edge	Signal at the PLLLOCK output pin is used to clock the PHSTR signal into the chip. The PLLLOCK output clock is generated by dividing the CLK2/CLK2C input signal by the programmed interpolation and interface settings. Enabling the FIFO allows the chip to function with large loads on the PLLLOCK output pin at high input rates. <i>The FIFO must be initialized first in this mode.</i>
				1	PLLLOCK falling edge	
Dual External Clock without FIFO	0 V	1	1	0	CLK1/CLK1C	The CLK1/CLK1C input signal is used to clock in the PHSTR signal. CLK1/CLK1C and CLK2/CLK2C are both input to the chip and the phase relationship must be tightly controlled
Dual External Clock with FIFO	0 V	0	1	1	CLK1/CLK1C	The CLK1/CLK1C input signal is used to clock in the PHSTR signal. CLK1/CLK1C and CLK2/CLK2C are both input to the chip, but no phase relationship is required. The FIFO input circuits are used to manage the clock domain transfers. <i>The FIFO must be initialized in this mode.</i>
PLL Enabled	3.3 V	1	0	0	CLK1/CLK1C	The CLK1/CLK1C input signal is used to clock in the PHSTR signal. <i>The FIFO must be bypassed when the PLL is enabled.</i>

NCO Synchronization

The phase accumulator in the NCO block (see the Fine Mixer (FMIX) section and [Figure 39](#) for a description of the NCO) can be synchronously reset when PHSTR is asserted. The PHSTR signal passes through the input FIFO block, using the input clock associated with the clocking mode. If the FIFO is enabled, there can be some uncertainty in the exact instant the PHSTR synchronization signal arrives at the NCO accumulator due to the *elastic* capabilities of the FIFO. For example, in dual-clock mode with the FIFO enabled, the internal clock generator divides down the CLK2/CLK2C input signal to generate the FIFO output clock. The phase of this generated clock will be unknown externally, resulting in an uncertainty of the exact PHSTR instant of as much as a few input clock cycles.

**Figure 51. Logic Path for PHSTR Synchronization Signal to NCO**

The serial interface includes a **sync_nco** bit in register **SYNC_CNTL**, which needs to be set for the PHSTR input signal to initialize the phase accumulator.

The NCO uses a rising edge detector to perform the synchronous reset of the phase accumulator. Due to the pipelined nature of the NCO, the latency from the phstr sync signal at the FIFO output to the instant the phase accumulator is cleared is $13 f_{NCO}$ clock cycles ($f_{NCO} = f_{DAC}$ in X4 mode, $f_{NCO} = f_{DAC}/2$ in X2, X4L, and X8 modes). In 2x interpolation mode with the inverse sinc filter disabled, overall latency from PHSTR input to DAC output is ~100 input clock cycles.

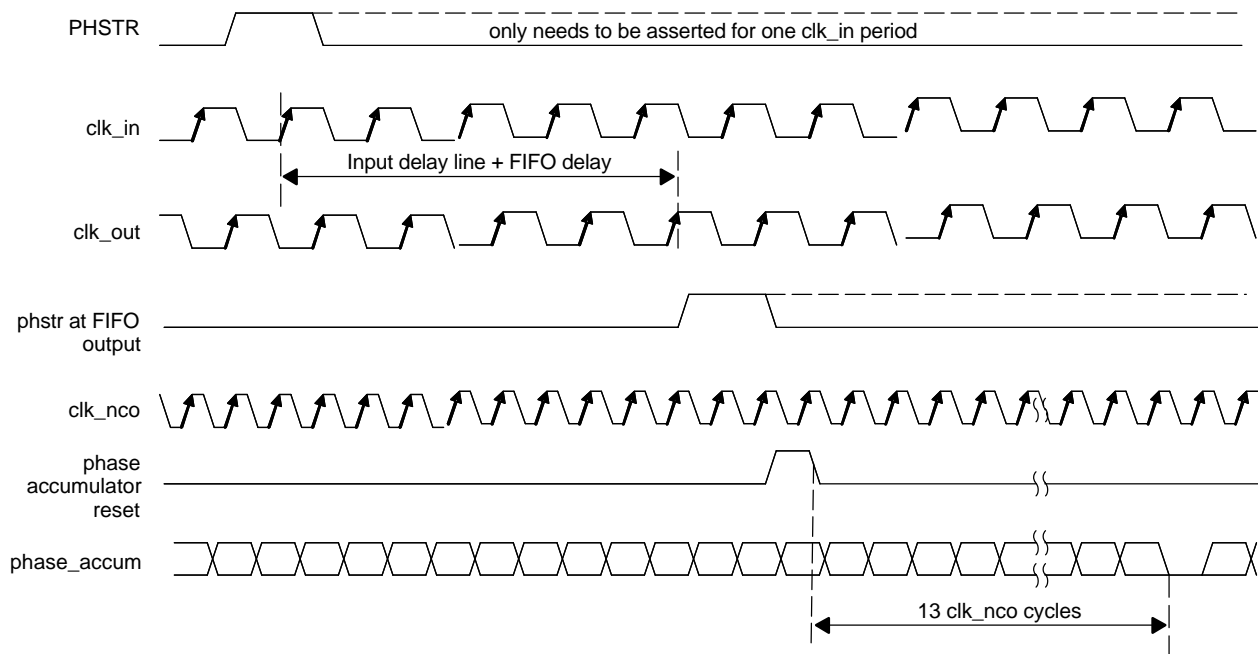


Figure 52. NCO Phase Accumulator Reset Synchronization Timing

Coarse Mixer (CMIX) Synchronization

The coarse mixer implements the $f_{DAC}/2$ and $f_{DAC}/4$ (and $-f_{DAC}/4$) fixed complex mixing operation using simple complements of the datapath signals to create the proper sequences. The sequences are controlled using a simple counter and this counter can be synchronously reset using the PHSTR signal.

Similar to the NCO, the PHSTR signal used by the coarse mixer is from the FIFO output. This introduces the same uncertainty effect due to the FIFO input to output pointer relationship. Bypassing the FIFO and using the dual external clock mode without FIFO eliminates this uncertainty for systems using multiple DAC5687 devices when this cannot be tolerated. Using the internal PLL, as with the NCO, allows the complete control and synchronization of the coarse mixer.

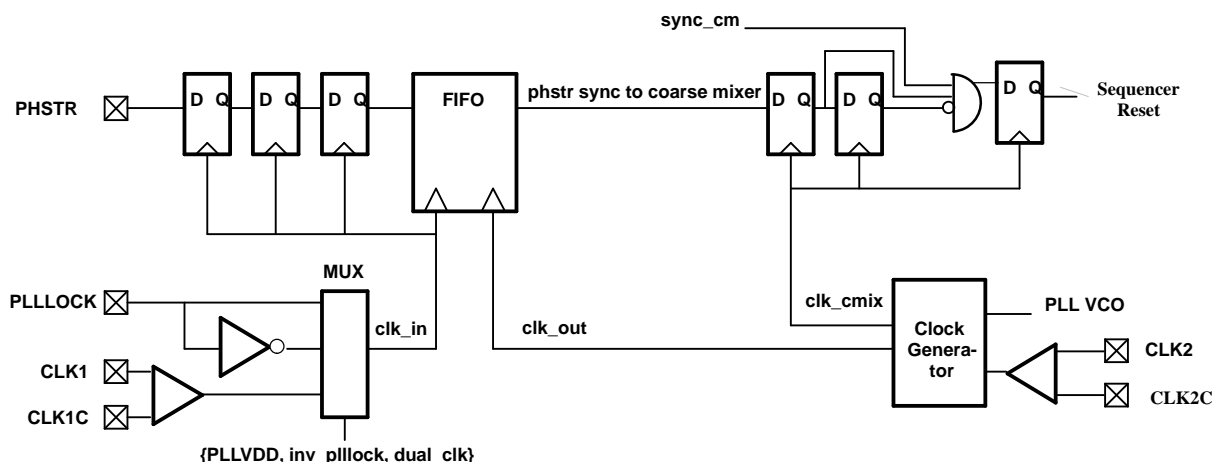


Figure 53. Logic Path for PHSTR Synchronization Signal to CMIX Reset

To enable the PHSTR synchronous reset, the serial interface bit **sync_cm** in register **SYNC_CNTL** must be set. The coarse mixer sequence counter will be held reset when PHSTR is low and operates when PHSTR is high.

Only needs to be high for one **clk_in** period

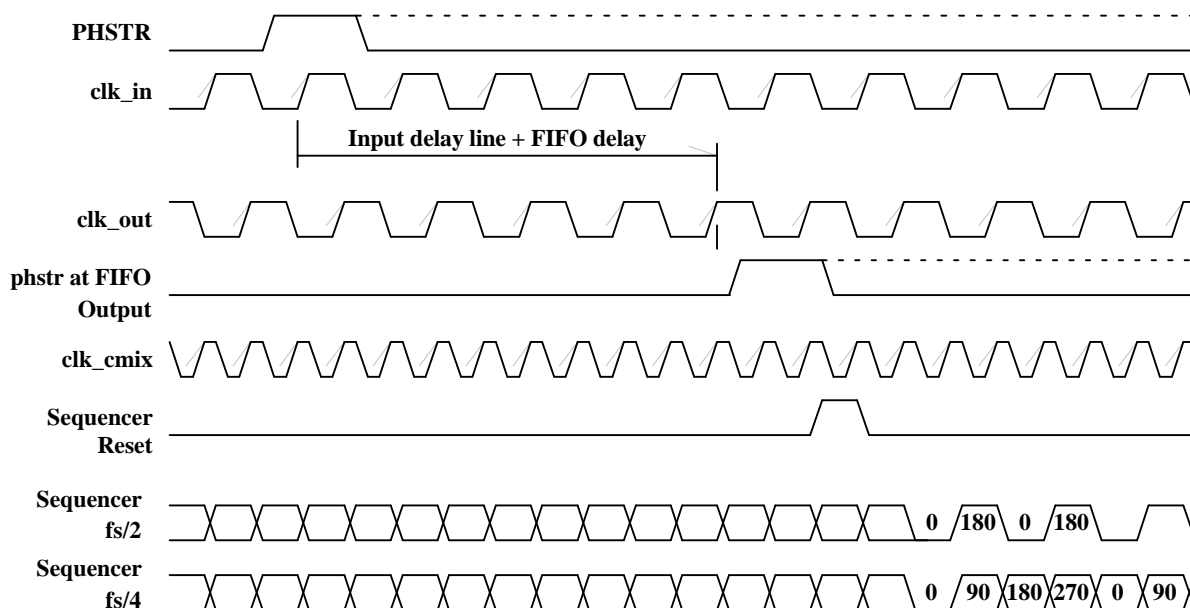


Figure 54. CMIX Reset Synchronization Timing

In addition to the reset function provided by the PHSTR signal, the **phstr_del(1:0)** bits in register **ATEST** allow the user to select the initial (reset) state. Changing the **cm_mode** lower 2 bits produces the same phase shift results.

Table 13. Initial State of CMIX After Reset

Fix Mix Selection	phstr_del(1:0)	Initial State at PHSTR
$f_s/2$	00 and 10	Normal
$f_s/2$	01 and 11	180 degree shift
$f_s/4$	00	Normal
$f_s/4$	01	90 degree shift

Table 13. Initial State of CMIX After Reset (continued)

Fix Mix Selection	phstr_del(1:0)	Initial State at PHSTR
$f_s/4$	10	180 degree shift
$f_s/4$	11	270 degree shift

Input Clock Synchronization of Multiple DAC5687s

For applications where multiple DAC5687 chips are used, clock synchronization is best achieved by using dual-clock mode with the FIFO disabled or the PLL-clock mode. In the dual-clock mode with FIFO disabled, an appropriate clock PLL such as the CDC7005 is required to provide the DAC and input rate clocks that meet the skew requirement t_{align} (see Figure 47). An example for synchronizing multiple DAC5687 devices in dual clock mode with two CDC7005 is shown in Figure 55. When using the internal PLL-clock mode, synchronization of multiple using PHSTR is completely deterministic due to the phase/frequency detector in the PLL feedback loop. All chips using the same CLK1/CLK1C input clock will have identical internal clocking phases.

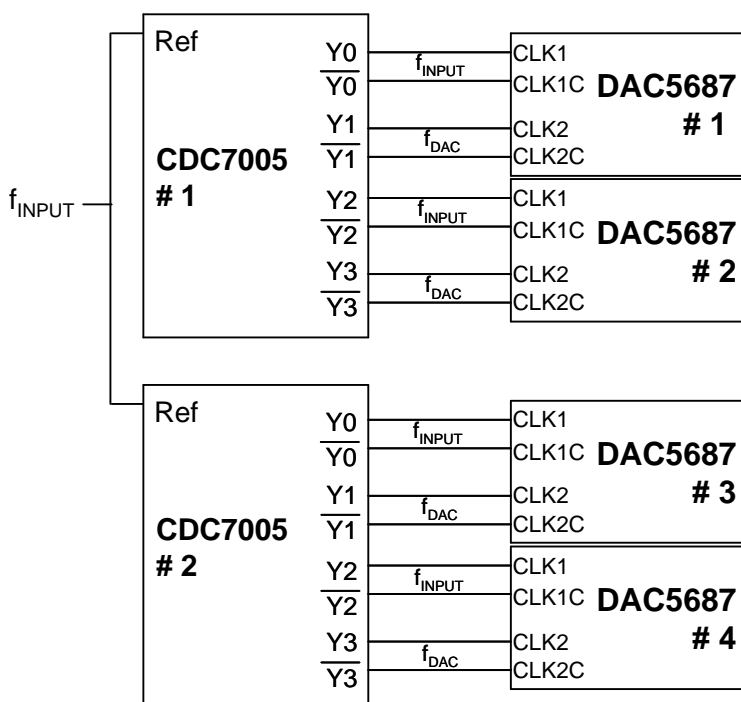


Figure 55. Block Diagram for Clock Synchronization of Multiple DAC5687 Devices in Dual-Clock Mode

Reference Operation

The DAC5687 comprises a bandgap reference and control amplifier for biasing the full-scale output current. The full-scale output current is set by applying an external resistor R_{BIAS} to pin $BIASJ$. The bias current I_{BIAS} through resistor R_{BIAS} is defined by the on-chip bandgap reference voltage and control amplifier. The full-scale output current equals 16 times this bias current. The full-scale output current I_{OUTFS} can thus be expressed as:

$$I_{OUTFS} = 16 \times I_{BIAS} = 16 \times V_{EXTIO} / R_{BIAS}$$

where V_{EXTIO} is the voltage at terminal $EXTIO$. The bandgap reference voltage delivers an accurate voltage of 1.2 V. This reference is active when terminal $EXTLO$ is connected to $AGND$. An external decoupling capacitor C_{EXT} of 0.1 μF should be connected externally to terminal $EXTIO$ for compensation. The bandgap reference can additionally be used for external reference operation. In that case, an external buffer with high impedance input should be applied in order to limit the bandgap load current to a maximum of 100 nA. The internal reference can be disabled and overridden by an external reference by connecting $EXTLO$ to $AVDD$. Capacitor C_{EXT} may hence be omitted. Terminal $EXTIO$ thus serves as either input or output node.

The full-scale output current can be adjusted from 20 mA down to 2 mA by varying resistor R_{BIAS} or changing the externally applied reference voltage. The internal control amplifier has a wide input range, supporting the full-scale output current range of 20 mA.

DAC Transfer Function

The CMOS DAC's consist of a segmented array of NMOS current sinks, capable of sinking a full-scale output current up to 20 mA. Differential current switches direct the current of each current source through either one of the complementary output nodes IOUT1 or IOUT2. Complementary output currents enable differential operation, thus canceling out common mode noise sources (digital feed-through, on-chip and PCB noise), dc offsets, even order distortion components, and increasing signal output power by a factor of two.

The full-scale output current is set using external resistor R_{BIAS} in combination with an on-chip bandgap voltage reference source (+1.2 V) and control amplifier. Current I_{BIAS} through resistor R_{BIAS} is mirrored internally to provide a full-scale output current equal to 16 times I_{BIAS} . The full-scale current $I_{OUT_{FS}}$ can be adjusted from 20 mA down to 2 mA.

The relation between IOUT1 and IOUT2 can be expressed as:

$$I_{OUT1} = -I_{OUT_{FS}} - I_{OUT2}$$

We will denote current flowing into a node as - current and current flowing out of a node as + current. Since the output stage is a current sink the current can only flow from AVDD into the IOUT1 and IOUT2 pins. If $I_{OUT2} = -5$ mA and $I_{OUT_{FS}} = 20$ mA then:

$$I_{OUT1} = -20 - (-5) = -15 \text{ mA}$$

The output current flow in each pin driving a resistive load can be expressed as:

$$I_{OUT1} = I_{OUT_{FS}} \times \text{CODE} / 65536$$

$$I_{OUT2} = I_{OUT_{FS}} \times (65535 - \text{CODE}) / 65536$$

where CODE is the decimal representation of the DAC data input word.

For the case where IOUT1 and IOUT2 drive resistor loads R_L directly, this translates into single ended voltages at IOUT1 and IOUT2:

$$V_{OUT1} = AVDD - |I_{OUT1}| \times R_L$$

$$V_{OUT2} = AVDD - |I_{OUT2}| \times R_L$$

Assuming that the data is full scale (65535 in offset binary notation) and the R_L is 25 Ω , the differential voltage between pins IOUT1 and IOUT2 can be expressed as:

$$V_{OUT1} = AVDD - | -20 \text{ mA} | \times 25 \Omega = 2.8 \text{ V}$$

$$V_{OUT2} = AVDD - | -0 \text{ mA} | \times 25 \Omega = 3.3 \text{ V}$$

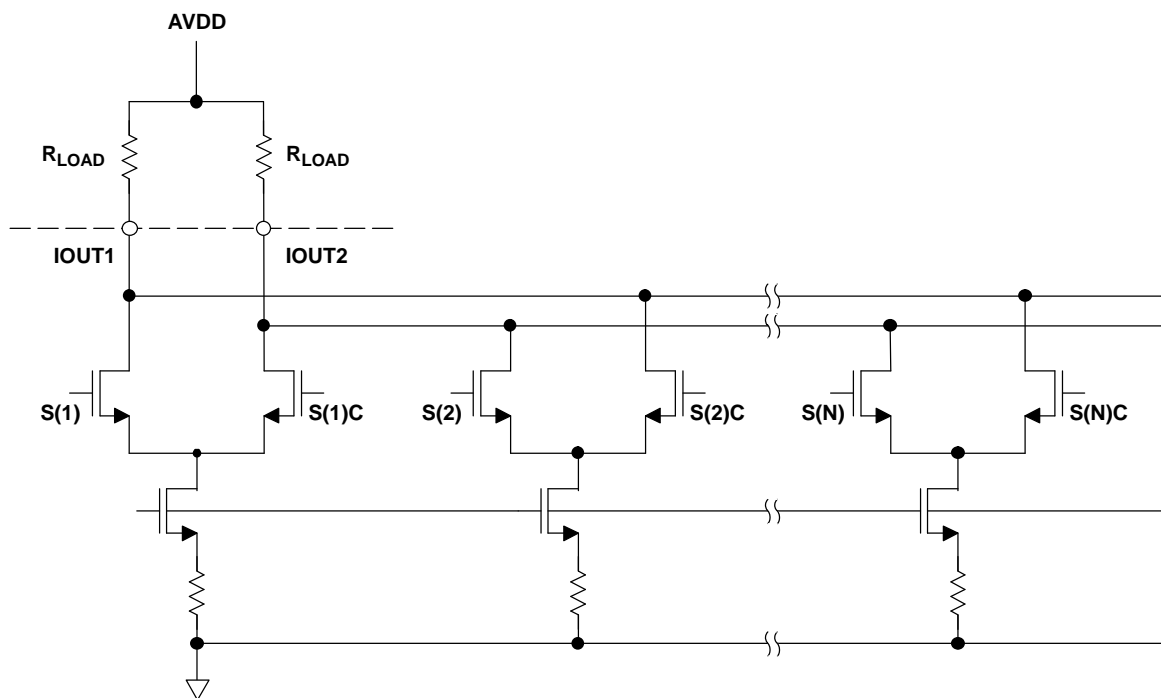
$$V_{DIFF} = V_{OUT1} - V_{OUT2} = 0.5 \text{ V}$$

Note that care should be taken not to exceed the compliance voltages at node IOUT1 and IOUT2, which would lead to increased signal distortion.

Analog Current Outputs

Figure 56 shows a simplified schematic of the current source array output with corresponding switches. Differential switches direct the current of each individual NMOS current source to either the positive output node IOUT1 or its complementary negative output node IOUT2. The output impedance is determined by the stack of the current sources and differential switches, and is typically >300 k Ω in parallel with an output capacitance of 5 pF.

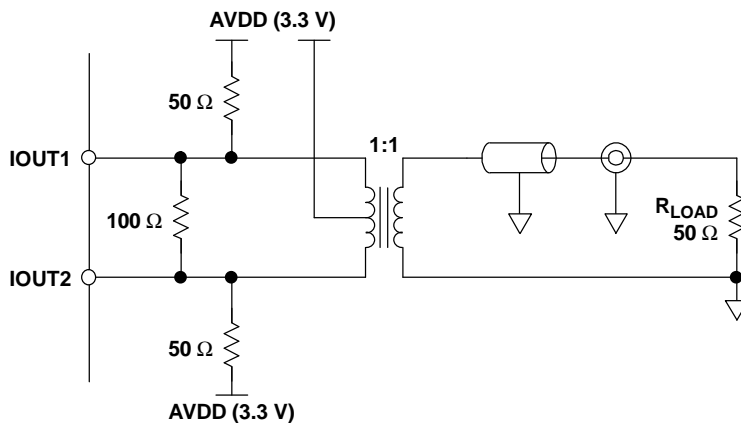
The external output resistors are referred to an external ground. The minimum output compliance at nodes IOUT1 and IOUT2 is limited to $AVDD - 0.5 \text{ V}$, determined by the CMOS process. Beyond this value, transistor breakdown may occur resulting in reduced reliability of the DAC5687 device. The maximum output compliance voltage at nodes IOUT1 and IOUT2 equals $AVDD + 0.5 \text{ V}$. Exceeding the minimum output compliance voltage adversely affects distortion performance and integral non-linearity. The optimum distortion performance for a single-ended or differential output is achieved when the maximum full-scale signal at IOUT1 and IOUT2 does not exceed 0.5 V.



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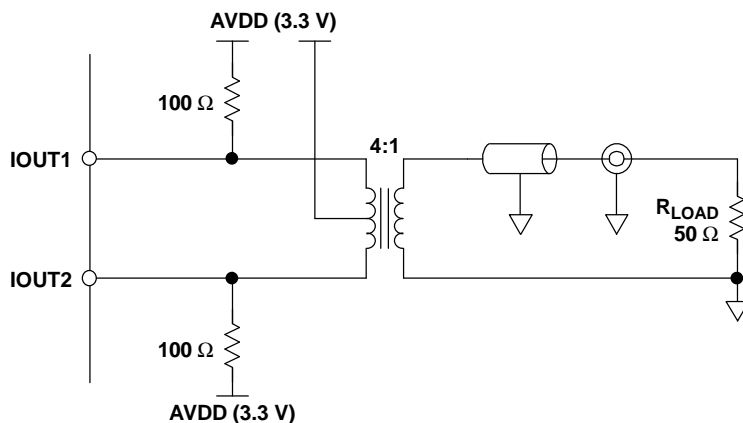
Figure 56. Equivalent Analog Current Output

The DAC5687 can be easily configured to drive a doubly terminated 50- Ω cable using a properly selected RF transformer. Figure 57 and Figure 58 show the 50- Ω doubly terminated transformer configuration with 1:1 and 4:1 impedance ratio, respectively. Note that the center tap of the primary input of the transformer has to be connected to AVDD to enable a dc-current flow. Applying a 20-mA full-scale output current would lead to a 0.5 V_{PP} for a 1:1 transformer and a 1-V_{PP} output for a 4:1 transformer. The low dc-impedance between the IOUT1 or IOUT2 and the transformer center tap sets the center of the ac-signal at AVDD, so the 1-V_{PP} output for the 4:1 transformer results in an output between AVDD + 0.5 V and AVDD – 0.5 V.



S0033-01

Figure 57. Driving a Doubly Terminated 50- Ω Cable Using a 1:1 Impedance Ratio Transformer

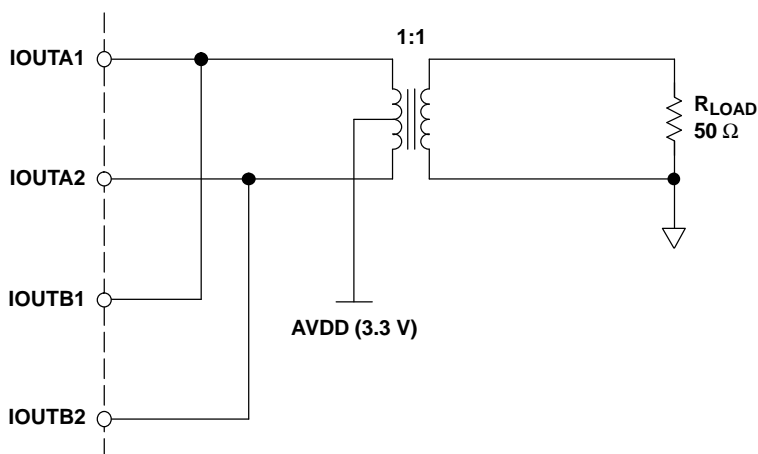


S0033-02

Figure 58. Driving a Doubly Terminated 50-Ω Cable Using a 4:1 Impedance Ratio Transformer

Combined Output Termination

The DAC5687 DAC A and DAC B outputs can be summed together as shown in Figure 59 to provide a 40-mA full-scale output for increased output power.



S0069-01

Figure 59. Combined Output Termination Using a 1:1 Impedance Ratio Transformer into 50-Ω Load

For the case where the digital codes for the two DACs are identical, the termination results in a full scale swing of $2 V_{PP}$ into the 50-Ω load, or 10 dBm. This is 6 dB higher than the 4:1 output termination recommended for a single DAC output.

There are two methods to produce identical DAC codes. In modes where there is mixing between digital channels A and B, i.e., when channels A and B are isolated, the identical data can be sent to both input ports to produce identical DAC codes. Channels A and B are isolated when FMIX is disabled, the QMC is disabled or enabled with QMC phase register set to 0, and CMIX is disabled or set to $f_{DAC}/2$. Note that frequency upconversion is still possible using the high-pass filter setting and CMIX $f_{DAC}/2$.

Alternatively, by applying the input data on one input port only and setting the other input port to mid-scale (zero), the NCO can be used to duplicate the output of the active input channel in the other channel by setting the frequency to zero, phase to 8192 and NCO_GAIN = 1 and QMC gain = 1446. Assuming $I(t)$ is the wanted signal and $Q(t) = 0$, this is demonstrated by the simplification of the NCO equations in the Fine Mixer (FMIX) section:

$$I_{OUT}(t) = (I_{IN}(t)\cos(2\pi \times 0 \times t + \pi/4) - 0 \times \sin((2\pi \times 0 \times t + \pi/4)) \times 2^{(1-1)}) = I_{IN}(t)\cos(\pi/4) = I_{IN}(t)/2^{1/2}$$

$$Q_{OUT}(t) = (I_{IN}(t)\sin(2\pi \times 0 \times t + \pi/4) + 0 \times \cos(2\pi \times 0 \times t + \pi/4)) \times 2^{(1-1)} = I_{IN}(t)\sin(\pi/4) = I_{IN}(t)/2^{1/2}$$

Applying the QMC gain of 1446, equivalent to $2^{7/2}$, increases the signal back to unity gain through the FMIX and the QMC blocks.

Note that with this termination, the DAC side of the transformer is not 50-Ω terminated and therefore may result in reflections when used with a cable output.

Digital Inputs

Figure 60 shows a schematic of the equivalent CMOS digital inputs of the DAC5687. DA[0..15], DB[0..15], SLEEP, PHSTR, TXENABLE, QFLAG, SDIO, SCLK, and SDENB have pull-down resistors and RESETB has a pull-up resistor internal to the DAC5687. See the specification table for logic thresholds.

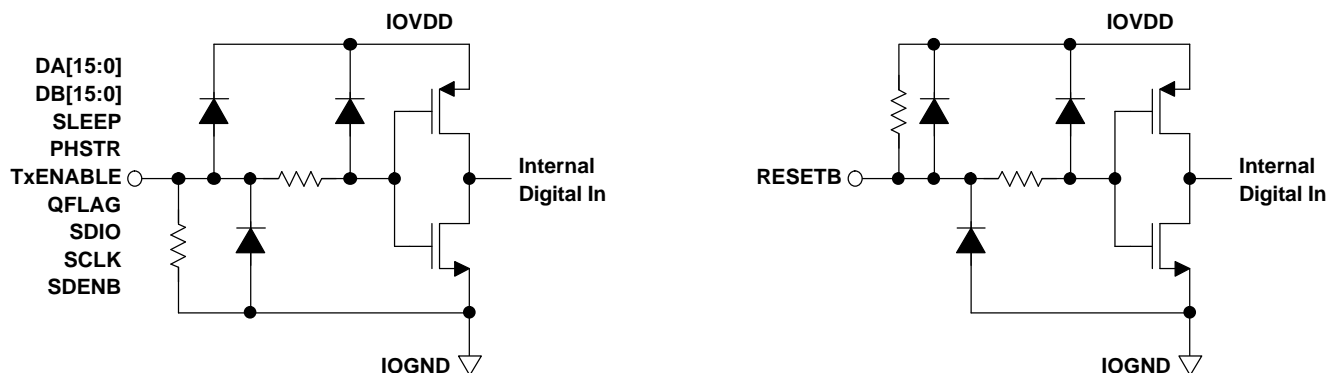
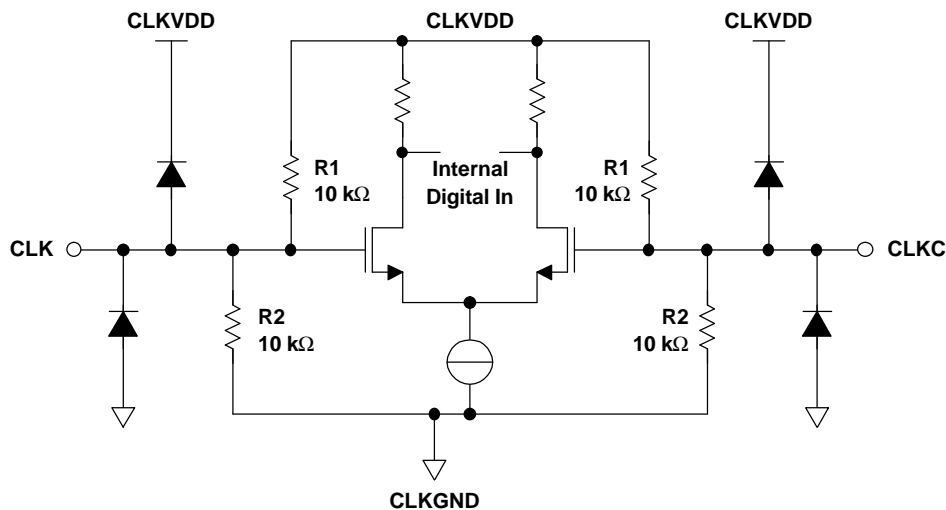


Figure 60. CMOS/TTL Digital Equivalent Input

Clock Inputs

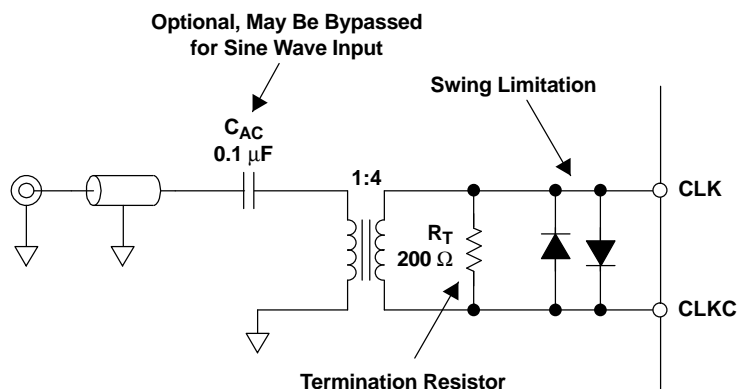
Figure 61 shows an equivalent circuit for the clock input.



S0028-01

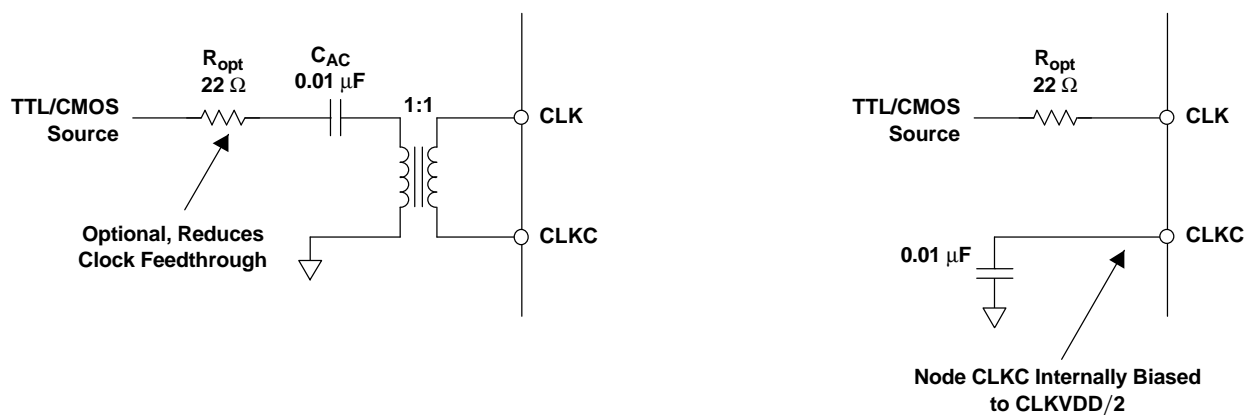
Figure 61. Clock Input Equivalent Circuit

Figure 62, Figure 63, and Figure 64 show various input configurations for driving the differential clock input (CLK/CLKC).



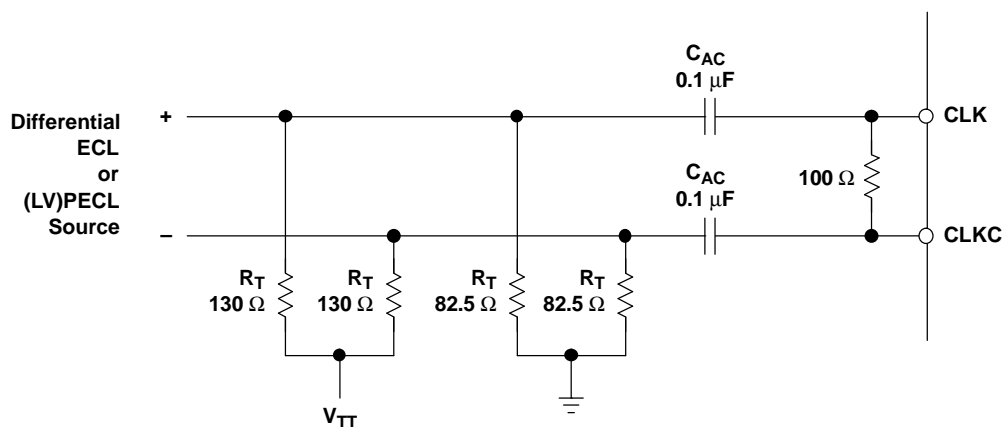
S0029-01

Figure 62. Preferred Clock Input Configuration



S0030-01

Figure 63. Driving the DAC5687 With a Single-Ended TTL/CMOS Clock Source



S0031-01

Figure 64. Driving the DAC5687 With Differential ECL/PECL Clock Source

Power Up Sequence

In all conditions, bring up DVDD first. If PLLVDD is powered (PLL on), CLKVDD should be powered before or simultaneously with PLLVDD. AVDD, CLKVDD, and IOVDD can be powered simultaneously or in any order. Within AVDD, the multiple AVDD pins should be powered simultaneously.

There are no specific requirements on the ramp rate for the supplies.

Sleep Mode

The DAC5687 features a power-down mode that turns off the output current and reduces the supply current to less than 5 mA over the supply range of 3 V to 3.6 V and temperature range. The power-down mode is activated by applying a logic level 1 to the SLEEP pin (e.g., by connecting pin SLEEP to AVDD). An internal pull-down circuit at node SLEEP ensures that the DAC5687 is enabled if the input is left disconnected. Power-up and power-down activation times depend on the value of external capacitor at node EXTIO. For a nominal capacitor value of 0.1-μF, power down takes less than 5 μs and approximately 3 ms to power back up.

Application Information

Designing the PLL Loop Filter

Table 14. Optimum DAC5687 PLL Settings

f _{DAC} (MHZ)	pll_freq	pll_kv	pll_div (1:0)	f _{VCO} / f _{DAC}	Estimated G _{VCO} (MHz/V)
25 to 28.125	0	1	11	8	380
28.125 to 46.25	0	0	11	8	250
46.25 to 60	0	1	11	8	300
60 to 61.875	1	0	11	8	130
61.875 to 65	1	1	11	8	225
65 to 92.5	0	0	10	4	250
92.5 to 120	0	1	10	4	300
120 to 123.75	1	0	10	4	130
123.75 to 130	1	1	10	4	225
130 to 185	0	0	01	2	250
185 to 240	0	1	01	2	300
240 to 247.5	1	0	01	2	130
247.5 to 260	1	1	01	2	225
260 to 370	0	0	00	1	250
370 to 480	0	1	00	1	300
480 to 495	1	0	00	1	130
495 to 520	1	1	00	1	225

The optimized DAC5687 PLL settings based on the VCO frequency MIN and MAX values (see the digital specifications) as a function of f_{DAC} are listed in [Table 14](#). To minimize phase noise at a given f_{DAC}, **pll_freq**, **pll_kv**, and the **pll_div** have been chosen so G_{VCO} is minimized and within the MIN and MAX frequency for a given setting.

For example, if f_{DAC} = 245.76 MHz, **pll_freq** is set to 1, **pll_kv** is set to 0 and pll_div(1:0) is set to 01 (divide by 2) to lock the VCO at 491.52 MHz.

The external loop filter components C1, C2, and R1 are set by the G_{VCO}, $N = f_{VCO}/f_{DATA} = f_{VCO} \times \text{Interpolation}/f_{DAC}$, the loop phase margin ϕ_d and the loop bandwidth ω_d . Except for applications where abrupt clock frequency changes require a fast PLL lock time, it is suggested that ω_d be set to at least 80 degrees for stable locking and suppression of the phase noise side lobes. Phase margins of 60 degrees or less can be sensitive to board layout and decoupling details.

C1, C2, and R1 are then calculated by the following equations

$$C1 = \tau1 \left(1 - \frac{\tau2}{\tau3} \right) \quad C2 = \frac{\tau1 - \tau2}{\tau3} \quad R1 = \frac{\tau3^2}{\tau1 (\tau3 - \tau2)} \quad (1)$$

where,

$$\tau1 = \frac{K_d K_{VCO}}{\omega_d^2} (\tan \phi_d + \sec \phi_d) \quad \tau2 = \frac{1}{\omega_d (\tan \phi_d + \sec \phi_d)} \quad \tau3 = \frac{\tan \phi_d + \sec \phi_d}{\omega_d} \quad (2)$$

and

charge pump current: $i_{qp} = 1 \text{ mA}$

vco gain: $K_{VCO} = 2\pi \times G_{VCO} \text{ rad/V}$

FVCO/FDATA: $N = \{2, 4, 8, 16, 32\}$

phase detector gain: $K_d = i_{qp} \times (2 \times N) - 1 \text{ A/rad}$

An Excel spreadsheet is provided by Texas Instruments for automatically calculating the values for C1, C2, and R.

Completing the example given above with:

Parameter	Value	Units
G_{VCO}	1.30E+02	MHz/V
ω_d	0.50E+00	MHz
N	4	
ϕ_d	80	Degrees

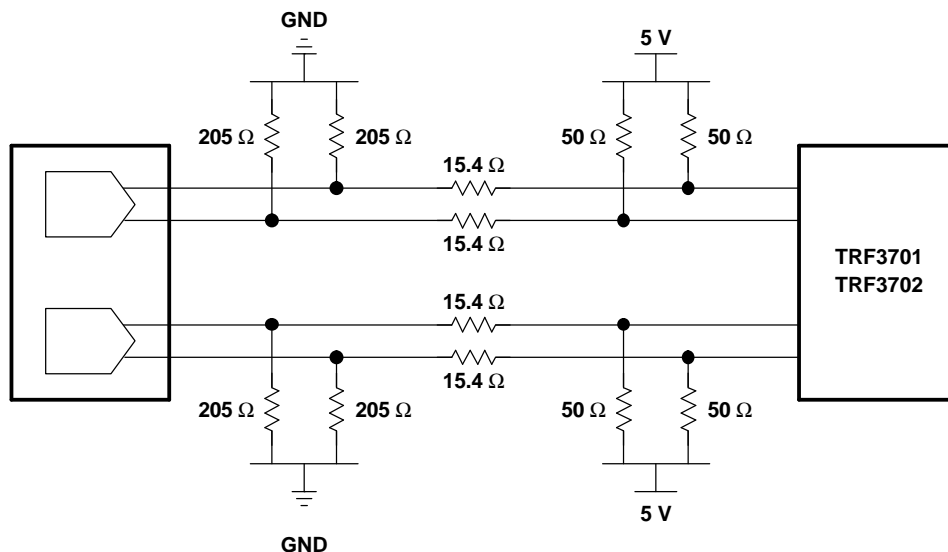
The component values are:

C1 (F)	C2 (F)	R (Ω)
3.74E-08	2.88E-10	9.74E+01

As the PLL characteristics are not sensitive to these components, the closest 20% tolerance capacitor and 1% tolerance resistor values can be used. If the calculation results in a negative value for C2 or an unrealistically large value for C1, then the phase margin may need to be reduced slightly.

DAC5687 Passive Interface-to-Analog Quadrature Modulators

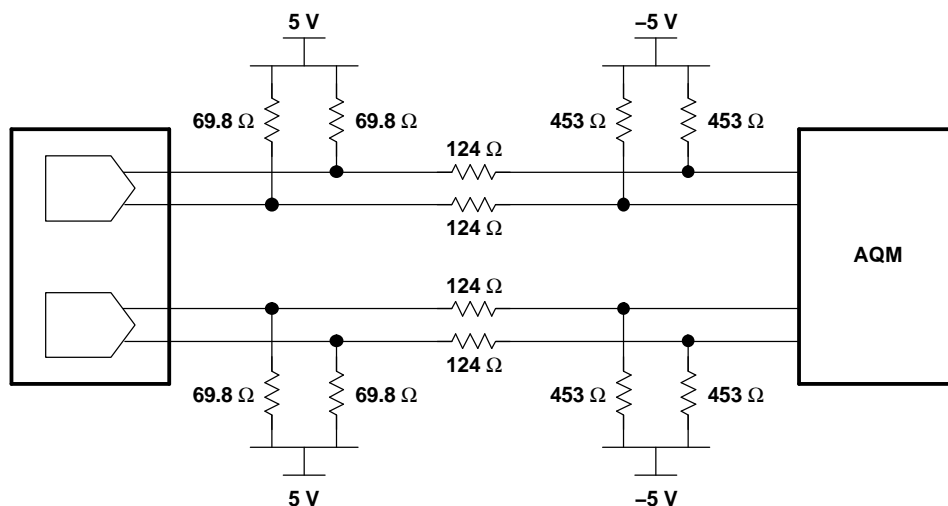
The DAC5687 has a maximum 20-mA full-scale output and a compliance range of $AVDD \pm 0.5 \text{ V}$. The TRF3701 or TRF3702 analog quadrature modulators (AQM) require a common-mode of approximately 3.7 V and 1.5 V to $2-V_{PP}$ differential swing. A resistive network as shown in [Figure 65](#) can be used to translate the common mode voltage between the DAC5687 and TRF3701 or TRF3702. The voltage at the DAC output pins for a full-scale sine wave is centered at approximately $AVDD$ with a $1-V_{PP}$ single ended ($2-V_{PP}$ differential). The voltage at the TRF3701/2 input pins is centered at 3.7 V and swings $0.76-V_{PP}$ single ended ($1.56-V_{PP}$ differential), or 2.4 dB of insertion loss.



B0046-01

Figure 65. DAC5687 Passive Interface to TRF3701/2 Analog Quadrature Modulator

Changing the voltage levels and resistor values enable other common-mode voltages at the analog quadrature modulator input. For example, the network shown in Figure 66 can produce a 1.5-V common mode at the analog quadrature modulator input, with a 0.78-V_{PP} single-ended swing (1.56-V_{PP} differential swing), or 0.2-dB insertion loss.



B0046-02

Figure 66. DAC5687 Passive Interface With 1.5-V Common Mode at AQM Input

Non-Harmonic Clock-Related Spurious Signals

In interpolating DACs, imperfect isolation between the digital and DAC clock circuits generate spurious signals at frequencies related to the DAC clock rate. The digital interpolation filters in these DACs run at sub-harmonic frequencies of the output rate clock, where these frequencies are $f_{DAC}/2^N$, $N = 1 - 3$. For example, for X2 mode there is only one interpolation filter running at $f_{DAC}/2$; for X4 and X4L modes, on the other hand, there are two interpolation filters running at $f_{DAC}/2$ and $f_{DAC}/4$. In X8 mode, there are three interpolation filters running at $f_{DAC}/2$, $f_{DAC}/4$, and $f_{DAC}/8$. These lower-speed clocks for the interpolation filter mix with the DAC clock circuit and create spurious images of the wanted signal and second Nyquist-zone image at offsets of $f_{DAC}/2^N$.

To calculate the non-harmonic clock related spurious signals for a particular condition, we first determine the location of the spurious signals and then the amplitude.

Location of the Spurious Signals

The location of the spurious signals is determined by the DAC5687 output frequency (f_{SIG}) and whether the output is used as a dual output complex signal to be fed to an analog quadrature modulator (AQM) or as a real IF signal from a single DAC output.

Figure 67 shows the location of spurious signals for X2 mode as a function of f_{SIG}/f_{DAC} . For complex outputs, the spurious frequencies cover a range of $-0.5 \times f_{DAC}$ to $0.5 \times f_{DAC}$, with the negative complex frequency indicating that the spurious signal will fall in the opposite sideband at the output of the QAM from the wanted signal. For the real output, the phase information for the spurious signal is lost, and therefore what was a negative frequency for the complex output is a positive frequency for a real output.

For the X2 mode, there is one spurious frequency with an absolute frequency less than $0.5 \times f_{DAC}$. For a complex output in X2 mode, the spurious signal will always be offset $f_{DAC}/2$ from the wanted signal at $f_{SIG} - f_{DAC}/2$. For a real output, as f_{SIG} approaches $f_{DAC}/4$, the spurious signal frequency falls at $f_{DAC}/2 - f_{SIG}$, which will also approach $f_{DAC}/4$.

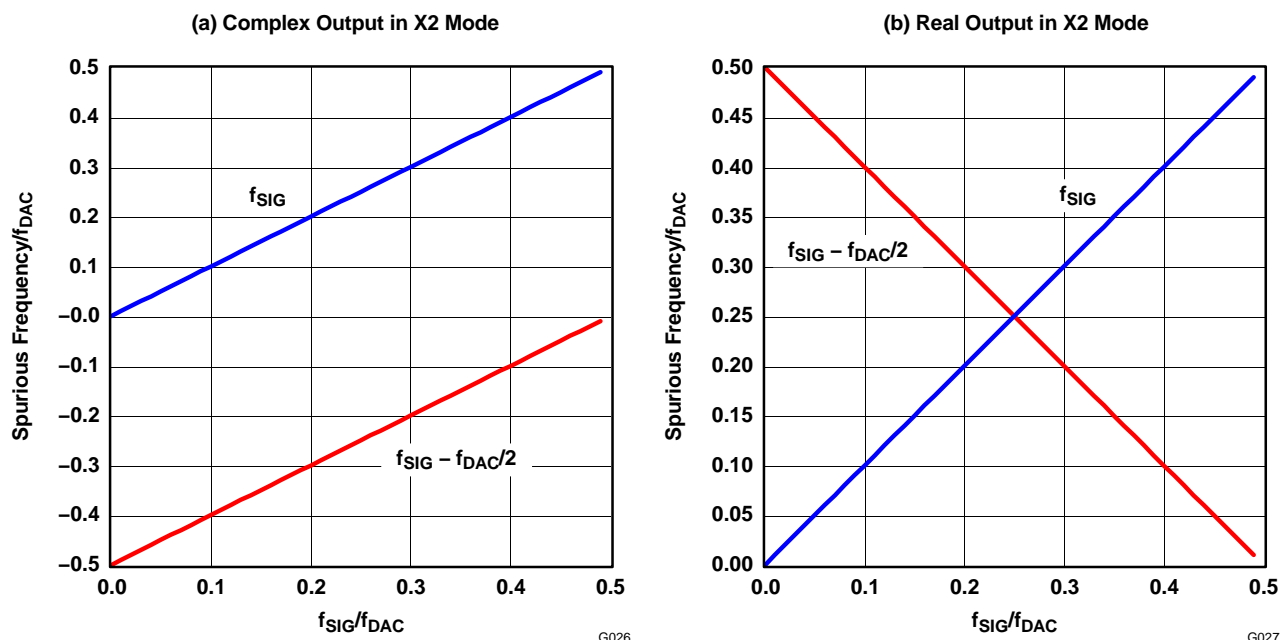


Figure 67. Frequency of Clock Mixing Spurious Images in X2 Mode

Figure 68 shows the location of spurious signals for X4 and X4L mode as a function of f_{SIG}/f_{DAC} . The addition of the $f_{DAC}/4$ clock frequency for the first interpolation filter creates three new spurious signals. For a complex output, the nearest spurious signals are $f_{DAC}/4$ offset from f_{SIG} . For a real output, the signal due to $f_{SIG} - f_{DAC}/4$ and $f_{SIG} - f_{DAC} \times 3/4$ falls in band as f_{SIG} approaches $f_{DAC}/8$ and $f_{DAC} \times 3/8$. This creates optimum real output frequencies $f_{SIG} = f_{DAC} \times N/16$ ($N = 1, 3, 5, \text{ and } 7$), where the minimum spurious product offset from f_{SIG} is $f_{DAC}/8$.

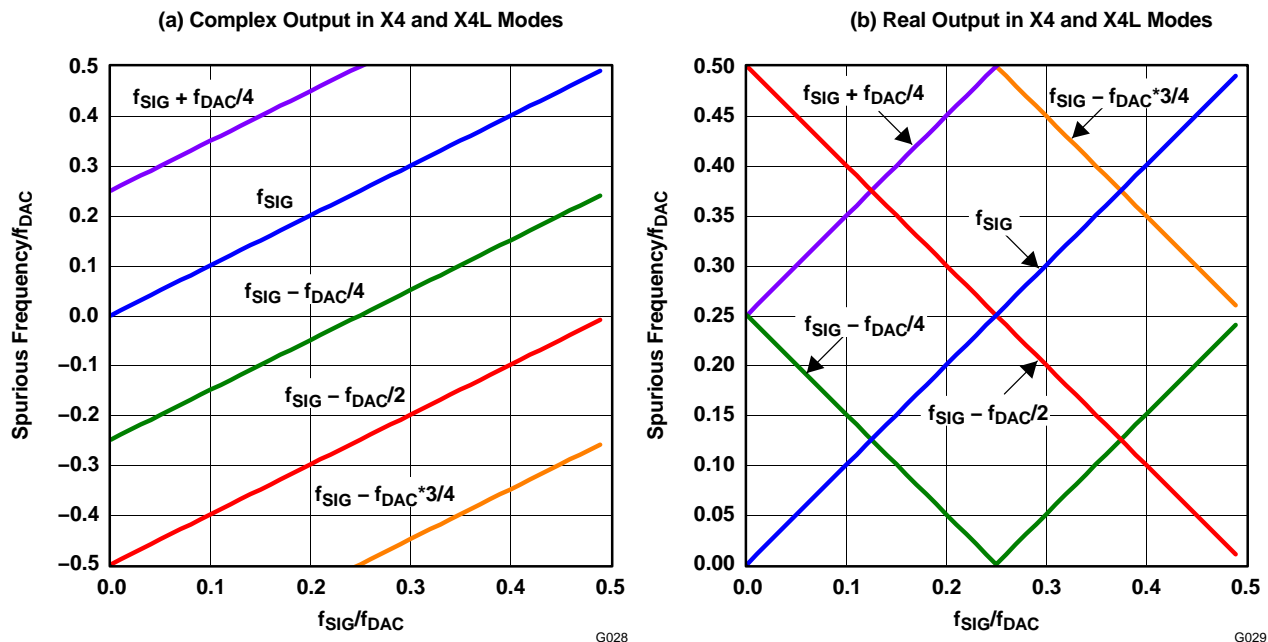


Figure 68. Frequency of Clock Mixing Spurious Images in X4 and X4L Modes

Figure 69 shows the location of spurious signals for X8 mode as a function of $f_{\text{SIG}}/f_{\text{DAC}}$. The addition of the $f_{\text{DAC}}/8$ clock frequency for the first interpolation filter creates four new spurious signals. For a complex output, the nearest spurious signals are $f_{\text{DAC}}/8$ offset from f_{SIG} . For a real output, the optimum real output frequencies $f_{\text{SIG}} = f_{\text{DAC}} \times N/16$ ($N = 3$ and 5), where the minimum spurious product offset from f_{SIG} is $f_{\text{DAC}}/8$.

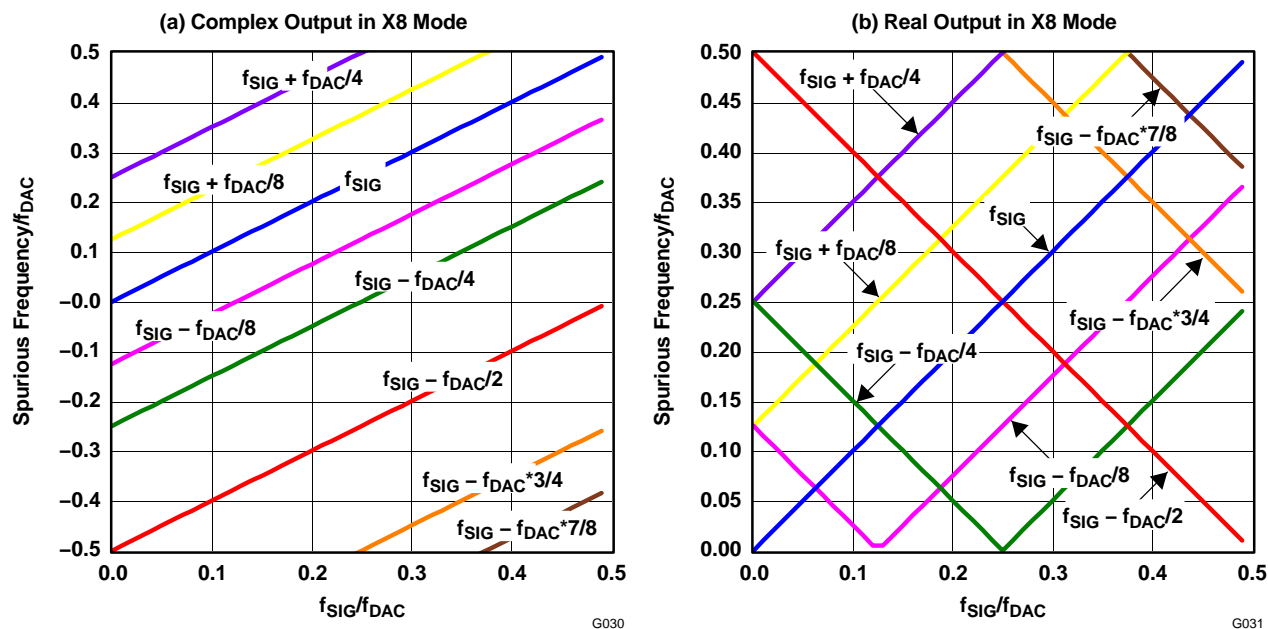


Figure 69. Frequency of Clock Mixing Spurious Images in X4 and X4L Modes

Amplitude of the Spurious Signals

The spurious signal amplitude is sensitive to factors such as temperature, voltage, and process. Typical worst case estimates to account for the variation over these factors are provided below as design guidelines.

Figure 70 and Figure 71 show the typical worst case spurious signal amplitudes vs f_{DAC} for a signal frequency $f_{SIG} = 11 \times f_{DAC}/32$ in each mode for PLL on (PLL clock mode) and PLL off (external and dual clock modes). Each spurious signal ($f_{DAC}/2$, $f_{DAC}/4$ and $f_{DAC}/8$) has its own curve. The spurious signal amplitudes can then be adjusted for the exact signal frequency f_{SIG} by applying the amplitude adjustment factor shown in Figure 72. The amplitude adjustment factor is the same for each spurious signal ($f_{DAC}/2$, $f_{DAC}/4$, and $f_{DAC}/8$) and is normalize for $f_{SIG} = 11 \times f_{DAC}/32$.

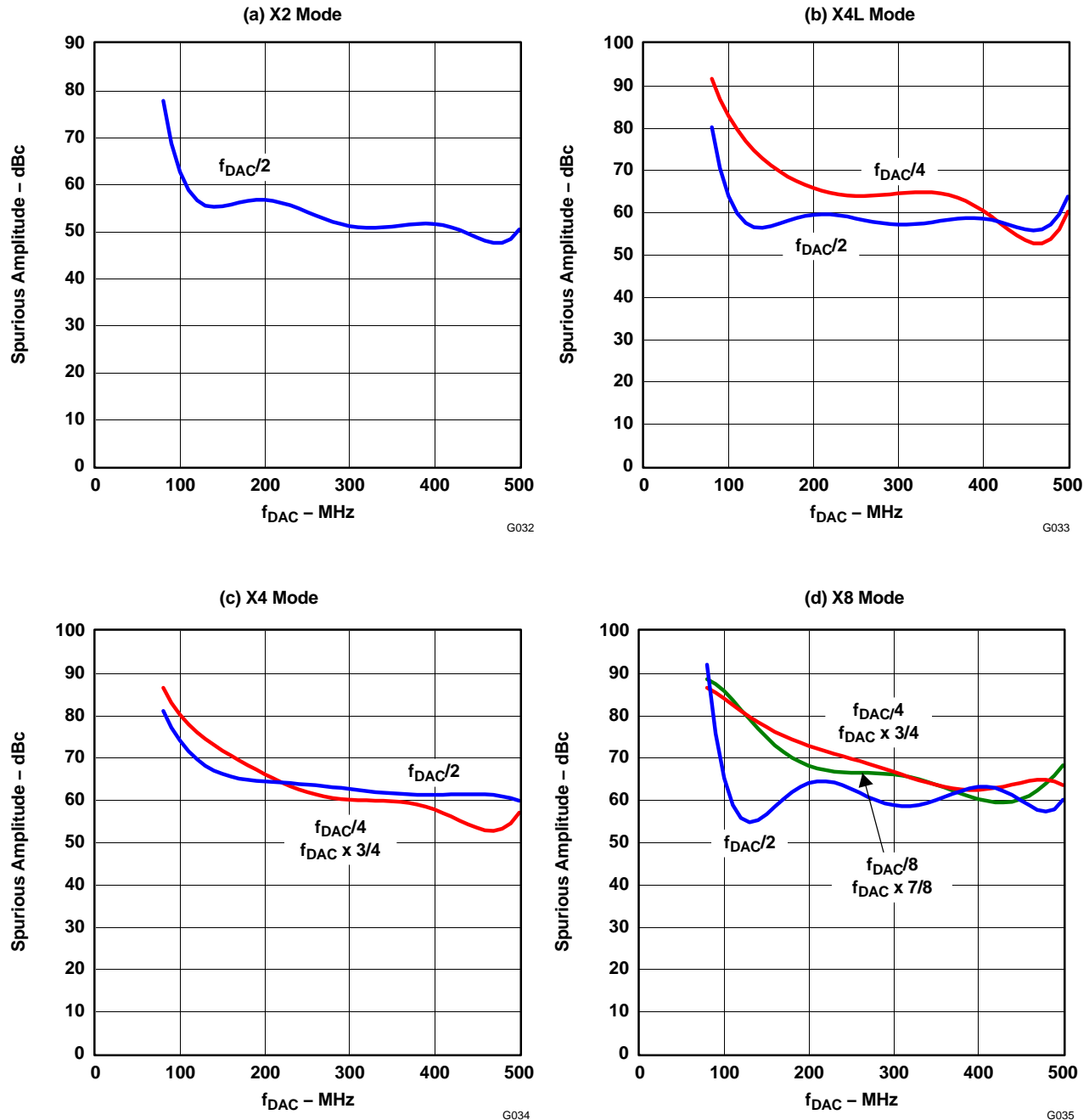


Figure 70. Clock Related Spurious Signal Amplitude With PLL Off for $f_{SIG} = 11 \times f_{DAC} / 32$

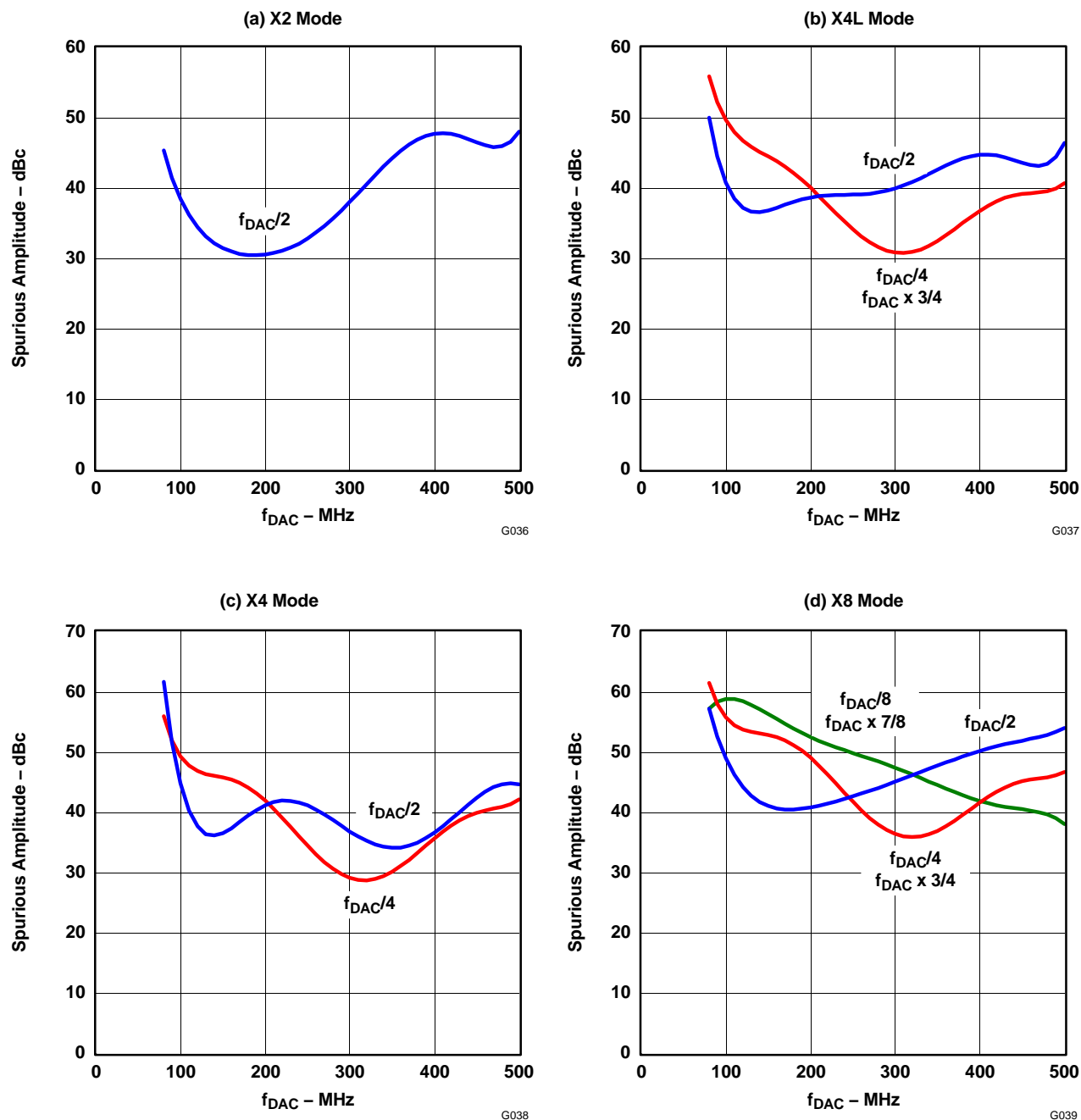


Figure 71. Clock Related Spurious Signal Amplitude With PLL On for $f_{SIG} = 11 \times f_{DAC} / 32$

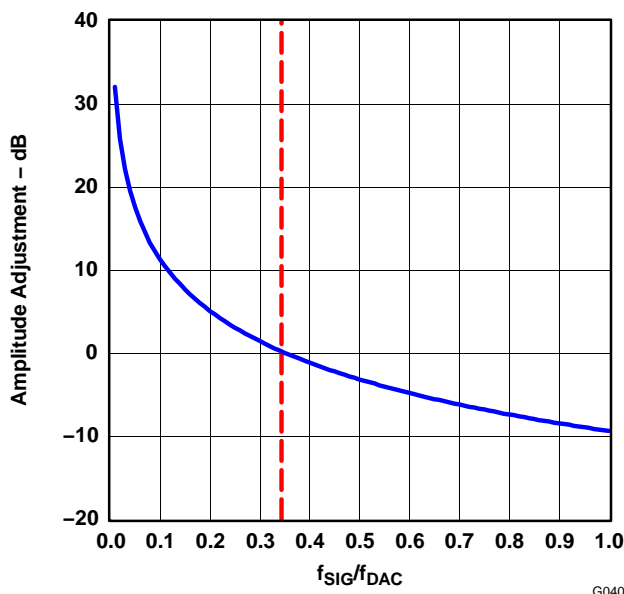


Figure 72. Amplitude Adjustment Factor for f_{SIG}

The steps for calculating the non-harmonic spurious signals are:

1. Find the spurious signal frequencies for the appropriate mode from [Figure 67](#), [Figure 68](#), or [Figure 69](#).
2. Find the amplitude for each spurious frequency for the appropriate mode from [Figure 70](#) or [Figure 71](#).
3. Adjust the amplitude of the spurious signals for f_{SIG} using the adjustment factor in [Figure 72](#).

Consider Example 1 with the following conditions:

1. X4 Mode
2. PII off
3. Complex Output
4. $f_{\text{DAC}} = 500 \text{ MHz}$
5. $f_{\text{SIG}} = 160 \text{ MHz} = 0.32 \times f_{\text{DAC}}$

First, the location of the spurious signals is found for the x4 complex output in [Figure 68\(a\)](#). Three spurious signals are present in the range $-0.5 \times f_{\text{DAC}}$ to $0.5 \times f_{\text{DAC}}$: two from $f_{\text{DAC}}/4$ (35 MHz and -215 MHz) and one from $f_{\text{DAC}}/2$ (-90 MHz). Consulting [Figure 70©](#), the raw amplitudes for $f_{\text{DAC}}/2$ and $f_{\text{DAC}}/4$ are 60 and 58 dBc, respectively. From [Figure 72](#), the amplitude adjustment factor for $f_{\text{SIG}} = 0.32 \times f_{\text{DAC}}$ is estimated at ~ 1 dB and so the $f_{\text{DAC}}/2$ and $f_{\text{DAC}}/4$ are adjusted to 61 and 59 dBc.

Table 15. Example # 1 for Calculating Spurious Signals

Spurious Signal	Frequency/ f_{DAC}	Frequency (MHz)	Raw Amplitude (dBc)	Adjusted Amplitude (dBc)
$f_{\text{DAC}}/4$	0.7	35	58	59
$f_{\text{DAC}}/2$	-0.18	-90	60	61
$f_{\text{DAC}}/4$	-0.43	-215	58	59

Now consider Example 2 with the following conditions:

1. X2 Mode
2. PLL on
3. Real output
4. $f_{\text{DAC}} = 400 \text{ MHz}$
5. $f_{\text{SIG}} = 70 \text{ MHz} = 0.175 \times f_{\text{DAC}}$

First, the location of the spurious signals is found for the X2 real output in [Figure 67\(b\)](#). One spurious signals is present in the range 0 to $0.5 \times f_{DAC}$ at $0.325 \times f_{DAC}$ (see [Table 16](#)). Consulting [Figure 71\(a\)](#), the raw amplitude for $f_{DAC}/2$ is 47 dBc. From [Figure 72](#), the amplitude adjustment factor for $f_{SIG} = 0.175 \times f_{DAC}$ is estimated at ~ 6 dB, and so the $f_{DAC}/2$ and $f_{DAC}/4$ is adjusted to 53 dBc.

Table 16. Example # 2 for Calculating Spurious Signals

Spurious Signal	Frequency/ f_{DAC}	Frequency (MHz)	Raw Amplitude (dBc)	Adjusted Amplitude (dBc)
$f_{DAC}/2$	0.325	130	47	53

Schematic and Layout Recommendations

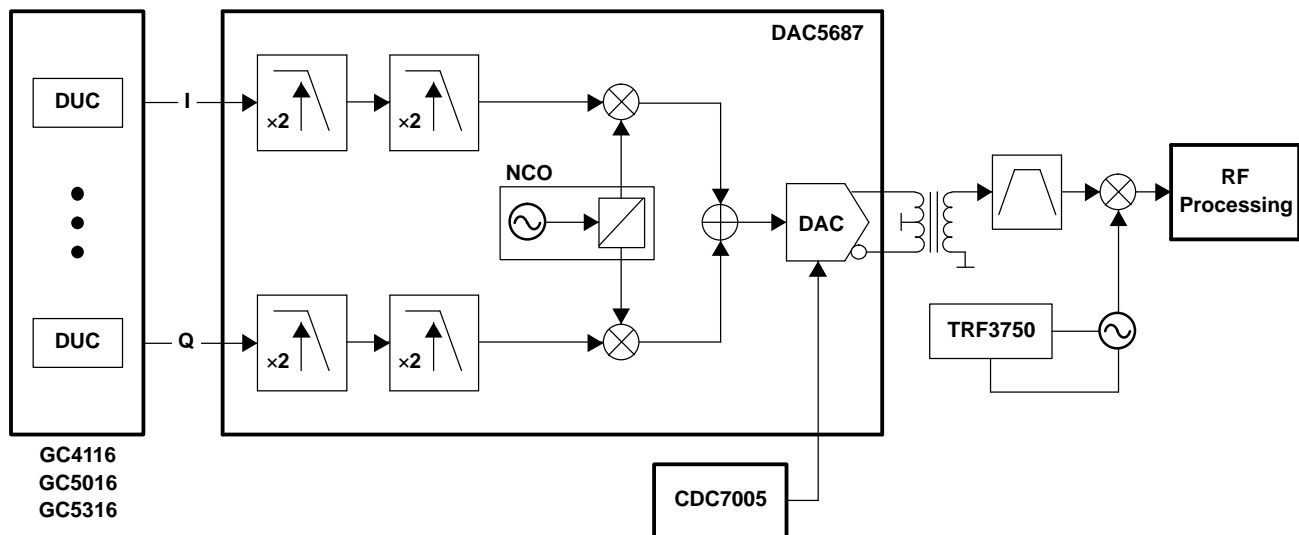
The DAC5687 clock is sensitive to fast transitions of input data on pins DA0, DA1, and DA2 (55, 54, and 53) due to coupling to DVDD pin 56. The noise-like spectral energy of the DA[0-2] couples into the DAC clock resulting in increased jitter. This significantly improves by using a 10- Ω resistor between DVDD and pin 56 in addition to 10-pF capacitor to DGND, as implemented on the DAC5687EVM (see the DAC5687 EVM user's guide - [SLWU017](#)). Pin 56 draws only approximately 2 mA of current and the 0.02-V voltage drop across the resistor is acceptable for DVDD voltages within the MINIMUM and MAXIMUM specifications. It is also recommended that the transition rate of the input lines be slowed by inserting series resistors near the data source. The optimized value of the series resistor depends on the capacitance of the trace between the series resistor and DAC5687 input pin. For a 2-3 inch trace, a 22- Ω to 47- Ω resistor would be recommended.

The effect of DAC clock jitter on the DAC output signal is worse for signals at higher signal frequencies. For low IF (< 75 MHz) or baseband signals, there is little degradation of the output signal. However, for high IF (> 75 MHz) the DAC clock jitter may result in an elevated noise floor, which often appears as broad humps in the DAC output spectrum. It is recommended for signals above 75 MHz that the inputs to DA0 and DA1, which are the two LSBs if input DA[0-15] is not reversed, not be connected to input data to prevent coupling to the DAC rate clock. The decrease in resolution to 14-bits and increase in quantization noise will not significantly affect the DAC5687 SNR for signals > 75 MHz.

Application Examples

Application Example: Real IF Radio

An system example of the DAC5687 used for a flexible real IF radio is shown in [Figure 73](#). A complex baseband input to the DAC would be generated by a digital upconverter such as Texas Instruments GC4116, GC5016, or GC5316. The DAC5687 would be used to increase the data rate through interpolation and flexibly place the output signal using the FMIX and/or CMIX blocks. Although the DAC5687 X4 mode is shown, any of the modes (x2, x4L, or x8) would be appropriate.



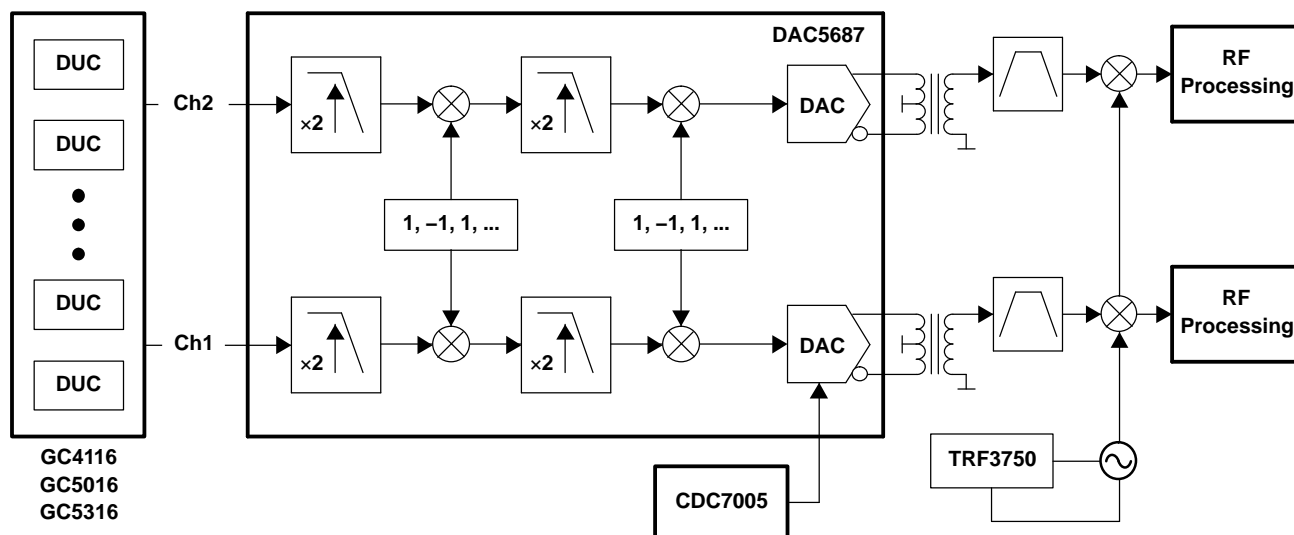
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Figure 73. System Diagram of a Real IF System Using the DAC5687

With the DAC5687 in external clock mode, a low phase noise clock for the DAC5687 at the DAC sample rate would be generated by a VCXO and PLL such as Texas Instruments CDC7005, which can also provide other system clocks at the VCXO frequency divided by 2^n ($n = 0$ to 4). In this mode, the DAC5687 PLLLOCK pin output would typically be used to clock the digital upconverter. With the DAC in PLL clock mode, the same input rate clock would be used for the DAC clock and digital upconverter and the DAC internal PLL/VCO would generate the DAC sample rate clock. Note that the internal PLL/VCO phase noise may degrade the quality of the DAC output signal, and will also have higher non-harmonic clock-related spurious signals (see the *Non-Harmonic Clock Related Spurious Signals* section).

Either DACA or DACB outputs can be used (with the other DAC put into sleep mode) and would typically be terminated with a transformer (see the *Analog Current Output* section). An IF filter, either LC or SAW, is used to suppress the DAC Nyquist zone images and other spurious signals before being mixed to RF with a mixer.

An alternative architecture uses the DAC5687 in a dual-channel mode to create a dual-channel system with real IF input and output. This would be used for narrower signal bandwidth and at the expense of less output frequency placement flexibility (see [Figure 74](#)). Frequency upconversion can be accomplished by using the high-pass filter and CMIX $f_{DAC}/2$ mixing features.



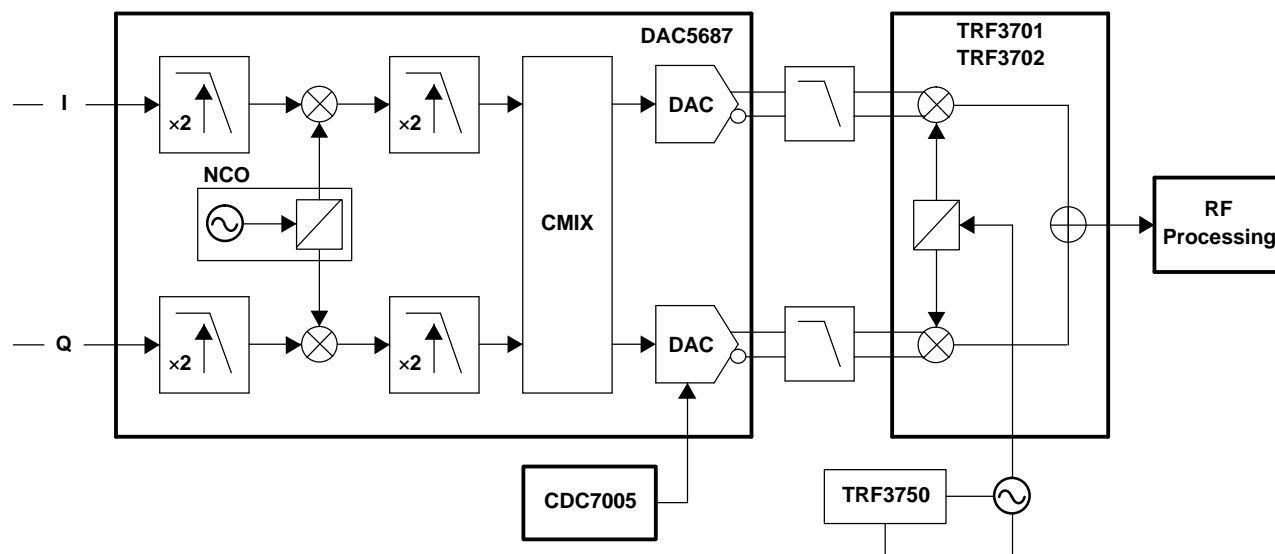
B0041-01

Figure 74. System Diagram of a Dual Channel Real IF Radio

The outputs of multiple DAC5687s can be phase synchronized for multiple antenna/beamforming applications.

Application Example: Complex IF to RF Conversion Radio

An alternative to a real IF system is to use a complex IF DAC output with analog quadrature modulator, as shown in Figure 75. The same complex baseband input as the real IF system in Figure 73 is used. The DAC5687 would be used to increase the data rate through interpolation and flexibly place the output signal using the FMIX and/or CMIX blocks. Although the DAC5687 X4 mode is shown, any of the modes (x2, x4L, or x8) would be appropriate.



B0042-01

Figure 75. Complex IF System Using the DAC5687 in X4L Mode

Instead of only using one DAC5687 output as for the real IF output, both DAC5687 outputs are used for a complex IF Hilbert transform pair.

The DAC5687 outputs can be expressed as:

$$A(t) = I(t)\cos(\omega_c t) - Q(t)\sin(\omega_c t) = m(t)$$

$$B(t) = I(t)\sin(\omega_c t) + Q(t)\cos(\omega_c t) = m_h(t)$$

where $m(t)$ and $m_h(t)$ connote a Hilbert transform pair and ω_c is the sum of the NCO and CMIX frequencies.

The complex DAC5687 output is input to an analog quadrature modulator (AQM) such as the TRF3701 or TRF3702. A passive (resistor only) interface is recommended between the DAC5687 and TRF3701/2 (See the Passive Interface to TRF3701/2 section). Upper single-sideband up-conversion is achieved at the output of the analog quadrature modulator, whose output is expressed as:

$$RF(t) = I(t)\cos(\omega_c + \omega_{LO})t - Q(t)\sin(\omega_c + \omega_{LO})t$$

Flexibility is provided to the user by allowing for the selection of $-B(t)$ out, which results in lower-sideband up-conversion. This option is selected by `usb` in the `CONFIG3` register.

Note that the process of complex mixing in FMIX and CMIX to translate the signal frequency from 0 Hz means that the analog quadrature modulator IQ imbalance produces a side-band and LO feedthrough that falls outside the signal.

This is shown in Figure 76, which is the RF analog quadrature modulator (AQM) output of an asymmetric three carrier WCDMA signal with the properties in Table 17. The wanted signal is offset from the LO frequency by the DAC5687 complex IF, in this case 122.88 MHz. The nearest spurious signals are ~ 100 MHz away from the wanted signal (due to non-harmonic clock-related spurious signals generated by the $f_{DAC}/4$ digital clock), providing 200 MHz of spurious free bandwidth. The AQM phase and gain imbalance produce a lower sideband product, which does not affect the quality of the wanted signal. Unlike the real IF architecture, the non-harmonic clock-related spurious signals generated by the $f_{DAC}/2$ digital clock fall ± 245.76 -MHz offset from the wanted rather than falling inband.

As a consequence, in the complex IF system it may be possible that no AQM phase, gain and offset correction is needed, instead relying on RF filtering to remove the LO feedthrough, sideband, and other spurious products.

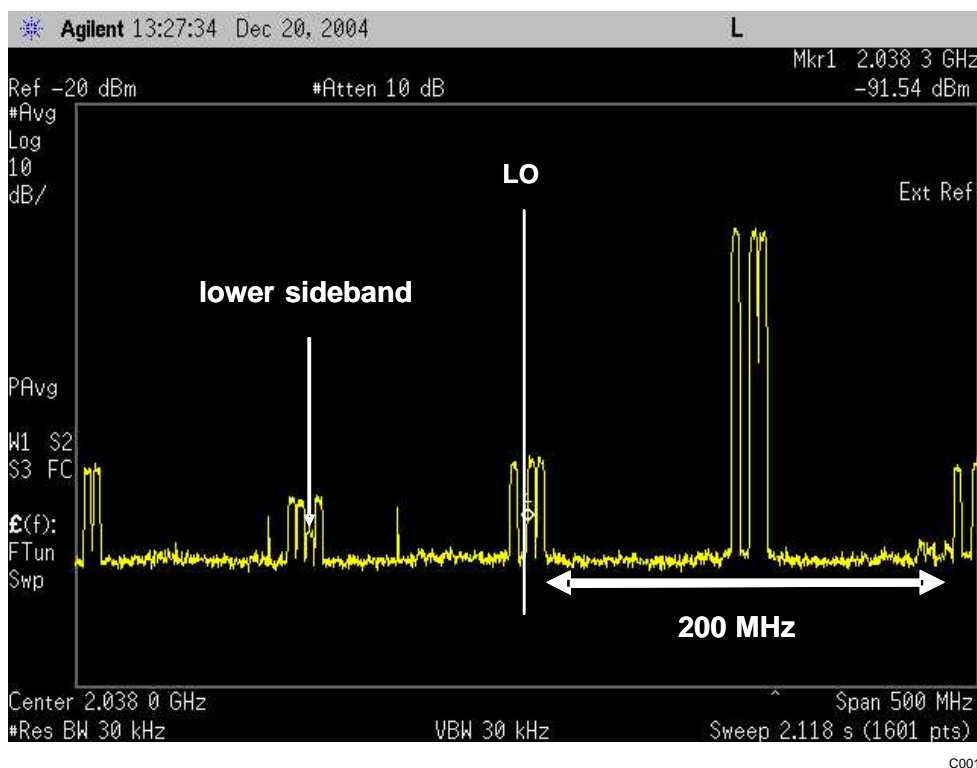


Figure 76. Analog Quadrature Modulator Output for a Complex IF System

Table 17. Signal and System Properties for Complex IF System Example in Figure 76

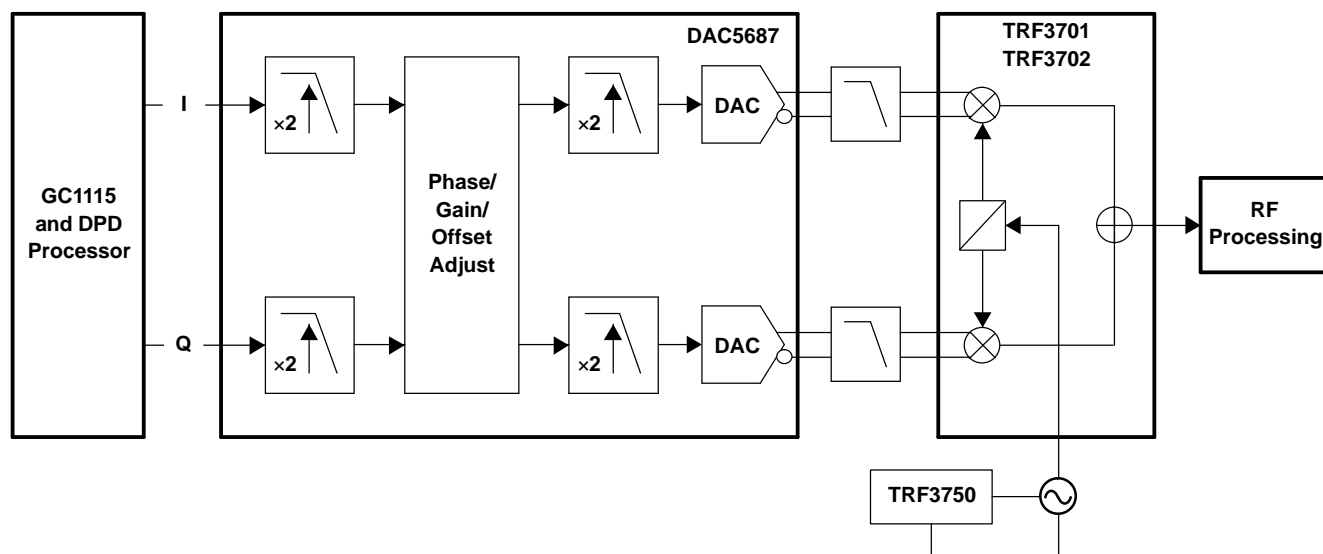
Signal	Three WCDMA Carriers, Test Model 1
Baseband Carrier Offsets	-7.5 MHz, 2.5 MHz, 7.5 MHz
DAC5687 Input Rate	122.88 MSPS
DAC5687 Output Rate	491.52 MSPS (4x Interpolation)
DAC5687 Mode	X4 CMIX
DAC5687 Complex IF	122.88 MHz ($f_{DAC}/4$)
LO Frequency	2140 MHz

The complex IF has several advantages over the real IF architecture such as:

1. Uncalibrated side-band suppression ~ 35 dBc compared to 0 dBc for real IF architecture.
2. Direct DAC - Complex mixer connection - no amplifiers
3. Non-harmonic clock-related spurious signals fall out-of-band
4. DAC 2nd Nyquist zone image is offset f_{DAC} compared with $f_{DAC} - 2 \times \text{IF}$ for a real IF architecture, reducing the need for filtering at the DAC output.
5. Uncalibrated LO feed through for AQM is ~ 35 dBc and calibration can reduce or completely remove the LO feed through.

Application Example: Wide Bandwidth Direct Baseband to RF Conversion

A system example of the DAC5687 used in a wide bandwidth direct baseband to RF conversion is shown in Figure 77. The DAC input would typically be generated by a crest factor reduction processor such as Texas Instruments GC1115 and digital predistortion processor. With a complex baseband input, the DAC5687 would be used to increase the data rate through interpolation. In addition, phase, gain and offset correction of the IQ imbalance is possible using the QMC block, DAC gain and DAC offset features. The correction could be done one time during manufacturing (see the TRF3701 data sheet (SLWS145) and the TRF3702 data sheet (SLWS149) for the variation with temperature, supply, LO frequency, etc. after calibration at nominal conditions) or during operation with a separate feedback loop measuring imbalance in the RF signal.



B0043-01

Figure 77. Direct Conversion System Using DAC5687 in X4L Mode

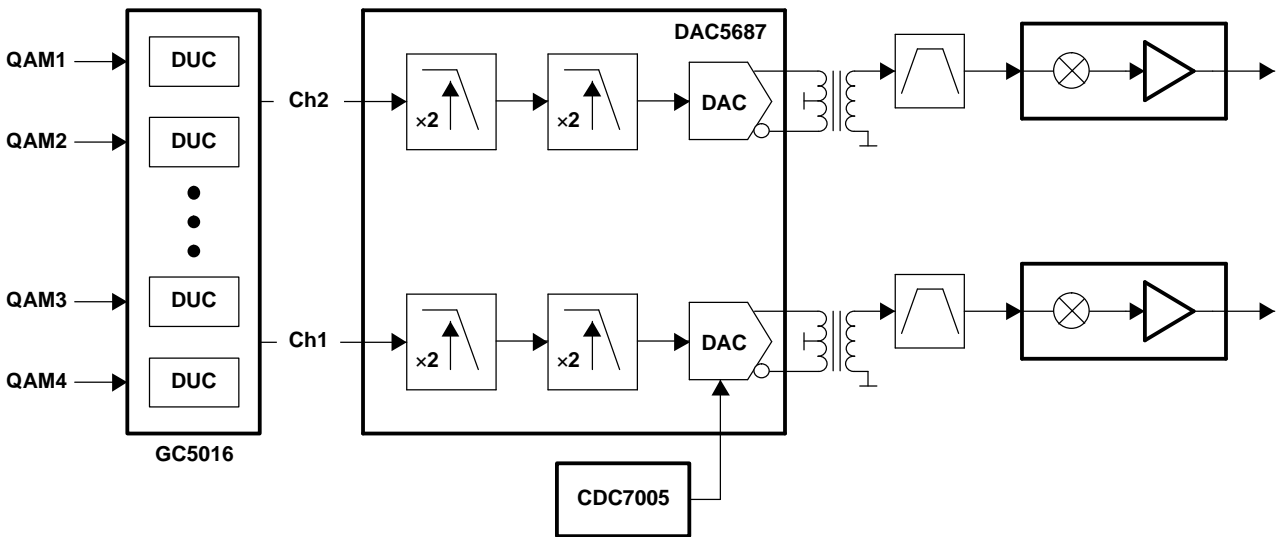
Operating at baseband has the advantage that the DAC5687 output is insensitive to DAC sample clock phase noise, so using the DAC PLL clock mode will have similar spectral performance to the External clock mode. In addition, the non-harmonic clock-related spurious signals will be small due to the low DAC output frequency.

With a complex input rate specified up to 250 MSPS, the DAC5687 is capable of producing signals with up to 200-MHz bandwidth for systems such as digital predistortion (DPD).

Application Example: CMTS/VOD Transmitter

The DAC5687's exceptional SNR enables a dual-cable modem termination system (CMTS) or video on demand (VOD) QAM transmitter in excess of the stringent DOCSIS specification, with > 74 dBc and 75 dBc in the adjacent and alternate channels.

A typical system using the DAC5687 for a cost optimized dual channel two QAM transmitter is shown in [Figure 78](#). A GC5016 would take four separate symbol rate inputs and provide pulse shaping and interpolation to ~ 128 MSPS. The four QAM carriers would be combined into two groups of two QAM carriers with intermediate frequencies of approximately 30 MHz to 40 MHz. The GC5016 would output two real data streams to one DAC5687. The DAC5687 would function as a dual-channel device and provide 2x interpolation to increase the frequency of the 2nd Nyquist zone image. The two signals are then output through the two DAC outputs, through a transformer and to an RF upconverter.



B0044-01

Figure 78. Dual Channel Two QAM CMTS Transmitter System Using DAC5687

The DAC5687 output for a two QAM256 carrier signal at 33-MHz and 39-MHz IF with the signal and system properties listed in [Table 18](#) is shown in [Figure 70](#). The low DAC5687 noise floor provides better than 75 dBc (equal bandwidth normalized to one QAM256 power) at > 6-MHz offset.

Table 18. Signal and System Properties for Complex IF System Example in [Figure 79](#)

Signal	QAM256, 5.36 MSPS, $\alpha = 0.12$
IF Frequencies	33 MHz and 39 MHz
DAC5687 Input Rate	5.36 MSPS x 24 = 128.64 MSPS
DAC5687 Output Rate	257.28 MSPS (2x Interpolation)
DAC5687 Mode	X2

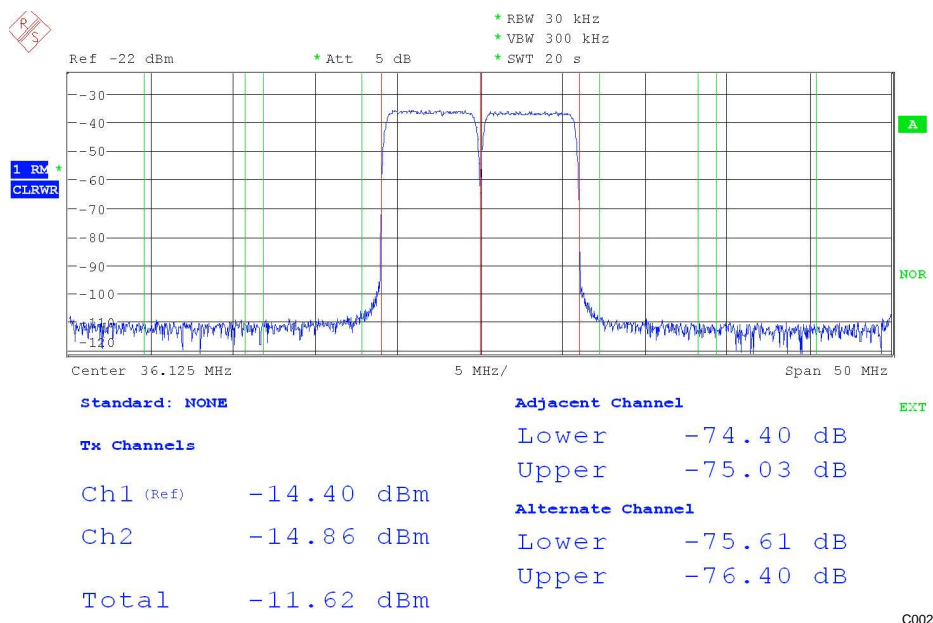
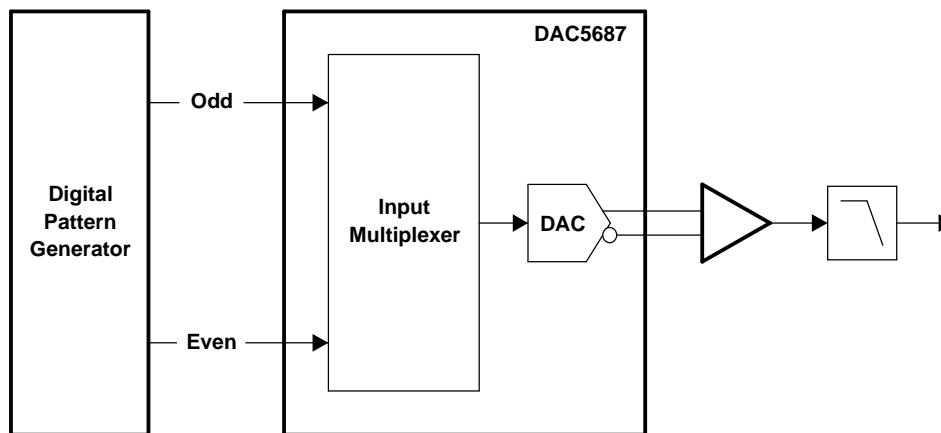


Figure 79. Two QAM256 Carriers With at 36-MHz IF

Application Example: High-Speed Arbitrary Waveform Generator

The DAC5687's flexible input allows use of the dual input ports with demultiplexed odd/even samples at a combined rate of up to 500 MSPS. Combined with the DAC's 16-bit resolution, the DAC5687 allows wideband signal generation for test and measurement applications.



B0045-01

Figure 80. DAC5687 in Odd/Even Input Mode

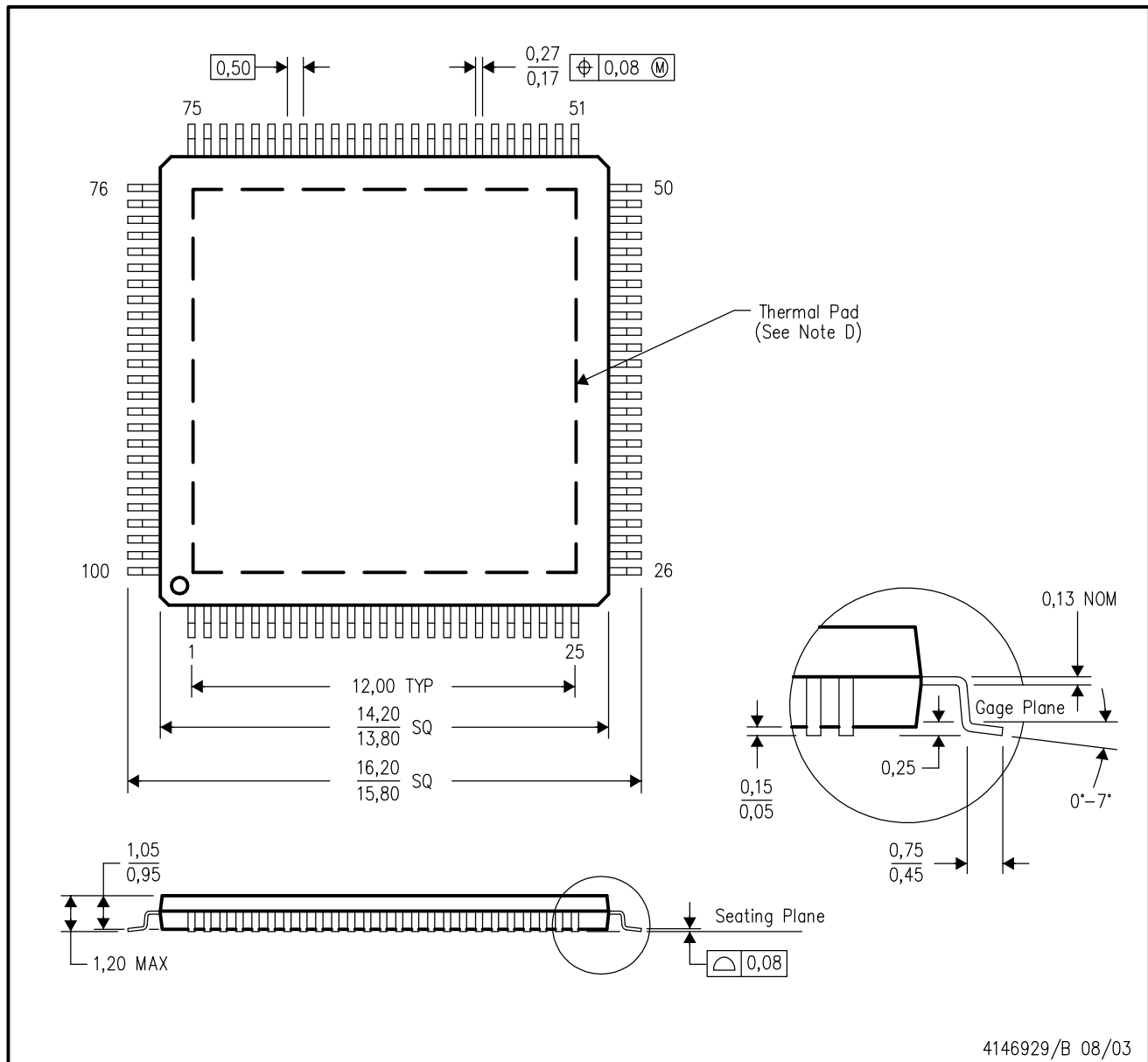
Revision History

DATE	REV	PAGE ⁽¹⁾	SECTION	DESCRIPTION
29 JUN 05	B	1	Ordering Information	Added thermal pad dimensions
		9	AC specifications	Reversed "External Clock Mode" and "PLL Clock Mode" in Noise floor test
		31	Register Name: ATEST	Changed PLLLOCK Output Signal for PLLVDD = 0 to "Normal Operation" in Table 5
		41	Clock Modes	Reversed ts(DATA) and th(DATA) in Figures 43 and 44
		42	Clock Modes	Reversed ts(DATA) and th(DATA) in Figure 45
		42	Clock Modes	Updated Figure 46
26 MAR 04	A	–	–	–
12 FEB 03	*	–	–	Original version

(1) Page numbers for previous versions may differ from page numbers in the current version.

PZP (S-PQFP-G100)

PowerPAD™ PLASTIC QUAD FLATPACK



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion.
 - This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <<http://www.ti.com>>.
 - Falls within JEDEC MS-026

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